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General Description

The MAX25432 combines an automotive-grade buckboost controller capable of full-range 3.3V to 21V programmable power supply (PPS) at up to 6.35A, a USB Power Delivery (USB PD) analog front-end (AFE), legacy USB charging support, and USB Type-C[®] protection switches for automotive USB host or downstream-facing (DFP) applications. The USB Type-C protection switches provide automotive system-level ESD protection and 24V short-circuit protection for D+, D-, CC1, CC2, and V_{CONN}. The device can optionally support legacy charging modes for older passenger phones including BC1.2, Apple[®] Charge, Apple CarPlay[®], Apple MFi, and USB On-The-Go (OTG).

The MAX25432B integrates a USB PD AFE, which supports the USB-IF Type-C Port Controller Interface (TCPCI) specification and can interface with any I²C master in the application. The MAX25432A provides configuration channel (CC) signal pass-through protection for an external USB PD controller.

G-suffix devices include intelligent detection and protection to avoid high short-circuit currents flowing from the car battery through the cable shield to ground during fault events, thus preventing car module damage.

The MAX25432 is available in a small, 6mm x 6mm, 40-pin TQFN-EP package and requires very few external components. The MAX25432 evaluation (EV) kit and collateral provide a convenient platform to the design engineer for rapid evaluation with reduced test and firmware development time.

Applications

- USB Hubs, Breakout Boxes, and Multimedia Hubs
- Dedicated Charging Modules
- Rear-Seat Entertainment Modules
- Head Unit, Radio, Navigation

Benefits and Features

- USB PD PHY That Is TCPCI-Standard for Use with Any Low-Cost I²C Master (Hub IC, MCU, SoC)
 - Ground Offset Adjusted BMC PHY for Maximum Signal-to-Noise Ratio
- Non-TCPC Versions Available for Protecting External USB PD Controller (MAX25432A)
- Integrated Buck-Boost Controller for External H-Bridge
 - 4.5V to 36V Input Operating Range
 - 220kHz, 300kHz, and 400kHz Switching Frequency
 External Frequency Synchronization and Spread
 - Spectrum for Reduced EMI
- USB PD PPS APDO Support TID 5821
 - 10mV Programmable Voltage Step Size
 - 25mA Programmable Current Step Size
- Integrated Cable Compensation up to 516mΩ
- Highest Performance, Safest, and Lowest Cost Passenger Cable-Shield Short-to-Battery Protection
 Minimizes Short-Circuit Currents with a Small,
 - Single-FET Solution
- Integrated High-Side Current-Sense Amplifiers, ADC and DAC
- Integrated 3.3V to 5.0V, 1.5W, Smart, Reliable V_{CONN} Switches and Protection
 - 50mA Programmable Overcurrent Step Size
- Integrated 24V DC Protection on Protected HVD+, HVD-, HVCC1, HVCC2 Outputs
- Integrated Legacy USB 2.0 Charging Support Including BC1.2, Apple CarPlay, OTG, and Apple MFi Rev 3x

19-101142; Rev 0; 9/21

- Integrated ±15kV Air-Gap/±8kV Contact Discharge ISO 10605 and IEC 61000-4-2 ESD Protection
- -40°C to +125°C Operating Temperature Range
- 40-Pin, 6mm x 6mm, TQFN Package with EP
- AEC-Q100 and AEC-Q006 Qualified

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Ordering Information appears at end of data sheet.

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Simplified Block Diagram



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Absolute Maximum Ratings

IN to PGND0.3V to +40V	PGND to AGND0.3V to +0.3V
HVEN, CSP1, CSN1 to PGND0.3V to V _{IN} +0.3V	HVCC1, HVCC2, HVDP, HVDM to AGND0.3V to +24V
LX1 to PGND (<u>Note 1</u>)0.3V to V _{IN} +0.3V	SHLD_SNS to AGND0.3V to +24V
OUT, CSP2, CSN2 to PGND0.3V to +30V	CC1, CC2, V _{CONN} to AGND0.3V to +6V
LX2 to PGND (<u>Note 1</u>)0.3V to V _{IN} +0.3V	DP, DM to AGND0.3V to V _{VDD USB} +0.3V
CSP_ to CSN0.3V to +0.3V	ADDR, ALERT, GDRV, SYNC, to AGND
BST1 to LX1, BST2 to LX20.3V to +6V	SCL, SDA to AGND0.3V to V _{VDD IO} +0.3V
BST1, DH1 to PGND0.3V to +46V	Continuous Power Dissipation (<u>Note 2</u>)
BST2, DH2 to PGND0.3V to +36V	Operating Temperature Range40°C to +125°C
DH_ to LX+0.3V to V _{BST} +0.3V	Junction Temperature+150°C
DL_, V _{COMP} , I _{COMP} to PGND0.3V to V _{BIAS} +0.3V	Storage Temperature Range40°C to +150°C
BIAS, V _{DD_USB} , V _{DD_IO} , V _{DD_BMC} , to AGND0.3V to +6V	Soldering Temperature (reflow)+260°C

Note 1: Self-protected from transient voltages exceeding these limits in circuit under normal operation. **Note 2:** Multilayer Board; $T_A = +70^{\circ}C$, derate $37mW/^{\circ}C$ above $+70^{\circ}C$.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Package Information

TQFN

Package Code	T4066+5C
Outline Number	<u>21-0141</u>
Land Pattern Number	<u>90-0055</u>
Thermal Resistance, Four-Layer Board:	
Junction to Ambient (θ_{JA})	27°C/W
Junction to Case (θ_{JC})	1°C/W

For the latest package outline information and land patterns (footprints), go to <u>www.maximintegrated.com/packages</u>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to <u>www.maximintegrated.com/thermal-tutorial</u>.

Electrical Characteristics

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
POWER SUPPLY						
Input Voltage Range on IN	V _{IN}		4.5		36	V
IN Supply Current – Off State	IN_OFF	V _{IN} = 18V, HVEN = 0V, V _{VCONN} = 0V, Off state		16		μA
IN Supply Current – Standby State	I _{IN_STDBY}	Powered; enabled; V _{BUS} Off		2.4		mA
IN Undervoltage Lockout Rising Threshold	V _{IN_UVLO_R}	V _{IN} rising. Default setpoint. Programmable from 4.5V to 8.5V in 0.4V steps with IN_UV_THRESH[3:0] register.		4.5		V
IN Undervoltage Lockout Falling Threshold	VIN_UVLO_F	V _{IN} falling. Default setpoint.		4.3		V

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Electrical Characteristics (continued)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
IN Undervoltage Lockout Accuracy – Rising and Falling	VIN_UVLO_AC C	Setpoint programmable in 0.4V steps with IN_UV_THRESH[3:0] register	Setpoint - 0.3	Setpoint	Setpoint + 0.3	V
IN Undervoltage Blanking Time	T _{DEB_IN_UVL}			150		μs
INTERNAL REGULATOR	RS					
BIAS Output Voltage	VBIAS	$V_{IN} > 6V$, $I_{BIAS} = 0$ to $80mA$	4.7	5.0	5.4	V
BIAS Dropout Voltage	V _{BIAS_DROP}	V _{IN} = 4.5V, I _{BIAS} = 20mA		0.125	0.25	V
BIAS Undervoltage Lockout	V _{UV_BIAS}	V _{BIAS} falling	2.7	3.0	3.3	V
BIAS Undervoltage Lockout Hysteresis	V _{UV_BIAS_HY} ST			0.25		V
BIAS Short-Circuit Current Limit	IBIAS_SC	V _{BIAS} shorted to AGND	100	200		mA
V _{DD_USB} Output Voltage	V _{DD_USB}		3.0	3.3	3.6	V
V _{DD_USB} Overvoltage	V _{DD_USB_OV}	Rising	3.8	4.0	4.3	V
V _{DD_BMC} Output Voltage	V _{DD_BMC}	MAX25432B only, SHLD_SNS = 0V	1.05	1.125	1.2	V
THERMAL SHUTDOWN						
Thermal Shutdown Temperature	T _{SHDN}	(<u>Note 4</u>), T _J rising		165		°C
Thermal Shutdown Hysteresis	T _{SHDN_HYST}	(<u>Note 4</u>)		10		°C
BUCK-BOOST CONTRO	LLER					
Programmable V _{BUS} Voltage Range	V _{OUT}		3.3		21.0	V
	N	VBUS_HIRES = 0b (10-bit resolution mode)		20.51		
V _{BUS} Voltage Step Size	V _{STEP}	VBUS_HIRES = 1b (11-bit resolution mode)		10.255		mV
		$3.3V \le V_{OUT} < vSafe5V$, CV mode, no load, VBUS_HIRES = 0b and 1b	-3.03		+3.03	0/
V _{BUS} Voltage Accuracy	Vout_acc	vSafe5V ≤ V _{OUT} ≤ 21V, CV mode, no load, VBUS_HIRES = 0b and 1b	-2.0		+2.0	%
V _{BUS} Slew Rise and	_	VBUS_HIRES = 0b		0.2		_
Fall Times During Transitions	T _{SLEW}	VBUS_HIRES = 1b		0.1		mV/µs
Soft-Start Ramp Time	T _{START}		4.0	6.5	9.0	ms
Minimum On-Time	T _{ON_MIN}	Buck mode, 400kHz switching		80		ns
Minimum Off-Time	T _{OFF_MIN}	Boost mode, 400kHz switching		120		ns
Dead Time	DT	Rising and falling edges of DH_ to DL_ and DL_ to DH_		17		ns
DH Pullup Resistance	R _{DH PU}	V _{BIAS} = 5V, I _{DH} = -100mA		2	4	Ω

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Electrical Characteristics (continued)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
DH Pulldown Resistance	R _{DH_PDWN}	V _{BIAS} = 5V, I _{DH} = +100mA		1	2	Ω
DL Pullup Resistance	R _{DL_PU}	V _{BIAS} = 5V, I _{DL} = -100mA		2	4	Ω
DL Pulldown Resistance	R _{DL_PDWN}	V _{BIAS} = 5V, I _{DL} = +100mA		1	2	Ω
DL1, DL2 Leakage Current	IDL_LKG	V _{DL1} = V _{DL2} = 0 to 5V, T _A = +25°C			1	μA
DH1 Leakage Current	I _{DH1_LKG}	V _{DH1} = V _{LX1} = 0V, T _A = +25°C			1	μA
DH2 Leakage Current	IDH2_LKG	V _{DH2} = V _{LX2} = 0V, T _A = +25°C			1	μA
BUCK-BOOST OSCILLA	TOR					
		FSW[1:0] = 00b	200	220	240	
Buck-Boost Oscillator	£	FSW[1:0] = 01b	270	300	330	
Switching Frequency	fsw	FSW[1:0] = 10b	350	400	450	- kHz
		FSW[1:0] = 11b	2000	2200	2400]
SYNC Input Frequency Lock Range	^f synci_rang E	External frequency lock range with respect to internal f _{SW} setting when SYNC_DIR = 1b (SYNC Input mode). SYNC input duty cycle range is 30% to 70%.	80		120	%
Spread-Spectrum		SS_SEL[1:0] = 01b		±3		
Frequency Modulation Range (with respect to	SPS	SS_SEL[1:0] = 10b		±6		%
f _{SW})		SS_SEL[1:0] = 11b		±9		
Slope Compensation Peak Ramp Voltage	V _{SLOPE_PK}	Peak ramp voltage per switching period. Default setpoint shown. Programmable from 100mV to 800mV in steps of 100mV with SLP[2:0] register.		400		mV
BUCK-BOOST CURREN	T SENSE					
Input Current-Limit Threshold	V _{OC1}	V _{CSP1} - V _{CSN1} rising		50	60	mV
Output Runaway Limit Threshold	V _{OC2}	V _{CSP2} - V _{OUT} rising, V _{OUT} > 0V		75	90	mV
CS Negative Limit Threshold	V _{OC3}	$ V_{CSP2} - V_{OUT} $ rising, $V_{OUT} > 4.5V$	-26	-20	-14	mV
	ILIM_OUT_1A		0.9	1.0	1.1	
Output Overcurrent Limit Accuracy	ILIM_OUT_3A	$R_{CS3} = 5m\Omega$	2.85	3.00	3.15	A
recuracy	ILIM_OUT_5A		4.75	5.00	5.25	
Output Overcurrent Programmable Step Size	IOUT_LSB	$R_{CS3} = 5m\Omega$		25		mA
Output Overcurrent Protection	IOUT_OCP	R _{CS3} = 5mΩ		6.4		A
CABLE COMPENSATION	N					
Cable Comp Loop Gain – V _{ADJ}	V _{ADJ}	3mV < V _{OUT} - V _{CSN2} < 30mV, GAIN[5:0] = 111111b	99	103	107	V/V

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Electrical Characteristics (continued)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
R-Cable Adjustment/ LSB	R _{COMP_LSB}			8.2		mΩ
HVEN AND SYNC I/O PI	NS					
SYNC Input Logic-High	VIH _{SYNC}	V _{SYNC} rising	2.0			V
SYNC Input Logic-Low	VIL _{SYNC}	V _{SYNC} falling			0.5	V
HVEN Rising Threshold	V _{HVEN_R}	V_{HVEN} rising threshold; guaranteed logic-high level when $V_{HVEN} \ge 1.8V$	1.20	1.45	1.80	V
HVEN Falling Threshold	V _{HVEN_F}	V_{HVEN} falling threshold; guaranteed logic-low level when $V_{HVEN} \le 1.0V$	1.00	1.26	1.60	V
HVEN Input Leakage	I _{HVEN_LKG}	V _{HVEN} = 5.5V, T _A = +25°C			+1	μA
SYNC Pulldown Resistance	R _{SYNC-PD}			1		MΩ
V _{CONN} SWITCH						
V _{CONN} Valid Voltage Range	V _{VCONN}		3.0		5.5	V
V _{CONN} Switch On- Resistance	R _{ON_VCONN}	V_{VCONN} = 5.0V and V_{VCONN} = 3.3V, I _{HVCC} = 0.25A		400	800	mΩ
V _{CONN} Programmable Overcurrent Threshold (Low)	IVCONN_OCP_	Measured on CC1 and CC2; V _{VCONN} = 5.0V or 3.3V	50		500	mA
V _{CONN} OCP Low Programmable Step Size	IVCONN_OCP_ L_LSB			50		mA
V _{CONN} Overcurrent Threshold (High)	IVCONN_OCP_	Measured on CC1 and CC2; V_{VCONN} = 3.3V and V_{VCONN} = 5.0V		750		mA
V _{CONN} Startup Time at 90%	^t vconn_on	Time from V_{CONN} switch enable to CC settled at 90% of final value with V_{VCONN} = 5.0V		300		μs
V _{CONN} Leakage Current	IVCONN_LKG	V_{CONN} switch disabled; V_{VCONN} = 5.0V			5	μA
V _{CONN} Fast UV Comparator Trip Threshold	V _{VCONN_} FAS T_UV	V_{CONN} enabled, measured at V_{CONN} pin, V_{VCONN} falling	Setpoint - 0.25	Setpoint	Setpoint + 0.25	V
USB TYPE-C/CURRENT	LEVEL CHARAG	CTERISTICS				
CC DFP Default Current Source	IDFP_DEF_CC		64	80	96	μA
CC DFP 1.5A Current Source	IDFP1.5_CC		166	180	194	μA
CC DFP 3.0A Current Source	IDFP3.0_CC		304	330	356	μA
CC PASS-THROUGH AN	ALOG SWITCH	ES	·			
Analog Signal Range			0		5.5	V
CC Switch On- Resistance	R _{ON_CC}	Resistance from CC1 to HVCC1 or CC2 to HVCC2		4		Ω

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Electrical Characteristics (continued)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
HVCC OV Protection Trip Threshold	V _{OV_HVCC}		5.65	5.80	5.95	V
HVCC OV Blanking Timeout Period	^t FP_HVCC	From OV condition to switch opened		1.0		μs
CC Switch ON Leakage	ICC_ON_LKG	CC switch ON, CC pullup voltage 5.5V; leakage to GND			10	μA
HVCC Pin OFF Leakage	IHVCC_OFF_L KG	HVCC switch OFF; V _{HVCC} = 20V; HVCC_ pins leakage to GND			25	μA
HVCC Open Termination Impedance	Z _{OPEN}	Impedance to GND	500			kΩ
HVCC Discharge Resistance	R _{DCH_HVCC}			3.0	6.2	kΩ
USB PD BMC (MAX2543	2B ONLY)					
BMC Tx Rise Time	t _{RISE}	10% to 90% with no load on CC wires	300	430		ns
BMC Tx Fall Time	t _{FALL}	90% to 10% with no load on CC wires	300	430		ns
BMC Tx Swing	V _{SWING}	Applies to no load and with max load defined by cable/receiver model	1.05	1.125	1.2	V
BMC Driver Output Impedance	ZDRIVER	Source output impedance	33	48	75	Ω
BMC Receiver Noise Filter	t _{RXFILTER}	Time constant of noise filter in Rx path	100			ns
Receiver Input Impedance	ZBMCRX			2		MΩ
Receiver Detect Rising Threshold	V _{BMCRxDet_Rt} h		0.645	0.685	0.725	V
Receiver Detect Falling Threshold	V _{BMCRxDet_Ft} h		0.565	0.605	0.645	V
DP, DM ANALOG USB S	WITCHES					
Analog Signal Range	V _{D_RANGE}		0		V _{DD_US} B	V
Protection Trip Threshold	V _{OV_D_L}	V _{HVDP} /V _{HVDM} rising; only for AUTO_CDP_DCP_MODE[1:0] = 01b (Auto-CDP mode)	3.65	3.85	4.05	V
	V _{OV_D_H}	V _{HVDP} /V _{HVDM} rising; all other modes	4.0	4.15	4.30	
Protection Response Time	t _{FP_D}	V_{HVEN} = 4.0V, V_{HVDP} = V_{HVDM} = 3.3V to 4.3V step, R_L = 15kΩ on DP and DM, delay to V_{DP} = V_{DM} < 3V		2		μs
Data Switch Differential Bandwidth	BW _{D_DIFF}	USB TEST_PACKET at 240MHz fundamental; -3dB BW		1000		MHz
On-Resistance Switch A	R _{ON_SA}	I_L = 10mA, V_D = 0V to V_{DD_USB} , V_{DD_USB} = 3.3V		4	8	Ω
On-Resistance Match between Channels Switch A	∆R _{ON_SA}	I _L = 10mA, V _D = 1.5V or 3.0V			0.25	Ω

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Electrical Characteristics (continued)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS
On-Resistance Flatness Switch A	R _{FLAT(ON)} A	I _L = 10mA, V _D _ = 0V or 0.4V			0.25	Ω
On-Resistance of HVDP/HVDM Short	R _{SHORT}	V _{DP} = 1V, I _{DM} = 500μA		90	180	Ω
HVDP/HVDM On- Leakage Current	IHVD_ON	V _{HVDP} = V _{HVDM} = 3.6V or 0V	-7		+7	μA
HVDP/HVDM Off- Leakage Current	I _{HVD_OFF}	V _{HVDP} = 18V or V _{HVDM} = 18V, V _{DP} = V _{DM} = 0V			100	μA
DP/DM Off-Leakage Current	ID_OFF	$V_{HVDP} = V_{HVDM} = 18V, V_{DP} = V_{DM} = 0V$	-1		+1	μA
USB 2.0 HOST CHARGE	R DETECTION, I	HVDP/HVDM				
Input Logic-High	VIH_CD		2.0			V
Input Logic-Low	V _{IL_CD}				0.8	V
Data Sink Current	IDAT_SINK	V _{DAT_SINK} = 0.25V to 0.4V	50	85	150	μA
Data Detect Voltage High	VDAT_REFH		0.4			V
Data Detect Voltage Low	V _{DAT_REFL}				0.25	V
Data Detect Voltage Hysteresis	V _{DAT_HYST}			60		mV
Data Source Voltage	VDAT_SRC	I _{SRC} = 200μA	0.5		0.7	V
V _{BUS} ADC						
ADC Resolution	Res_ADC			10		bits
ADC V _{BUS} LSB	V _{OUT_LSB_AD} C	VBUS_VOLTAGE[9:0] register		25		mV
ADC I _{BUS} LSB	IOUT_LSB_AD C	VBUS_CURRENT[7:0] register		50		mA
ADC Acquisition Time (V _{BUS} AND I _{BUS})	^t ACQ_ADC	Total time for both acquisitions		2		ms
V _{BUS} OUTPUT MONITOR	RS					
V _{BUS} OV	V _{BUS_OV_PR} OG	Programmable in 1.25% steps from +8.75% to +17.5% by changing the VBUS_OV_THRESH[2:0] register		+12.5%		%
V _{BUS} UV	V _{BUS_UV_PR} OG	Programmable in 1.25% steps from -8.75% to -17.5% by changing the VBUS_UV_THRESH[2:0] register		-12.5%		%
V _{BUS} Removal Detect Threshold	vSafe0V	Falling	0.6	0.75	0.8	V
V _{BUS} Removal Detect Hysteresis	vSafe0V	Rising hysteresis		0.05		V
SHIELD FET CONTROL						
GDRV Unloaded Output Voltage High	V _{GDRV,H}		4.5		5.5	V

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Electrical Characteristics (continued)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
GDRV Output Voltage High	V _{GDRV,LOAD}	I _{GDRV} = 10μA (sink)	4			V
GDRV Output Voltage Low	V _{GDRV,L}	I _{SINK} = 1mA (pullup)			0.8	V
I ² C DIGITAL INPUTS (SE	DA, SCL) AND V					
Input Leakage Current (SCL, SDA)	li2C_LKG	V _{PIN} = 5.5V, 0V	-5		5	μA
Logic-High (SCL, SDA)	V _{IH}		0.7 x V _{VDD_IO}			V
Logic-Low (SCL, SDA)	VIL				0.3 x V _{VDD_IO}	V
Hysteresis (SCL, SDA)	V _{I2C_HYST}			300		mV
V _{DD_IO} Input Voltage Range	V _{VDD_IO}		1.8		5.0	V
ADDR RESISTOR CONV	ERTER	-				
ADDR Current Leakage	IADDR_LKG	V _{ADDR} = 0 to 5V			±5	μA
Minimum Guaranteed Decoding Window Range	R _{ADDR_TOL}		-5		5	%
DIGITAL OUTPUTS (ALE	RT, SDA)		·			
Output-High Leakage Current	IOH_LKG	Pull up 0V and 5.5V	-10		10	μA
Output Low Level	V _{OL}	Sinking 1mA			0.4	V
I ² C DYNAMIC CHARACT	FERISTICS					
Clock Frequency	f _{SCL}				1000	kHz
Hold Time (Repeated) START Condition	^t HD;STA		0.26			μs
CLK Low Period	t _{LOW}		0.5			μs
CLK High Period	tнigн		0.26			μs
Setup Time Repeated START Condition	^t su;sta		0.26			μs
DATA Hold Time	thd:dat		0			ns
DATA Valid Time	^t SU;DAT				0.45	μs
DATA Setup Time	^t SU;DAT		50			ns
Setup Time for STOP Condition	^t su;sто		0.26			μs
Bus-Free Time Between STOP and START	t _{BUF}		0.5			μs
Noise Suppression on SCL and SDA	NS _{I2C}			50		ns
ESD PROTECTION (ALL	PINS)					
ESD Protection Level	V _{ESD}	Human Body Model (HBM)		±2		kV

Electrical Characteristics (continued)

 $(V_{IN} = 14V, V_{HVEN} = V_{IN}, V_{VCONN} = 5V, V_{VDD_IO} = 3.3V, T_A = -40^{\circ}C$ to +125°C, unless otherwise noted. Typical values are at T_A = +25°C. (*Note 3*))

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
ESD PROTECTION (HVDP, HVDM, HVCC1, HVCC2, SHLD_SNS)						
ESD Protection Level		ISO 10605 Air Gap (330pF, 2kΩ)		<u>+</u> 15		
		ISO 10605 Contact (330pF, 2kΩ)		<u>+</u> 8		kV
	V _{ESD}	IEC 61000-4-2 Air Gap (150pF, 330Ω)		<u>+</u> 15		ĸv
		IEC 61000-4-2 Contact (150pF, 330Ω)		<u>+</u> 8		

Note 3: Specifications with minimum and maximum limits are 100% production tested at T_A = +25°C and are guaranteed over the operating temperature range by design and characterization. Actual typical values may vary and are not guaranteed.
 Note 4: Guaranteed by design and bench characterization. Limits are not production tested.

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Typical Operating Characteristics

(V_{IN} = 14V; V_{HVEN} = V_{IN}; V_{VCONN} = 5V; V_{VDD_IO} = 3.3V; T_A = +25°C, unless otherwise noted)



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Typical Operating Characteristics (continued)

(V_{IN} = 14V; V_{HVEN} = V_{IN}; V_{VCONN} = 5V; V_{VDD} IO = 3.3V; T_A = +25°C, unless otherwise noted)



Automotive, 100W, USB PD, PPS, Buck-Boost Port Controller and Protector

Typical Operating Characteristics (continued)

(V_{IN} = 14V; V_{HVEN} = V_{IN} ; V_{VCONN} = 5V; $V_{VDD_{-}IO}$ = 3.3V; T_A = +25°C, unless otherwise noted)





SWITCHING FREQUENCY (400kHz)

















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Typical Operating Characteristics (continued)

(V_{IN} = 14V; V_{HVEN} = V_{IN} ; V_{VCONN} = 5V; $V_{VDD_{-}IO}$ = 3.3V; T_A = +25°C, unless otherwise noted)









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Pin Configuration

MAX25432



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Pin Description

PIN	NAME	FUNCTION
1	BST1	Bootstrap Capacitor Pin for High-Side Driver of LX1 Node. Connect a 0.1µF capacitor between BST1 and LX1.
2	DL1	Buck Low-Side Gate Drive Output. Connect to the gate of Q _{b1} external N-channel MOSFET.
3	PGND	Buck-Boost Power Ground. Connect directly to GND. Connect to GND copper underneath IC.
4	CSN1	Negative Terminal of the Input High-Side Current-Sense Amplifier. Connect CSN1 as close to R_{CS1} as possible using a Kelvin sense routing.
5	CSP1	Positive Terminal of the Input High-Side Current-Sense Amplifier. Connect CSP1 as close to R_{CS1} as possible using a Kelvin sense routing.
6	HVEN	High-Voltage Enable Input. Driving HVEN high powers up the IC. This pin can be connected directly to battery voltage or car accessory power. This pin can also be driven by a 3.3V or 5V general-purpose output from a microcontroller.
		Shield Sense Pin. For G-suffix devices: In order to protect against shield short-to-battery events, connect SHLD_SNS to the drain of the external shield N-channel FET, which is connected to the SHIELD and GND pins
7	SHLD_SNS	of the USB Type-C receptacle. All MAX25432B devices have optional USB PD physical layer (PHY) ground offset compensation input. Connect to downstream Type-C captive cable ground sense line.
		For all other devices, or if not used, connect to the IC GND.
8	GDRV	Shield FET Gate Drive Output. Active on all MAX25432 devices. Connect to the gate of an external N-channel FET to let the MAX25432 control the ground connection on the downstream Type-C connector.
		If not used, connect a $1M\Omega$ resistor from GDRV to the IC GND.
9	V _{DD_IO}	External Input Supply for I ² C Interface. Bypass with 10nF ceramic capacitor to AGND.
10	SYNC	Optional Switching Frequency Input/Output for Synchronization with Other Switching Regulators. Leave as an input and tie to the IC GND if not used.
11	SCL	I ² C Clock Pin. Connect to V _{DD_IO} through a pullup resistor.
12	SDA	I ² C Data Pin. Connect to V _{DD IO} through a pullup resistor.
13	V _{DD_BMC}	MAX25432A: Connect V _{DD_BMC} to AGND. MAX25432B: Internal 1.125V Regulated Supply Output. Powers the biphase mark coding (BMC) Tx driver output. Bypass with a 1 μ F ceramic capacitor to AGND. Do not connect external loads to V _{DD_BMC} .
14	CC1	MAX25432A: Protected CC1. Connect to upstream CC1 configuration channel of the external USB PD controller.
		MAX25432B: No Connect.
15	CC2	MAX25432A: Protected CC2. Connect to upstream CC2 configuration channel of the external USB PD controller.
		MAX25432B: No Connect.
16	V _{CONN}	V_{CONN} Input Supply. Connect to BIAS or an external 5V or 3.3V supply. Bypass with a $10\mu F$ ceramic capacitor to GND when connected to a 3.3V supply. Bypass with a $1\mu F$ ceramic capacitor to GND when connected to BIAS or a 5V supply.
17	V _{DD_USB}	Internal 3.3V Regulated Supply Output. Bypass V _{DD_USB} to GND with a 1 μ F ceramic capacitor. Do not connect external loads to V _{DD_USB} .

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Pin Description (continued)

-	
NAME	FUNCTION
DP	Protected D+ USB 2.0 Data Path. For charging downstream port (CDP) applications, connect to the low-voltage USB transceiver or HUB IC D+ connection. For dedicated charging port (DCP) applications, tie to the DM pin.
DM	Protected D- USB 2.0 Data Path. For CDP applications, connect to the low-voltage USB transceiver or HUB IC D- connection. For DCP applications, tie to the DP pin.
ALERT	<u>Open-Drain</u> Interrupt Output. Indicates alerts to the I ² C master. Connect a 100k Ω pullup from ALERT to V _{DD_IO} .
HVDM	High-Voltage-Tolerant D- Connection to Downstream USB Type-C Connector or Captive Cable.
HVDP	High-Voltage-Tolerant D+ Connection to Downstream USB Type-C Connector or Captive Cable.
AGND	Analog Ground Pin (IC GND). Connect directly to GND; tie to GND pour underneath the IC.
HVCC2	High-Voltage-Tolerant CC2 Connection to Downstream USB Type-C Connector or Captive Cable.
HVCC1	High-Voltage-Tolerant CC1 Connection to Downstream USB Type-C Connector or Captive Cable.
V _{COMP}	Voltage Loop Error Amplifier Output. Connect the external compensation network of the voltage feedback loop between V _{COMP} and AGND.
IN	Supply Input for Main IC Power and Internal BIAS Linear Regulator. Bypass IN to GND locally with 1μ F and 100nF ceramic capacitors (one of each).
BIAS	Regulated Output of the Internal 5.0V LDO. BIAS powers the internal circuitry. Bypass with a 4.7µF ceramic capacitor from BIAS to AGND.
ICOMP	Error Amplifier Output for the PPS Current Loop. Connect the external compensation network of the PPS current loop between I _{COMP} and AGND.
CSN2	Negative Terminal of the PPS Current-Sense Amplifier. CSN2 connects to the negative side of the R_{CS3} sense resistor. Referenced to OUT.
OUT	Output Sense Pin. Negative terminal of the high-side output current-sense amplifier (output CSA), input to the internal feedback resistor network and positive terminal of the PPS CSA. Connect OUT as close to R_{CS3} as possible using a Kelvin sense routing. OUT is also connected to the negative side of the sense resistor R_{CS2} .
CSP2	Positive Terminal of the High-Side Output Current-Sense Amplifier. Connect CSP2 as close to R_{CS2} as possible using a Kelvin sense routing. Referenced to OUT.
ADDR	I ² C Slave Address Selection. Connect a resistor to ground to select the last two address bits. See the <i>I</i> ² <i>C</i> Slave Addressing section for selecting the ADDR resistor.
DL2	Boost Low-Side Gate Drive Output. Connect to the gate of the Qb2 external N-channel FET.
BST2	Bootstrap Capacitor Pin for High-Side Driver of the LX2 Node. Connect a 0.1µF capacitor from BST2 to LX2.
DH2	Boost High-Side Gate Drive Output. Connect to the gate of the Qt2 external N-channel FET.
LX2	Boost-Side Switching Output Node. LX2 is Hi-Z when the buck-boost is disabled.
LX1	Buck-Side Switching Output Node. LX1 is Hi-Z when the buck-boost is disabled.
DH1	Buck High-Side Gate Drive Output. Connect to the gate of the Qt1 external N-channel FET.
EP	Exposed Pad. EP must be connected to the ground plane of the PCB for power dissipation. Not electrically connected internally.
	DP DM ALERT HVDM HVDP AGND HVCC2 HVCC1 VCOMP IN BIAS ICOMP CSN2 OUT CSP2 ADDR DL2 BST2 DH2 LX2 LX1 DH1

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Functional Diagrams

Functional Block Diagram



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Power-Up Sequence



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Detailed Description

The MAX25432 is a single-chip USB PD charging and protection solution with PPS for multimedia hub, rear-seat entertainment module, and head-unit applications. Combined with either a microcontroller or a USB PD controller it is a two-chip solution for dedicated charging module applications. The MAX25432 provides all the functionality for USB PD car battery to V_{BUS} regulation, configuration channel communication, and USB 2.0 Hi-Speed protection. It can optionally provide BC1.2 host charge emulation. The device integrates all of the protection needed in an automotive application for a USB PD application.

The MAX25432 offers the design engineer two options for firmware development. The MAX25432B can operate with a system-on-chip (SoC), USB hub IC, or microcontroller, whereas the MAX25432A is designed to operate with a USB PD controller. The MAX25432 evaluation (EV) kit offers a platform where the design engineer can begin early firmware development.

Recent advancements in the automotive infotainment market demand high-efficiency and low footprint power delivery solutions. The push for lower BOM cost has driven USB power applications to integrate more features and responsibilities into a single IC. The proliferation of USB PD-based battery-powered portable devices has resulted in an increase in the number of USB ports in an automobile to charge the passenger's devices. These multiport charging modules can unnecessarily increase per-port cost when a dedicated MCU with firmware is used for each port. The MAX25432B minimizes per-port cost by using a single microcontroller as a USB Type-C policy manager (TCPM) that is operating as a master, and multiple USB Type-C port controllers (TCPCs) operating as slaves. The TCPM and TCPC communicate with each other using I²C.

The MAX25432B is an advanced automotive integrated USB PD solution that combines the TCPC along with other USB features such as Type-C, PD with PPS, BC1.2, Apple, and Samsung® charging port emulator. All MAX25432 devices implement Analog Devices' proprietary current-mode buck-boost H-bridge controller that can achieve a target USB output voltage with high-efficiency while operating over a wide range of input voltage. The MAX25432 buck-boost controller has robust protection mechanisms such as overvoltage (OV), undervoltage (UV), overcurrent, short-to-ground (STG), short-to-battery, overtemperature, and automotive ESD protections. The MAX25432 implements internal gate drivers to drive external power FETs to accommodate high-power USB requirements. The MAX25432 has an intelligent voltage adjustment circuit that can adjust the output voltage of the buck-boost converter such that the voltage on the USB receptacle is within specifications regardless of the output current.

All MAX25432 devices have integrated data and CC switches that protect the upstream USB transceiver and/or PD controller from high-voltage events on the cable or the receptacle. All devices also have an integrated V_{CONN} switch to supply power on one of the unused CC pins in different configurations. The high-voltage DP/DM pins (HVDP/HVDM) and CC pins (HVCC1/HVCC2) are monitored and protected for OV conditions such as ESD or short-to-battery/V_{BUS} events. Based on the configuration requested by the TCPM, the MAX25432B has the capability to source different currents on the HVCC pins for a Type-C interface. The MAX25432B also supports biphase mark coding (BMC) communication using integrated USB PD AFE circuits with remote ground offset sensing for long captive cables.

Features

- Integrated buck-boost DC-DC controller with drivers for four external MOSFETs in an H-bridge configuration
 - 4.5V to 36V (40V load-dump) input voltage allows operation in "warm-crank" and start/stop conditions
 - USB PD with PPS
 - 10mV V_{BUS} voltage step size from 3.3V to 21V
 - 25mA V_{BUS} current-limit step size from 1.0A to 6.35A
 - Four switching frequency options for scalable efficiency, adjustable EMI interference avoidance and power optimization including 220kHz, 300kHz, 400kHz, and 2.2MHz
 - · Forced-PWM at light or no-load conditions for reduced EMI through USB cable
 - Spread-spectrum option for EMI reduction
 - · SYNC input and SYNC output for frequency parking and multiport applications
 - Reduced inrush current with soft-start
 - · Thermal shutdown
- Integrated USB PD V_{BUS} features

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- · USB PD PPS compliant
- Programmable V_{BUS} overcurrent protection limits
 - Apple MFi R3x compatible
- Programmable V_{BUS} undervoltage protection limits
- Programmable V_{BUS} overvoltage protection limits
- Digital voltage scaling (DVS) for smooth, predictable voltage transitions
- Integrated USB V_{BUS} discharge
- Integrated output voltage adjustment for cable voltage drop on captive-cable applications
 Programmable voltage gain up to 3m/up to 516mΩ cable resistance
- 1MHz I²C slave Interface with ALERT pin
 - TCPCI-compliant register set
 - · MAX25432-specific registers for alerts, advanced diagnostics, and management
 - · Maskable alerts for application-specific behavior
 - Selectable I²C address for multiport applications
 - Integrated watchdog timer for guaranteed safe operation
- MAX25432A devices provide integrated two-input to two-output USB Type-C CC1 and CC2 4Ω (typ) switches for external USB PD controller
- MAX25432B devices provide a single-port TCPC-compliant USB PD PHY for an external TCPM
 - Designed to comply with USB PD, Type-C, and TCPC specifications as a source and DFP
 - USB Type-C Specification, Revision 1.3
 - USB Power Delivery Specification, Revision 2.0, and Revision 3.0 Version 1.2
 - USB Type-C Port Controller Interface Specification, Revision 2.0 Version 1.1
 - · Implements Type-C CC interface and USB PD PHY functions to a TCPM that handles PD policy management
 - Type-C cable plug orientation detection
 - Type-C detection supporting default, 1.5A or 3.0A current capabilities
- SAR ADC for V_{BUS} (10-bit) and I_{BUS} (7-bit) monitoring
 - · Programmable V_{BUS} voltage alarm thresholds
- Integrated 1.5W, 400mΩ (typ) V_{CONN} switch with overcurrent protection removes need for dedicated V_{CONN} DC-DC and allows use of the common-voltage rail in the application
 - 3.0V to 5.5V input voltage support
 - Programmable I_{LIM} in 50mA steps
 - · Diagnostic current prevents enabling into an STG condition
 - Fast V_{CONN} input undervoltage protection
 - Intelligent soft-start and auto-retry for noncompliant V_{CONN} loads
 - Integrated V_{CONN} discharge on HVCC1 and HVCC2 pins
 - I²C control saves two GPIOs on the USB PD controller
- Integrated module input fuse protection
 - Programmable VIN undervoltage protection threshold
 - Fast detection of a fuse blow condition
 - Quick alert reporting to I²C master for resolution and possible USB PD renegotiation
- Integrated protection for passenger cable shield-short-to-battery faults prevents cable, passenger device, and car module damage
 - · Fast and intelligent detection of cable shield overcurrent
 - · Fast turn-off of external protection switch
 - · Safe dissipation of inrush energy
 - Fault reporting and auto-retry for fault removal
- Integrated automotive protection on V_{BUS} output
 - Fixed 6.4A V_{BUS} circuit-breaker limit (V_{BUS} OCP)
 - · Automatic short-to-GND fault detection and diagnostic

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- Optionally supports USB BC1.2 CDP, DCP, and high-speed pass-through modes (SDP)
 - USB D+/D- protection and host charger emulator
 - Integrated HVDP/HVDM Apple and Samsung termination resistors
 - Compatible with USB OTG specification and Apple CarPlay
 - Supports Chinese Telecommunication Industry Standard YD/T 1591-2009
 - Integrated 1GHz, 3dB BW data switches supporting USB 2.0 480Mbps/12Mbps/1.5Mbps communication
 - Provides clean routing of Type-C Dp1, Dn1, Dp2, Dn2 connections to USB 2.0 downstream connector
 - Auto-DCP mode compatible with Oppo® and OnePlus® devices
- Integrated robust high-voltage protection for the USB PD or TCPM controller from events at the receptacle or captive cable
 - 24V (max) overvoltage protection on HVCC1/HVCC2
 - 24V (max) USB 2.0 overvoltage protection on HVDP/HVDM
 - Automatic fault detection and retry
 - Fault indication through active-low, open-drain ALERT output (maskable)
 - Short-to-battery and short-to-V_{BUS} protection
- Automotive-grade ESD protection on USB HVDP, HVDM, HVCC1, HVCC2, and SHLD_SNS pins
 - ±15kV Air-Gap/±8kV Contact Discharge IEC 61000-4-2
 - ±15kV Air-Gap/±8kV Contact Discharge ISO 10605

MAX25432A and MAX25432B Differences

Table 1. Differences between MAX25432A and MAX25432B Devices

FUNCTION	MAX25432A	MAX25432B	
Startup	No di	No difference	
Buck-Boost and V _{BUS} Power	No difference		
CC Protection Switches	No difference		
USB Data Switches and Host Charge Emulation	No difference		
Cable Shield Short-to-Battery Protection (G-Suffix only)	No difference		
Normally Open Ground	No difference		
V _{CONN}	No difference		
I ² C	No difference		
Watchdog	No difference		
Fault Reporting, Action, and Recovery	No difference		
V _{BUS} , I _{BUS} ADC	No difference		
V _{BUS} Alarms	No difference		
Type-C Interface (Rp, V _{Rd} /V _{Ra})	No	Yes	
USB Power Delivery PHY (BMC Driver)	No	Yes	
V _{DD BMC} Internal Supply	Off	On (1.125V)	

Document Conventions

Whenever "MAX25432" is mentioned in this document, the corresponding description, figure, or diagram applies to all MAX25432 devices.

Whenever "MAX25432A" is mentioned in this document, the corresponding description, figure, or diagram only applies to MAX25432A devices.

Whenever "MAX25432B" is mentioned in this document, the corresponding description, figure, or diagram only applies to MAX25432B devices.

Whenever "G-suffix" is mentioned in this document, the corresponding description, figure, or diagram only applies to MAX25432 devices with the G-suffix. Example: MAX25432BATLG/V+ or MAX25432AATLG/V+ are G-suffix devices.

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Whenever "M-suffix" is mentioned in this document, the corresponding description, figure or diagram only applies to MAX25432 devices with the M-suffix. Example: MAX25432BATLM/V+ is a M-suffix device.

References

Table 2 shows the reference specifications, their locations, and the common names they are referred to in this document.

Table 2. References

REFERENCE SPECIFICATION	TITLE	LOCATION
The USB PD Specification	Universal Serial Bus Power Delivery Specification Revision 3.0, Version 1.2 June 21, 2018	http://www.usb.org
The USB Type-C™ Specification	Universal Serial Bus Type-C Cable and Connector Specification Release 1.3 July 14, 2017	http://www.usb.org
The TCPCI Specification	Universal Serial Bus Type-C Port Controller Interface Specification Revision 2.0, Version 1.1 March 2020	http://www.usb.org
The USB 2.0 Specification	Universal Serial Bus Specification Revision 2.0 April 27, 2000	http://www.usb.org
The USB 3.x Specification	Universal Serial Bus 3.2 Specification Revision 1.0 September 22, 2017	http://www.usb.org
The USB BC1.2 Specification	Battery Charging Specification Revision 1.2 December 7, 2010	http://www.usb.org

Power-Up and Enabling

When a valid voltage is applied to IN and HVEN is high, the MAX25432 goes through its power-up sequence as described in the <u>Power-Up Sequence</u> functional diagram. The MAX25432 power-up sequence is done when ALERT asserts low after HVEN goes high with $V_{IN} > UVLO$. The $V_{DD_{IO}}$ input must be within a valid voltage to perform I²C communication with the MAX25432 and provide a pullup voltage to the ALERT pin.

IN Supply Input

IN is the input supply for the MAX25432 and the external H-bridge buck-boost converter. The MAX25432 can operate with a V_{IN} voltage in the range of 4.5V to 36V and is load-dump tolerant up to 40V. A 1µF ceramic capacitor with appropriate voltage rating should be connected for decoupling from IN to GND. An additional 100nF closer to the IN pin is recommended for improved high-frequency decoupling for internal circuitry.

To prevent large input current from tripping an upstream automotive fuse during high output power at low input voltage, the MAX25432 integrates a programmable input undervoltage lockout. When the input voltage is below the undervoltage lockout threshold, the buck-boost controller is turned off, which prevents high current being drawn at the input. The undervoltage lockout is set by the IN_UV_THRESH[3:0] register. This voltage can be programmed in the range of 4.5V to 8.5V in steps of 0.4V. The default setting for the undervoltage lockout threshold is 4.5V and can be changed on the fly after power-up through I²C. The UVLO threshold includes a blanking time of 150µs (typ), which prevents the device from turning off during input voltage transients.

High-Voltage Enable Input (HVEN)

HVEN is used as the main enable to the device and initiates the MAX25432 start-up and configuration. If HVEN is at a logic-low level, the device enters the Off mode with low quiescent current level on IN. HVEN is compatible with inputs from 3.3V logic up to automotive battery voltages.

BIAS Linear Regulator Output

The device includes an internal 5V linear regulator (BIAS) that provides power to the internal circuit blocks. The IC powers

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up once the voltage on BIAS crosses the undervoltage-lockout (UVLO) rising threshold and shuts down when BIAS falls below the UVLO falling threshold. Connect a 4.7µF ceramic capacitor from BIAS to GND for proper operation of the linear regulator. See the <u>PCB Layout Guidelines</u> for more information.

External loads, such as an MCU or PD controller, can be connected to BIAS as a power supply as long as:

- The total BIAS current, including internal circuitry, is below 80mA. Make sure to account for the internal buck-boost drivers current consumption when the H-bridge is switching. The usable current for external loads varies depending on operating conditions.
- The power dissipated by the internal BIAS LDO does not cause the MAX25432 to exceed the maximum continuous power dissipation or junction temperature as specified in the <u>Absolute Maximum Ratings</u> section.

With the proper current budgeting, BIAS can also be used to provide V_{CONN} power. To do so, tie BIAS to the V_{CONN} pin and program the V_{CONN} OCP low threshold to the 50mA setting. Cables and accessories needing 100mW V_{CONN} can be powered with this method. A 1µF ceramic capacitor close to the V_{CONN} pin with a low impedance to ground is required to minimize voltage dips on BIAS.

External BIAS Supply

In certain applications, the 5V BIAS internal regulator can be turned off and an external voltage can be applied to the BIAS pin to provide power to the internal circuit blocks. To power the BIAS pin with an external voltage source, set the EXT_BIAS_SEL bit on register BIAS_CONTROL to 1. The default setting for this bit is 0 in which case the internal LDO is on. Connect an external voltage on BIAS after startup and before setting the EXT_BIAS_SEL bit to 1. The external voltage should be in the range of 4.7V to 5.4V for proper operation of the MAX25432.

Power-On Sequencing with External BIAS

When using an external 5V rail to power BIAS, the EXT_BIAS_SEL bit must be set after turning on the 5V rail. External back-to-back FETs can be used to switch the 5V rail on/off so as to prevent any supply conflict.

V_{DD} USB Linear Regulator Output

The $\overline{M}AX25432$ integrates a 3.3V low-dropout linear regulator. The V_{DD_USB} output is used as a clamping voltage during high-voltage events such as short-to-battery or ESD strikes on HVDP/HVDM pins. The V_{DD_USB} output is also used to power the internal 10-bit ADC on MAX25432 devices. This regulator uses the 5V BIAS regulator as its input. Connect a 1µF ceramic capacitor from V_{DD_USB} to GND for proper operation of the linear regulator. See the <u>PCB Layout Guidelines</u> for more information.

The MAX25432 includes an output undervoltage comparator that sets the read-only VDD_USB_UV status bit when the regulator output goes below $V_{DD_USB_UV} = 2.7V$ (typ). An output overvoltage comparator is also included, which sets the read-only VDD_USB_OV status bit when the regulator output goes above $V_{DD_USB_OV} = 4.0V$ (typ).

The V_{DD} USB 3.3V LDO cannot be used to power external loads.

V_{DD BMC} Linear Regulator Output (MAX25432B only)

The $\overline{M}AX25432B$ integrates a 1.125V (typ) regulated voltage reference required for BMC communication. Connect a 1µF ceramic capacitor from V_{DD_BMC} to GND for proper operation of the linear regulator. See the PCB Layout Guidelines for more information. Connect the pin directly to GND on MAX25432A devices.

V_{DD} IO Input

The \overline{V}_{DD} IO pin must be connected to the external 1.8V, 3.3V, or 5.0V V_{DD} rail used for I²C communication by the I²C master (MCU, HUB, or PD controller). V_{DD} IO is used as the pullup voltage for the SCL, SDA, and ALERT pins.

I²C communication can begin as soon as the power-up sequence is done (i.e., $\overline{\text{ALERT}}$ asserts low after HVEN goes high with V_{IN} > U_{VLO}) and the V_{DD IO} input is within a valid voltage.

In an application where neither 1.8V, 3.3V, nor 5.0V external supplies are available, the V_{DD_IO} pin can be tied to V_{DD_USB} or BIAS directly. It is recommended to place a 10nF ceramic capacitor from the V_{DD_IO} pin to GND to provide local decoupling. The V_{DD_IO} input voltage can withstand a maximum voltage of 6V.

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V_{CONN} Supply Input

The device requires an external supply on the V_{CONN} input to provide the required power for the V_{CONN} switch. The input voltage range for the V_{CONN} input is 3.0V to 5.5V but, in an application, the input voltage is typically 3.3V or 5.0V. See the V_{CONN} Switch section for more information.

Buck-Boost Controller

The MAX25432 integrates a buck-boost controller and drivers that provide power from the car battery to V_{BUS} . The buck-boost controller operates for input voltage ranges from 4.5V to 36V and is 40V load-dump tolerant. The buck-boost controller can regulate output voltages from 3.3V up to 21.0V and can limit output current from 1.0A up to 6.35A.

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Figure 1. Buck-Boost Block Diagram

The integrated buck-boost controller operates in either a buck or boost, depending on the input and output voltages. The buck-boost transitions seamlessly between these modes to maintain a constant output voltage. This seamless four-switch buck-boost transition method ensures that V_{BUS} does not droop during V_{IN} transients and helps achieve excellent efficiency, load regulation, and line regulation. The architecture consists of a peak current-mode control loop that senses the inductor current using an external current-sense resistor on the input side (R_{CS1}). The slope compensation value can be adjusted in steps of 100mV by the SLP[2:0] register from 100mV to 800mV so as to prevent subharmonic oscillations. The switching frequency is also set by writing to the FSW[1:0] register. Four switching frequency options (220kHz,

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300kHz, 400kHz, and 2.2MHz) are available in the device. To alleviate EMI problems the IC integrates a programmable spread spectrum on the switching frequency oscillator. The SS_SEL[1:0] register is used to set the desired amount of spread spectrum, which can be programmed to be $\pm 3\%$, $\pm 6\%$, and $\pm 9\%$ of the set switching frequency. The output voltage is fed back to the controller using an internal resistor divider on the OUT pin. The buck-boost control-loop is compensated externally using an RC network on the V_{COMP} pin. An output current-sense resistor (R_{CS2}) between CSP2 and OUT provides protection from runaway currents (V_{OC2}), and excessive negative currents (V_{OC3}). A third current-sense resistor (R_{CS3}) is required between OUT and CSN2 for V_{BUS} I_{LIM} DC regulation used in PPS Current-Limit (CL) mode. R_{CS3} is also used for USB cable/voltage drop compensation in order to maintain a constant V_{BUS} voltage at the user port across output current variations.

Enabling/Disabling V_{BUS}

Before enabling V_{BUS} , ensure that the I²C master performs the following initial configuration after power-up:

- 1. The V_{BUS} current limit has been set accordingly. See the V_{BUS} Current-Limit (CL) Regulation section.
- 2. The cable-compensation gain has been selected to offset any PCB trace/connector and/or cable drop. See the <u>Cable</u> <u>Compensation</u> section.
- 3. The slope-compensation peak ramp voltage is correctly set per the system requirements. See the <u>Slope</u> <u>Compensation</u> section.
- 4. The switching frequency and desired spread-spectrum settings are correctly set per the system requirements. See the <u>Switching Frequency and Spread Spectrum</u> section.
- 5. The SYNC pin direction is selected. By default, the SYNC pin acts as an input. See the <u>Synchronization Input/Output</u> (<u>SYNC</u>) section.
- The V_{BUS} undervoltage and overvoltage thresholds and masks are correctly configured for the application. By default, the 12.5% UV/OV thresholds are selected. See the <u>VBUS_THRESH</u> register description.
- No fault has been reported by the MAX25432 through the <u>SHIELDING</u> bit or dedicated V_{BUS} Fault flags. See the <u>Fault Table (Analog Devices Auto-Shield)</u>.
- V_{BUS} needs to be at vSafe0V before being enabled. Make sure the <u>VSAFE0V</u> bit in the <u>EXTENDED_STATUS[7:0]</u> register reads logic '1'.
- If a V_{BUS} pre-bias condition exists, the I²C master needs to attempt a force discharge first using MAX25432 integrated force discharge functionality. The MAX25432 issues an I²C error if V_{BUS} is not at vSafe0V prior to being enabled. See the <u>V_{BUS} Discharge</u> and <u>Fault Table (Analog Devices Auto-Shield)</u> sections.

To comply with the USB-IF TCPCI specification, the MAX25432 only sources V_{BUS} when the proper command is received from the I²C master. In order to enable V_{BUS} :

Write 0x77 (SourceVbusDefaultVoltage) to the <u>COMMAND[7:0]</u> register. The MAX25432 then soft-starts to vSafe5V (5.15V, typ).

To set V_{BUS} to non-default voltages (voltages other than vSafe5V), perform the following steps. Note that once V_{BUS} is at vSafe5V, only then can the I²C master request for non-5V outputs.

- 2. Select the desired non-default output voltage by writing to the NONDEFAULT_TARGET registers.
- Write 0x88 (SourceVbusNonDefault) to the <u>COMMAND[7:0]</u> register. The MAX25432 then transitions to the nondefault voltage with a USB PD compliant slew rate.

To change to a different non-default output voltage target, repeat steps 2 and 3. To go back to vSafe5V, perform step 1. Note that the output current limit can be changed while sourcing V_{BUS} .

To disable V_{BUS}, write 0x66 (DisableSourceVbus) to the <u>COMMAND[7:0]</u> register. The MAX25432 will then turn off the buck-boost. To discharge V_{BUS} to vSafe0V, see the <u>V_{BUS} Discharge</u> section.

For more information on specific actions to be performed with the MAX25432 to comply with USB Type-C and USB power delivery, contact Analog Devices.

Soft-Start

The buck-boost output is enabled by the I²C master by writing to the COMMAND register. When enabled, the controller soft-starts by gradually ramping up the output voltage from vSafe0V to vSafe5V (5.15V, typ). This soft-start feature reduces inrush current during startup. Soft-start is guaranteed into compliant USB loads. Only after the voltage reaches vSafe5V can the buck-boost output voltage be adjusted to other voltage options by the I²C master. The typical soft-start time is 6.5ms.

Switching Frequency and Spread Spectrum

The MAX25432 provides a programmable switching frequency and spread spectrum through I²C. The internal oscillator frequency is set by the FSW[1:0] register. The switching frequency can be programmed to 220kHz, 300kHz, 400kHz, or 2.2MHz.

Spread spectrum can be enabled and adjusted by writing to the SS_SEL[1:0] register. Spread spectrum can be programmed to $\pm 3\%$, $\pm 6\%$, and $\pm 9\%$ centered on f_{SW}. The default oscillator frequency at power-up is 400kHz with no spread spectrum.

Table 3 shows the typical variation of the switching frequency for each spread-spectrum setting.

Table 3. Spread-Spectrum Settings vs. Switching Frequency

f _{SW} (kHz)	SPREAD-SPECTRUM MODULATION FREQUENCY (kHz)			
	±3% SETTING	±6% SETTING	±9% SETTING	
220	±6.6	±13.2	±19.8	
300	±9	±18	±27	
400	±12	±24	±36	
2200	±66	±132	±198	

Synchronization Input/Output (SYNC)

The MAX25432 integrates a clock synchronization input/output to be used in two-port applications or with other power supplies in the module. The benefits of the synchronization between two switching power supplies are as follows:

- Reduced input capacitance requirement due to 180° out-of-phase current demands, which leaves time for the input capacitors to recharge between each cycle.
- Reduced EMI due to less input current ripple. This translates to a smaller inductor required for the module input EMI filter.

Both the reduced input capacitance requirement and reduced input current ripple help reduce system cost significantly.

The SYNC pin direction can be configured through I²C as either an input or an output through the SYNC_DIR register. SYNC_DIR is a one-bit register which is set by default to logic '1'. In this case, the SYNC pin on the MAX25432 is expecting an external input signal to synchronize its oscillator to the input on the SYNC pin. If there is no input on this pin, the buck-boost operates with the internal oscillator. Connect SYNC to GND and configure it as an input if not used.

The SYNC_DIR bit can be set to logic '0' by the I²C master. In this case, the SYNC pin acts as an output and, when sourcing V_{BUS} , generates a fixed 50% duty cycle square waveform at the master's switching frequency that is phase shifted by 180°, as shown in <u>Figure 2</u>. Note that only buck operation is shown. The SYNC feature also supports boost and buck/boost operation.

The internal spread spectrum is disabled if SYNC is configured as an input and synchronized to an external clock.

When configured as an output, the SYNC signal includes the spread-spectrum modulation for the slave to synchronize to.

When configured as an input, the external clock signal must be within f_{SYNC_RANGE} of the programmed switching frequency f_{SW} and have a duty cycle between 30% to 70% for the MAX25432 to synchronize properly. If not, the slave reverts to its internal clock synchronization autonomously without changing the SYNC_DIR bit.

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Figure 2. SYNC Operation Diagram

Input Current Limit

The MAX25432 features a peak input current limit. The device limits the input current by reducing the output voltage if the sensed voltage drop across the input current-sense resistor ($V_{CSP1} - V_{CSN1}$) is above the fixed V_{OC1} threshold (50mV, typ). The current threshold can be selected with the input current-sense resistor value R_{CS1} . See the <u>Current-Sense</u> <u>Resistors Selection</u> section.

An input overcurrent event sets the latched, read-only IN_OC status bit to logic '1' after a debounce of 16ms.

The MAX25432 reports the event to the VNDR_ALRT <u>bit in the ALERT_H</u> register if the IN_OC_MASK is unmasked. Additionally, if MSK_VNDR_ALRT bit is unmasked, the ALERT pin is asserted low.

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V_{BUS} Current-Limit (CL) Regulation

The MAX25432 features a programmable DC current-regulation loop on V_{BUS} to support PPS CL operation. The buck-boost is allowed to enter the CL mode only when the CL_EN bit is set to 1, as seen in Figure 3.



Figure 3. CL_EN Diagram

When CL_EN = 1 and the V_{BUS} DC output current monitored on R_{CS3} is less than the programmed current-limit threshold set in the VBUS_ILIM_SET[7:0] register, the buck-boost stays in Constant-Voltage (CV) mode and V_{BUS} is regulated to the programmed voltage target (default or non-default V_{BUS}).

When the V_{BUS} DC output current is above the current-limit threshold, the ICOMP voltage increases and drives the internal feedback node higher to reduce V_{BUS} and maintain constant current. As the PD device increases its load, V_{BUS} reduces further and the MAX25432 maintains accurate regulation until the PD device reduces its load or the sensed OUT voltage reaches the V_{BUS} STG threshold (2.85V, typ), which will turn off the buck-boost. See the <u>Fault Table (Analog</u> <u>Devices Auto-Shield)</u> for more information on the V_{BUS} STG fault.

The buck-boost regulation mode is indicated by the OMF_TRANS and the CL_CV bits in the VENDOR_STATUS and AUTO_SHIELD_STATUS_1 registers, respectively. See the register descriptions in the <u>Register Map</u> for more details.

When CL_EN = 0, the MAX25432 is prevented from entering CL mode. The MAX25432 does not regulate the output current in this mode and maintains CV regulation for the debounce duration. If the current exceeds the programmed

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threshold in the VBUS_ILIM_SET[7:0] register for more than 16ms (typ), the MAX25432 turns off the buck-boost controller to protect itself and the sink. This setting is recommended when sourcing vSafe5V or fixed PDOs, and also to meet the MFi Overcurrent specification (introduced in the R30 revision in 2018).

Additionally, a fixed overcurrent protection (V_{BUS} OCP), independent of CL_EN setting, is always active when sourcing V_{BUS} . The fault is triggered when V_{BUS} current exceeds 6.4A DC (typ) which immediately causes the buck-boost controller to turn off.

See the *Fault Table (Analog Devices Auto-Shield)* for more information on action, reporting, and recovery upon a V_{BUS} current-limit or OCP condition.

VBUS Short-to-GND (STG) Comparator

The buck-boost output is protected against an STG condition. An STG event is detected when OUT goes below 2.85V (typ) for CL_EN = 1 or below 2.0V (typ) for CL_EN = 0 while V_{BUS} is being sourced. In this case, the buck-boost controller is turned off immediately. See Fault Action A in the *Fault Types* table.

Integrated VOUT Pulldown

While the buck-boost is disabled, an active pulldown of $16k\Omega$ (typ) is switched on to keep V_{BUS} at vSafe0V.

Cable Compensation

USB charging current of devices could be as high as 5A while connectors and cables contribute to voltage drops. Stringent USB port supply voltage specifications increase the need for compensation, and excessive voltage drop causes device disconnects. The voltage drop compensation is implemented by measuring the current and feeding back the current information to the internal feedback block of the converter. In this implementation, the load regulation of the power supply is effectively changed to compensate a voltage drop on a power line.



Figure 4. Cable Compensation Benefit

The MAX25432 compensates voltage drops for up to 516m Ω from parasitic resistance present from the OUT pin to the user cable, including but not limited to the USB captive cable, PCB trace, and inline connectors. The cable compensation is designed for use in the constant voltage region at up to 5A. Cable compensation stays active upon entry into current-limit region. The gain of the cable-compensation circuit can be adjusted through I²C by changing the values in GAIN[5:0] in the cable-compensation control register CABLE_COMP_CONTROL. The R_{CS3} external current-sense resistor is required when using the cable-compensation feature. See the <u>USB Cable Compensation</u> section for guidelines.

Thermal Shutdown

Thermal shutdown protection limits the temperature the device is allowed to reach before forced shutdown. If the die temperature exceeds +165°C, the device shuts down and needs to cool down. Once the device has cooled down by 15°C, the device is automatically enabled again (as long as HVEN is still high and V_{IN} is above UVLO). The thermal overload protects the device in the event of overheating. For continuous operation, do not exceed the absolute maximum junction temperature of +150°C. For more information regarding actions and recovery steps taken upon a thermal shutdown fault, see the *Fault Table (Analog Devices Auto-Shield)* and *Fault Types* sections.

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USB Type-C and Power Delivery



Figure 5. USB Type-C Functional Block Diagram

A detailed breakdown of the block diagram and operation is provided in the following sections.

Configuration Channel (CC1 and CC2)

To maintain the USB host/device relationship, Type-C requires a configuration channel (CC). It is through the CC pins that current capabilities are advertised and detected, as well as how the host detects the cable orientation, which is required for USB3 and active cables. In the USB Type-C solution, two pins on the connector, CC1 and CC2, are used to establish and manage the source-to-sink connection.

Functionally, the CC is used to serve the following purposes.

- Detect attachment of USB ports (e.g., a source to a sink)
- Resolve cable orientation and twist connections to establish USB data bus routing
- · Establish data roles between two attached ports

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- Discover and configure V_{BUS}: USB Type-C current modes or USB PD
- Configure V_{CONN}
- Discover and configure optional Alternate and Accessory modes

The CC pins utilize combinations of pullups and pulldowns to detect Type-C device attachment, advertise the current capabilities of the source, and detect the type and orientation of the cable and the device. There are three possible pullups (Rp) which represent the three source current capabilities: default, 1.5A, and 3A. Additionally, there are two possible device pulldown resistors (Ra and Rd) to provide device and cable information to the host. This configuration allows for simultaneous advertisement and detection. The Type-C specification also allows for dynamic Rp changes without any resets.

CC Pass-Through Switches

The Type-C block includes the CC-to-HVCC pass-through switches that provide a protected communication path between the USB PD controller and handheld device. See the CC Pass-Through Switches section for more information.

VCONN

While there are two HVCC pins that must be monitored on the host receptacle, there is only one CC wire running through the Type-C cable. This is how orientation can be determined. This leaves the second HVCC pin available for other uses. The Type-C specification allows the unused HVCC pin to operate as V_{CONN} , a low-power source intended to power active cables which may include authentication ICs or super-speed muxes.

The MAX25432 includes complete support for V_{CONN} power control and protection. When a power source within the acceptable operating voltage is connected to the V_{CONN} pin, the MAX25432 can connect the voltage source to the appropriate HVCC pin. Back-to-back V_{CONN} FETs provide overvoltage and overcurrent protection to the V_{CONN} source in addition to controlling the application of V_{CONN} per the Type-C specification.

The advantage of the MAX25432 is the ability to provide V_{CONN} power from a low-power system supply to a wide-range of E-marked cables (i.e., using the same supply used to power the USB PD controller or MCU), essentially reducing the current budget needed for supplying V_{CONN} and hence reducing the cost and solution size.

However, certain V_{CONN} loads draw currents that exceed the Type-C specification of 1W (max), shortly after V_{CONN} is sourced. This causes unwanted inrush currents and droops on the system supply, ultimately causing a module reset.

To overcome this limitation while being able to provide in the range of 100mW to 1W V_{CONN} power, the MAX25432 implements a dual-threshold overcurrent protection (OCP) with specific debounce timers and a fast UV comparator on the V_{CONN} pin. The first overcurrent threshold (OCP low) is programmable from 50mA to 500mA (typ) with a debounce of 400µs, which allows exceeding the 1W limit momentarily and during startup of the V_{CONN} load circuitry. The second OCP threshold (OCP high) threshold is fixed and set to 750mA (typ) and has a debounce of 5µs, which protects the system supply from noncompliant V_{CONN} loads and/or short circuits. STG diagnostic circuitry is also implemented in order to detect if a STG condition is present before closing the V_{CONN} switch and avoid collapsing the upstream supply.

Enabling V_{CONN}

- Program the V_{CONN} OCP low setting by writing to the VCONN_OCPL_SEL[3:0] register. To power 100mW, 5A E-marked cables, the 50mA setting is recommended. Adjust the OCPL threshold based on desired V_{CONN} power supported.
- 2. Program the V_{CONN} UV setting by writing to the VCONN_IN_UV_THRESH bit. UV settings of 4.65V and 3.05V are recommended for 5V supply and 3.3V, respectively. The default value at power-up is 3.05V.
- 3. Make sure the V_{CONN} supply is enabled and above the V_{CONN} UV-programmed threshold. Read the VCONN_IN_UV status bit to verify.
- 4. Unmask Fault and Status bits as desired.
- 5. Select the HVCC channel where V_{CONN} is needed by setting the cable polarity bit PLUG_ORNT in the TCPC_CONTROL register.
- 6. Set the EN_VCONN bit to logic '1' to enable V_{CONN}.
- If V_{CONN} has successfully started up, the MAX25432 sets the POWER_STATUS.VCONN_PRESENT bit to indicate V_{CONN} is being sourced. On the MAX25432B, the corresponding HVCC comparator (found in HVCC_STATUS register) will go from "Ra" to "Open".
- 8. Monitor the OCP and UV fault flags.
- 9. To disable V_{CONN}, set EN_VCONN to logic '0'.

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V_{CONN} Startup

Once the V_{CONN} input is within its operating range and after V_{CONN} is enabled on a HVCC channel, the diagnostic current is enabled on the corresponding channel and the STG comparator is active and monitoring HVCC. If HVCC is above the STG threshold (0.5V, typ), the V_{CONN} switch is soft-started and the diagnostic current turned off after 500 μ s. The MAX25432 indicates that V_{CONN} has soft-started successfully by setting POWER_STATUS.VCONN_PRESENT to logic '1'.

After V_{CONN} is enabled on a HVCC channel, the IC monitors for additional faults related to V_{CONN} operation.

V_{CONN} Short-to-Ground Detection (STG Detection)

Every time V_{CONN} starts or restarts, the MAX25432 checks for an STG condition. An actual hot STG condition usually trips the V_{CONN} UV fault or V_{CONN} OCP high first. If an STG condition is maintained, the V_{CONN} switch does not soft-start.

When a V_{CONN} STG condition is detected, a 30mA diagnostic current (typ) is enabled for 8ms (typ). If HVCC rises above the STG threshold during the 8ms, the V_{CONN} switch is soft-started normally. If the HVCC voltage does not go above the STG threshold by the end of the 8ms, the MAX25432 disables the diagnostic current source, then waits for 16ms before re-enabling it again and repeating the cycle until either the STG condition is removed or V_{CONN} is disabled through I²C. The STG retry time is fixed at 16ms and cannot be changed.

V_{CONN} Reverse Overvoltage (Reverse OV)

On the first V_{CONN} reverse-OV fault, the V_{CONN} switch is immediately turned off, the diagnostic current is enabled on the corresponding channel and the STG comparator is active and monitoring HVCC.

The MAX25432 reports the fault by setting the VCONN_REV_OV status bit on the first fault and as long as the fault condition is present. Once the fault clears, the V_{CONN} switch attempts to restart autonomously after the time set in the RETRY_TMR register, as long as the VCONN_EN bit is still set to logic '1'.

V_{CONN} Autoretry

Due to the fact that the V_{CONN} supply is a shared supply, asynchronous system loads can happen while sourcing V_{CONN} . For this reason, a V_{CONN} autoretry feature is implemented to minimize the software interaction when sourcing V_{CONN} with a shared supply.

If a V_{CONN} load tries to draw an excessive amount of current for more than the debounce time, the V_{CONN} switch automatically opens to avoid drooping the upstream power supply, then will retry automatically. After three consecutive faults, the ALERT pin asserts indicating the I²C master to take action if needed.

The autoretry feature is only active for the V_{CONN} OCP and V_{CONN} UV faults.

V_{CONN} Overcurrent Protection (OCP Low/High)

On the first V_{CONN} OCP fault and after the debounce time, the V_{CONN} switch is immediately turned off, the diagnostic current is enabled on the corresponding channel and the STG comparator is active and monitoring HVCC.

If another OCP fault is detected, the fault process repeats again. After three consecutive faults, the VCONN_OCP_FAULT bit is latched and the retry timer starts (default 16ms). Once the timer expires, the SHIELDING bit is set and the process repeats again with the fault counter restarting. Note that only the I²C master can clear the VCONN_OCP_FAULT bit.

Upon the VCONN_OCP_FAULT bit being set, the I²C master can take action to clear the bit, then disable V_{CONN}. The I²C master can proceed without powering the noncompliant E-marked cable until a new cable is detected.

To disable the OCP fault detection, set the VCONN_OCP_DET_EN bit to 1 in the FAULT_CONTROL register.

V_{CONN} Undervoltage (UV)

On the first UV fault, the V_{CONN} switch is immediately turned off, the diagnostic current is enabled on the corresponding channel and the STG comparator is active and monitoring HVCC. If the fault is no longer present, the V_{CONN} switch soft-starts normally as described in V_{CONN} Startup in the <u>USB Type-C and Power Delivery</u> section.

However, if another UV fault is detected, the fault autoretry is engaged and the fault process repeats again. After three consecutive faults, the VCONN_IN_UV status bit is set and the retry timer will start (default 16ms). Once the timer expires, the process repeats again with the autoretry fault counter restarting at 0.

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The MAX25432 reports the fault by setting the VCONN_IN_UV status bit on the third fault and as long as the fault condition is present.

To disable the V_{CONN} UV fault reporting, set the VCONN_OCP_DET_EN bit to 1 in the FAULT_CONTROL register. Note the V_{CONN} UV fault actions and recovery will still be active in this case; only the reporting will be disabled.

V_{CONN} Automatic Discharge

To comply with the Type-C specification, the corresponding HVCC pin is discharged for 1ms every time V_{CONN} is disabled. The internal discharge circuit consists of a 2.65k Ω resistance and a low-side FET.

Legacy Devices

The Type-C specification ensures interoperability with Type-A/Type-B devices by defining requirements for legacy adapters. As a DFP, relevant adapters connect from the Type-C receptacle to either a Type-B plug or to a Type-A receptacle, which can then be used with any legacy Type-A cable. A compliant legacy adapter of this type must include an Rd termination inside the adapter. In this case, the MAX25432 detects a Type-C attachment whenever the adapter is connected, regardless of whether a portable device is connected. The portable device sees the DFP as a BC1.2 port (when configured as such). See the <u>Host Charge Emulation</u> section for additional information.

Port Controller and Power Delivery

Type-C Port Controller Interface (TCPCI) (MAX25432B only)

The MAX25432B devices implement a TCPCI as defined in the USB Type-C Port Controller Interface Rev. 2.0 Ver. 1.1.

TCPCI is the interface between a USB Type-C port manager (TCPM) and a USB Type-C port controller (TCPC).

The goal of the TCPCI is to provide a defined interface between a TCPC and a TCPM to standardize and simplify USB Type-C port manager implementations.

The TCPC is a functional block which encapsulates V_{BUS} and V_{CONN} power controls, USB Type-C CC logic, the USB PD BMC physical layer and protocol layer other than the message creation.

Contact Analog Devices for more information on how to program the TCPM to work with the MAX25432B.

BMC Transmitter (MAX25432B only)

The MAX25432B supports USB PD message transmission and reception (Tx/Rx) through the bi-phase mark coding (BMC) interface on the HVCC channels. The BMC communication is used by the source and sink to exchange USB PD messages. The BMC communication is single ended and occurs between two port partners (a source and a sink) after a Type-C attachment has been successfully made. The CC line that is going through the USB cable is used by the two port partners to communicate using BMC.

The BMC transmitter driver overdrives the DC bias voltage on the HVCC pin that is set for device attachment while transmitting. The BMC transmitter driver returns to a Hi-Z state when not transmitting.

Note: The MAX25432B meets the BMC eye diagram specifications as defined in the USB Power Delivery Specification. The MAX25432B's BMC driver is referenced to the SHLD_SNS pin and therefore BMC communication is not affected by the IR drop caused by the external shield short-to-battery FET, if used. A Type-C captive cable with dedicated ground sense allows compensation for ground offset during charging as pictured in Figure 6.

For more information on the BMC Protocol and Signaling, refer to the USB Power Delivery Specification Revision 3.0, Version 1.2.

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Figure 6. USB PD PHY Ground Offset Compensation

Sink Tx Ok (MAX25432B only)

When a PD contract is established, the sink shall ignore Rp current advertisement as USB PD takes precedence over Type-C.

After a PD contract, the TCPM can change the Rp advertisement of the TCPC to signal Sink Tx Ok. Rp advertisement is therefore used as a low-level signaling feature. This feature was added in USB PD Revision 3.0.
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V_{BUS} Voltage and Current ADC

<u>Figure 7</u> shows the block diagram of the V_{BUS} voltage and current ADC. The MAX25432 integrates signal conditioning, multiplexing, conversion, and result registers. The conversion results are used to trigger interrupts using the V_{BUS} voltage alarms registers or can be read by the TCPM for periodic monitoring.



Figure 7. V_{BUS} ADC Block Diagram

All MAX25432 devices integrate a V_{BUS} voltage and current continuous-sampling SAR ADC with a resolution of 10 bits for voltage and 7 bits for current.

The ADC sampling is disabled at POR. To enable sampling, write logic '0' to bit D6 (VBUS_VOLT_MON_EN) of the POWER_CONTROL register 0x1C. To stop ADC sampling, write logic '1' to bit D6 of the POWER_CONTROL register 0x1C.

The POWER_CONTROL register is shown in Figure 8.

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Figure 8. POWER_CONTROL Register for ADC Control

The voltage conversion result after each sample is stored in registers VBUS_VOLTAGE_L and VBUS_VOLTAGE_H and can be accessed through an I²C Read transaction. The MAX25432 maintains synchronization of the 10-bit result between the VBUS_VOLTAGE_L and VBUS_VOLTAGE_H registers by latching the VBUS_VOLTAGE_H value at the time of the VBUS_VOLTAGE_L is read. Therefore, an I²C Read Word transaction starting at VBUS_VOLTAGE_L address is recommended. See the I²C Interface section for more information on the Read Word transaction.

The current conversion result after each sample is stored in the VBUS_CURRENT register and can be accessed through an I²C Read Byte transaction.

The VBUS_VOLTAGE_L, VBUS_VOLTAGE_H, and VBUS_CURRENT registers are shown in Figure 9.

ADDR 0x70	REGISTER NAME VBUS_VOLTAGE_L	POR 0x00	D7	D6	D5	D4 VBUS VO	D3 LTAGE[7.0]	D2	D1	D0
0x71	VBUS_VOLTAGE_H	0x00			1	1000_10			VBUS_VO	LTAGE[9:8]
0x80	VBUS_CURRENT	0x00				VBUS_CU	RRENT[7:0]			
NOTE: REGISTER ACCESS READ/WRITE READ ONLY										

Figure 9. Voltage and Current Registers for ADC Result

A 10-bit value for the voltage conversion result is obtained by combining bits D[1:0] of the VBUS_VOLTAGE_H register with bits D[7:0] of the VBUS_VOLTAGE_L register.

V_ADC_Result = (UInt16)((VBUS_VOLTAGE_H & 0x03) x 256) + VBUS_VOLTAGE_L)

To convert the ADC_Result to the measured V_{BUS} voltage, multiply it by 25mV.

To convert the VBUS_CURRENT[7:0] result to the measured V_{BUS} current, multiply its decimal value by 50mA. Note that the VBUS_CURRENT[7] bit always equals 0b (7-bit effective on a 8-bit register).

Note that since voltage and current are measured one after the other, new conversion results in VBUS_VOLTAGE[9:0] and VBUS_CURRENT[7:0] registers are 1ms apart (typ).

The ALERT pin will not assert when a new conversion result is ready. The I²C master must use polling to read the most recent conversion results.

See the register descriptions in the <u>Register Map</u> for more information on the ADC.

V_{BUS} Alarms (MAX25432B only)

The 10-bit ADC conversion results are compared with the alarms thresholds set by the TCPM. Those alarms can be used

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to alert the TCPM during USB PD V_{BUS} voltage transitions or in CL mode. To enable V_{BUS} alarms, write a logic '0' to VOLT_ALRMS_EN bit in the POWER_CONTROL register. The V_{BUS} ADC must be enabled for the alarms to operate.

The MAX25432B V_{BUS} alarms are compliant with the USB PD specification. Contact Analog Devices for more information on how to program the V_{BUS} alarms.

vSafe0V Comparator

To comply with the Type-C specification, the MAX25432 implements a vSafe0V comparator to indicate when V_{BUS} (sensed on the OUT pin) is below the vSafe0V threshold. Unlike the V_{BUS} discharge stop threshold, the vSafe0V threshold is fixed to 0.75V falling with a 50mV hysteresis (typ).

The I²C master can check the status of the vSafe0V comparator by reading the VSAFE0V bit in the EXTENDED_STATUS[7:0] register located in the TCPCI-compliant register section.

A logic '1' of this bit signifies V_{BUS} is at or below vSafe0V threshold. A logic '0' signifies V_{BUS} is above the vSafe0V threshold. This status bit is read-only and non-latched.

Whenever the VSAFE0V bit changes and the MSK_VSAFE0V is set to '1' (unmasked), the EXTENDED_STATUS alert bit is set.

The vSafe0V status is valid only when the V_{BUS} Detection Enabled bit (VBUS_DET_EN) located in the POWER_STATUS[7:0] register becomes a '1'. The VBUS_DET_EN bit is read-only and indicates the MAX25432 is monitoring for V_{BUS} present and vSafe0V thresholds.

V_{BUS} Present Comparator

In order to enable the V_{BUS} present comparator, the TCPM must send the EnableVbusDetect command (0x33) to the COMMAND register.

Whenever the VBUS_DET_EN read-only bit becomes logic '1', the V_{BUS} present comparator is active and monitoring the OUT pin. If the voltage sensed on OUT goes above 4V (typ), the MAX25432 sets the VBUS_PRESENT bit in the POWER STATUS register to alert the TCPM that V_{BUS} is present on the Type-C connector.

To disable the comparator, the TCPM must send the DisableVbusDetect command (0x22). Note that the EnableVbusDetect and DisableVbusDetect commands also enable and disable the vSafe0V comparator, respectively.

V_{BUS} Overvoltage/Undervoltage (OV/UV) Comparator

Programmable V_{BUS} OV and UV comparators are implemented in the MAX25432.

To program the V_{BUS} OV and UV thresholds, write to VBUS_OV_THRESH[2:0] and VBUS_UV_THRESH[2:0], respectively, located in the VBUS_THRESH[7:0] register. The thresholds are set to +12.5% and -12.5% of the current V_{BUS} target set by the VOUT_SEL[1:0] register.

Upon an overvoltage event on V_{BUS} , the MAX25432 will turn off V_{BUS} and discharge it to vSafe0V immediately (Fault Action A). See the Fault Detection and Diagnostics section for more information on this fault.

The MAX25432 will report an overvoltage event through the VBUS_OVP_FAULT in FAULT_STATUS register if the VBUS_OVP_DET_EN in the FAULT_CONTROL register is set to logic '1'. If the MSK_VBUS_OVP bit in FAULT_STATUS_MASK register is unmasked, the FAULT_STAT bit in the ALERT_H register will be set and latched to logic '1'. The ALERT pin will be asserted low if the MSK_FAULT_STAT bit is unmasked. Write a '1' to FAULT_STAT and VBUS_OVP_FAULT to clear the fault.

The MAX25432 will report an undervoltage event through the VBUS_UV status bit in the AUTO_SHIELD_STATUS register. If the VBUS_UV_MASK bit in the AUTO_SHIELD_STATUS_MASK register is unmasked, the VNDR_ALRT bit will be set and latched to logic '1'. The ALERT pin will be asserted low if the MSK_FAULT_STAT bit is unmasked. Write a '1' to VNDR_ALRT to clear the fault.

See the <u>Mask Registers and Nested Alerts</u> section for a complete overview of the fault reporting tree through mask registers.

V_{BUS} Discharge

When V_{BUS} is disabled, the residual charge stored in the buck-boost output capacitance must be removed to comply with the Type-C specification. The MAX25432 has an internal discharge path that when activated, discharges V_{BUS} to a

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set threshold. <u>Figure 10</u> shows the discharge internal circuitry used for both force and auto-discharge features, which are compliant with the USB PD and TCPCI specifications.



Figure 10. V_{BUS} Discharge Block Diagram

V_{BUS} Force Discharge

Whenever the FORC_DISCH_EN bit D2 in the POWER_CONTROL register is set from logic '0' to '1', the 125 Ω discharge R_{DIS} is switched on and the discharge monitoring starts. The MAX25432 automatically disables the force discharge circuit (without clearing FORC_DISCH_EN bit) once the voltage on V_{OUT} has reached the value indicated by the 10-bit VBUS_STOP_DISCH_THRESHOLD register. It is recommended to use the minimum stop threshold of 0.5V to pass compliance.

If V_{OUT} does not reach the programmed Stop threshold (default 0.8V) within 650ms, the discharge stops to avoid possible overheating and flags the FORCE_DISCH_FAIL bit, which, if unmasked, sets the FAULT_STAT bit in the ALERT_H register. If FAULT_STAT is unmasked, ALERT is asserted. A typical use case of the V_{BUS} force discharge is after a device disconnect when using a PD controller with the MAX25432A or a hard reset when using either the MAX25432A or MAX25432B.

See the <u>Register Map</u> for more information on the V_{BUS} force discharge function.

V_{BUS} Auto-Discharge

The V_{BUS} auto-discharge function (MAX25432B devices only) is enabled by setting the AUTO_DISCH_DISC_EN bit D4 to 1 after a device attachment. When the MAX25432 detects a device disconnect, sourcing V_{BUS} is disabled, then the 125 Ω discharge resistor R_{DIS} is switched on automatically and discharge monitoring starts. The MAX25432 automatically disables the auto-discharge circuit (without clearing AUTO_DISCH_EN bit) once the voltage on V_{OUT} has reached the value indicated by the 10-bit VBUS_STOP_DISCH_THRESHOLD register. It is recommended to use the minimum stop threshold of 0.5V to pass compliance.

If V_{OUT} does not reach the programmed stop threshold within 650ms, the discharge stops to avoid possible overheating and flags the AUTO_DISCH_FAIL bit, which, if unmasked, sets the FAULT_STAT bit in the ALERT_H register. If FAULT_STAT is unmasked, ALERT is asserted.

See the <u>Register Map</u> for more information on the V_{BUS} auto-discharge function.

Figure 11 shows the POWER_CONTROL register which contains the V_{BUS} auto and force discharge enable bits.

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Figure 11. POWER_CONTROL Register for V_BUS Discharge

<u>Figure 12</u> shows a typical V_{BUS} discharge waveform. The blue curve shows a V_{BUS} discharge reaching the programmed stop threshold before the 650ms timeout and is therefore successful and no error flag is set. The red curve shows a discharge that did not reach the stop threshold on time and therefore is flagged as fail on either the FORCE_DISCH_FAIL or AUTO_DISCH_FAIL depending on the type of discharge used.



Figure 12. V_{BUS} Discharge Timing Diagram

Note: t_{SAFE0V} maximum value is defined in the USB PD specification.

Discharge Time

Due to the high-side FET circuit topology, V_{OUT} is discharged at a constant current rate first, down to 3.3V, then at a rate of R_{DIS} . C_{TOT} .

The discharge time t_{DIS} can be estimated using the following equation:

$$t_{\text{DIS}} = C_{\text{TOT}} \cdot \left[\frac{V_{\text{START}} - 3.3V}{I_{\text{DIS}}} - R_{\text{DIS}} \cdot \ln \left[\frac{V_{\text{STOP}}}{3.3V} \right] \right]$$

Where:

C_{TOT}: the total output capacitance, in F

 V_{START} , V_{STOP} : the start and stop voltages, in V

 R_{DIS} : the internal discharge resistance, in Ω . R_{DIS} = 125 Ω (typ)

I_{DIS}: the constant current discharge rate when V_{BUS} > 3.3V, in A. I_{DIS} = 28mA \pm 20%

Example

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Table 4 shows typical discharge times for different output voltages.

Table 4. Discharge Times for Different Output Voltages

V _{BUS}	TYPICAL DISCHARGE TIME TO 0.5V*	
vSafe5V	65ms	
9V	94ms	
15V	141ms	
21V	187ms	

*With $C_{TOT} = 200\mu F$ (bulk) + $30\mu F$ (ceramic) = $215\mu F$ effective capacitance

Host Charge Emulation



Figure 13. Host Charge Emulation Block Diagram

Note: USB-IF does not allow non-USB charging protocols on a USB Type-C connector. Analog Devices provides these features as optional for the user.

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Charge Mode Selection

The MAX25432 integrates the latest USB-IF Battery Charging Specification Revision 1.2 (BC1.2) CDP and DCP circuitry. The Auto-DCP modes provide either 1.0A and 2.4A resistor bias options for Apple-compliant devices. Legacy Samsung Galaxy 1.2V divider and China YD/T1591-2009 compatibility is also provided by the Auto-DCP modes.

Refer to the following Analog Devices Tutorials for more information on BC1.2:

- USB Battery Charging and Adapter Emulators
- Overview of USB Battery Charging Revision 1.2 and the Important Role of Charger Detectors

Table 5. Charge Mode Truth Table

HVEN	AUTO_CDP_DCP_MODE[1:0] SA SWITCH		SB SWITCH	CHARGE MODE
Low	X	OFF	OFF	Off
	00 (Default)	ON	OFF	Hi-Speed Pass-Through (SDP)
High	01	ON if CDP = 0	ON if CDP=1	Auto-CDP
_	10	OFF	ON	Auto-DCP/Apple 2.4A
	11	OFF	ON	Auto-DCP/Apple 1.0A

Note: The host charge emulation block, which includes the Auto-CDP and Auto-DCP state machines, is independent of the Type-C interface, V_{BUS} or V_{CONN} status, and vice versa. Certain faults will turn off, then reset the host charge emulation block. See the *Fault Table (Analog Devices Auto-Shield)* for more information.

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Auto-CDP Mode



Figure 14. Auto-CDP State Diagram

This mode allows simultaneous charging through V_{BUS} (up to 1.5A per BC1.2*) and data transfer through the USB data path. In the Auto-CDP mode, the HVDP/HVDM pins are initially used to support primary and secondary detection implemented by the PD prior to switching over to their data roles during the USB session. Note that LS/FS and USB Hi-Speed 2.0 communication is only supported in the USB session state (starting in step 7, ending in step 9).

Within the Auto-CDP mode, the MAX25432 will automatically transition between CDP signaling and the USB session state without software interaction. The principle of operation is described as follows:

- The USB data switches (SA switches) are initially open (step 0 in Figure 14), and the detection circuitry is connected to HVDP/HVDM (SB switches). This is the resting state in the Auto-CDP mode and is the called CDP Signaling state. In the CDP Signaling state, 19kΩ (typ) pulldowns are applied on HVDP/HVDM and IDAT_SINK is active on HVDP.
- Upon being plugged in, the portable device may perform data contact detection (DCD) to check whether the data pins have made contact. Some portable devices skip this step and instead implement a delay.
- Once DCD is done, the portable device will apply 0.6V (typ) on HVDP and look for the same voltage on HVDM (step 1). If it sees the same voltage, it knows the host is either a CDP or a DCP.
- Once the MAX25432 sees the 0.6V voltage on HVDP, it will apply 0.6V on HVDM by turning on V_{DAT_SRC} (step 2). This step is called primary detection and is used to differentiate between a charging port and a standard downstream port (SDP). Per the BC1.2 specification, a charging port may support USB data (CDP) or be used only for charging (DCP).
- In secondary detection, the MAX25432 turns off the 0.6V source on HVDM (step 3), the portable device turns off the 0.6V source on HVDP (step 4) and applies 0.6V on HVDM (step 5). Since no voltage will appear on HVDP, the portable device knows it is attached to a CDP (step 6). This is the last step of the BC1.2 detection and is used to

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differentiate between a CDP and a DCP.

Once the CDP detection is done, the MAX25432 will look for the enumeration signal on either HVDP or HVDM (1.6V, typ). Once this signal is detected, the MAX25432 will close the data switches (step 7) to allow the host and device to establish USB Hi-Speed communication (step 8). This state is called USB Session mode and is exited when no data traffic has happened on the bus for 500ms or more (step 9).

* Note that a higher Type-C or USB PD current advertisement takes precedence over BC1.2.

USB On-The-Go, Dual-Role Applications and Field Programmability

The MAX25432 is fully compatible with USB OTG and dual-role applications. A negotiated role swap (HNP or Apple CarPlay) requires no software interaction with the IC. When there is no negotiation before the SoC enters peripheral mode, the MAX25432 must be in Hi-Speed pass-through (SDP mode) before and during the role swap.

The MAX25432 devices default to SDP mode on startup. This configuration allows a role swap immediately upon startup without microcontroller interaction. This also allows the application firmware to be programmable though the USB data lines once the vehicle is in the field.

Note that the I²C master can change the Data Switch mode anytime by writing to the AUTO_CDP_DCP_MODE[1:0] register.

Protection

In an automotive Type-C PD application, several threats to the module can be encountered.

In case of a short-to- V_{BUS} event on CC connector pins, the V_{CONN} switch must protect the upstream supply against overvoltage. The CC switches must clamp and dissipate the energy in order to protect the upstream CC controller from pin damage.

In case of a short to GND, the shared 3.3V or 5.0V rail supplying V_{CONN} shall not brownout or be damaged.

For applications with a USB 2.0 host, the host's DP/DM pins typically have an absolute maximum rating of V_{DD} + 0.3V = 3.6V and therefore will not survive any short-to-battery, short-to-V_{BUS}, or automotive ESD event.

Short-to-battery (18V) can happen during module assembly, repair, or in the field (e.g., the end-user dropping the end of cable in the cigarette lighter).

Short-to-V_{BUS} (21V PD, up to 24V) is very common for USB Type-C ports and can happen upon device removal due to mechanical twisting, debris, or insertion of a non-PD compliant source into the port.

The MAX25432 protects the module against all of these threats.

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Figure 15. USB Power Delivery Protection Block Diagram

USB 2.0 Data Switches

The DP and DM pins are the protected side of the USB data switches and connect directly to the low-voltage upstream USB PHY or captive cable. No external circuitry is used on either data pin.

The HVDP and HVDM pins should be routed to the downstream Type-C connector or captive cable. No external circuitry is required on either pin. The HVDP and HVDM pins are tolerant to automotive high ESD and up to 24V transients.

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CC Pass-Through Switch

The CC1 and CC2 pins are the protected side of the CC switches and either connect directly to the upstream USB PD controller for MAX25432A devices or internally to the TCPC block for MAX25432B devices. No external circuitry is needed on either CC pin. The HVCC1 and HVCC2 pins connect directly to the downstream USB Type-C port connector or captive cable. No external circuitry is needed on either HVCC pin. HVCC1 and HVCC2 are tolerant to automotive high ESD and up to 24V transients.

Shield Short-to-Battery Protection

A USB shield/GND short-to-battery event can occur when a customer's portable device cable is connected to the downstream receptacle and the far end of this cable falls into the 12V cigarette lighter receptacle and contacts the 12V center terminal. This condition results in a damaging amount of current flow, with insufficient response time by the cigarette lighter fuse. The MAX25432 with G-suffix is designed to sense this shield short-to-battery condition with the SHLD_SNS pin and control an external nFET with the GDRV pin. The normally open (NO) ground logic will ensure no damaging current flows on Type-C to Type-C user cables by keeping the downstream connector ground open when no device is attached.



Figure 16. Shield Short-to-Battery Functional Diagram

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Figure 17. Shield/GND Short-to-Battery Timing Diagram

Figure 17 illustrates the circuit for the shield short-to-battery protection feature. When a Type-C attachment is present and the cable shield makes contact with V_{BAT} , a large surge current flows through the FET's $R_{DS(ON)}$ to ground. This surge current develops a voltage across it and is sensed through the MAX25432 SHLD_SNS pin. When the sense voltage exceeds a certain voltage threshold or slope, the fault-detection comparator is triggered. After a debounce period, the GDRV pin output goes low, causing the FET to switch off and reports the fault condition to the SHLD_EVENT bit. Once the fault condition is removed, the GDRV pin goes high to turn the FET on. The SHLD_EVENT flag can be cleared by the I²C master.

Principles of Operation

Normally Open Ground (All Devices)

The MAX25432 devices continuously monitor for a Type-C device attach and controls GDRV based on attach/detach events and timer circuitry.

When a Type-C connection is not present, the MAX25432 devices protect against shield short-to-battery events by leaving GDRV low. In this state, the USB shield and all other USB Type-C grounds are floating; however, a weak pulldown from SHLD_SNS is always active. This pulldown enables an Rd attach to be detected, while not providing a low-resistance path to ground.

When a valid Type-C attach is present, GDRV remains high for as long as the connection is present. A valid type-C attach may be to a native USB Type-C device, a Type-C to legacy adapter/cable, or an Apple Lightning cable.

If unused, GDRV should be tied with a $1M\Omega$ resistor to ground.

Fault Detection (G-Suffix only)

The MAX25432 G-suffix will protect against damaging surge currents on any user cable by using two unique detection methods on the SHLD_SNS pin:

- 1. Threshold Detection: Surge current exceeds a fixed threshold for several microseconds.
- 2. Slope Detection: Surge current exceeds a fixed upper slew-rate limit.

Either of these protection mechanisms can trigger the shield short-to-battery fault handling described in the <u>Fault Table</u> (<u>Analog Devices Auto-Shield</u>). Threshold and slope detections are automatically disabled when any of the following conditions are true:

- An attached USB device draws more than 400mA (typ). This condition resets when the current falls below 200mA (typ).
- An attached USB device has initiated a BC1.2 handshake (in Auto-CDP or Auto-DCP mode).
- A valid PD message was sent when V_{BUS} is being sourced. This condition resets when V_{BUS} is turned off or upon POR.

When a shield short-to-battery event is detected, GDRV is driven low until 1ms after the fault condition has cleared.

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GDRV Truth Table

<u>Table 6</u> shows the state of the GDRV pin with respect to the level detected on HVCC1 and HVCC2. This table applies to all MAX25432 G- and M-suffix devices. For the MAX25432A, it is assumed a PD controller is present upstream.

Table 6. GDRV Truth Table

V _{IN} > UVLO	HVEN	SOURCING V _{BUS} OR V _{CONN}	HVCC1	HVCC2	GDRV		
No	X1	Х	X	X			
	Low	Х	X	X			
			Open	Open	Low		
			Open	Ra			
			Ra	Open			
			Open	Rd			
Yes	Llink	No	Rd	Open			
	High		Rd	Ra	High ^{2, 3}		
			Ra	Rd			
			Ra	Ra	1		
			Rd	Rd	1		
		Yes	Х	х			

Note 1: "X" = Don't Care.

Note 2: G-suffix devices: If no shield short-to-battery fault has been detected.

Note 3: Minimum GDRV on-time is 32ms (typ).

Fault Detection and Diagnostics

The MAX25432 features advanced fault reporting and management mechanisms to protect the system from various events that are not within normal operating conditions. The MAX25432 is designed to eliminate false fault reporting by using internal deglitch and fault blanking timers. This ensures the <u>SHIELDING</u> bit is not incorrectly asserted during normal operation, such as starting into heavy capacitive loads. To report the fault to the ALERT pin, set the corresponding mask bit. <u>Table 7</u> describes the different faults, reporting mechanisms, debounce values, action, and recovery type. Each action and recovery type is defined in <u>Table 8</u>.

Table 7. Fault Table (Analog Devices Auto-Shield)

NAME	EVENT	REPORTING	DEBOUNCE PRIOR TO ACTION	FAULT ACTION	FAULT RECOVERY
Thermal Shutdown	IC temperature exceeds the Thermal Shutdown Temperature	<u>TSHDN</u> <u>SHIELDING</u> <u>VNDR_ALRT</u> ª	100µs	А	A
HVCC OV	HVCC1 or HVCC2 exceeds the V _{OV_HVCC} threshold	<u>HVCC_OV</u> <u>SHIELDING</u> <u>VNDR_ALRT</u> ª	Immediate	А	А
HVD OV	HVDP or HVDM exceeds the V _{OV_D} threshold	<u>DATA_OV</u> <u>SHIELDING</u> <u>VNDR_ALRT</u> ª	Immediate	А	A
V _{DD_USB} OV	V _{DD_USB} exceeds the V _{DD_USB_} OV threshold	<u>VDD_USB_OV</u> <u>SHIELDING</u> <u>VNDR_ALRT</u> ª	Immediate	А	А

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Table 7. Fault Table (Analog Devices Auto-Shield) (continued)

V _{DD_USB} UV	V _{DD_USB} falls below the V _{DD_USB} _UV threshold	<u>VDD_USB_UV</u> <u>SHIELDING</u> <u>VNDR_ALRT</u> ª	Immediate	С	с
	CL_EN = 0: V _{BUS} current exceeds the threshold set in the <u>VBUS_ILIM_SET</u> registers	<u>CV_ILIM</u> <u>SHIELDING</u> <u>VNDR_ALRT</u> ª	16ms	А	А
V _{BUS} I _{LIM}	CL_EN = 1: V _{BUS} current exceeds the threshold set in the <u>VBUS_ILIM_SET</u> registers. Enters current-limit (CL) regulation. Not a fault.	<u>CL_CV</u> <u>OMF_TRANS</u> © <u>VNDR_ALRT</u> ª	N/A	None	N/A
V _{BUS} OCP	CL_EN = 0: V _{BUS} current exceeds the I _{OUT_OCP} threshold ^(e) .	<u>VBUS_OCP_FAULT</u>	50µs	A	A
1802.001	CL_EN = 1: V _{BUS} current exceeds the I _{OUT_OCP} threshold ^(e) .	<u>FAULT_STAT</u> b	250µs		
Veue OV	CL_EN = 0: V _{OUT} exceeds the threshold set in the <u>VBUS_OV_THRESH[2:0]</u> register ^(f) , except when V _{BUS} is off, soft- starting or during V _{BUS} transitions	<u>VBUS_OVP_FAULT</u>	Immediate	А	A
V _{BUS} OV	CL_EN = 1: V _{OUT} exceeds the threshold set in the <u>VBUS_OV_THRESH[2:0]</u> register ^(f) , except when V _{BUS} is off or soft- starting	<u>FAULT_STAT</u> Þ	250µs	~	
	CL_EN = 0: V _{OUT} falls below the threshold set in the <u>VBUS_UV_THRESH[2:0]</u> register, except when V _{BUS} is off, soft- starting or during V _{BUS} transitions.	<u>VBUS_UV</u> SHIELDING	16ms	С	С
V _{BUS} UV	$\begin{array}{l} CL_EN = 1 \text{ and } CL_CV = 0: V_{OUT} \text{ falls} \\ \text{below the threshold set in the} \\ \underline{VBUS_UV_THRESH[2:0]} \text{ register, except} \\ \text{when } V_{BUS} \text{ is off or soft-starting.} \end{array}$	<u>VNDR_ALRT</u> a	10113		
	$CL_EN = 1$ and $CL_CV = 1$: V_{OUT} falls below the threshold set in the <u>VBUS_UV_THRESH[2:0]</u> register, except when V_{BUS} is off or soft-starting.	None	N/A	None	N/A
V OTO	CL_EN = 0: V _{OUT} falls below 2.0V (typ)	VBUS_SHT_GND	lucus adiata	•	٨
V _{BUS} STG	CL_EN = 1: V _{OUT} falls below 2.85V (typ)	<u>SHIELDING</u> <u>VNDR_ALRT</u> ª	Immediate	A	A
V _{BUS} Pre- Bias OV	COMMAND. SourceVbusDefaultVoltage is received, but V _{OUT} is above the vSafe0V threshold.	<u>I2C_ERR</u> FAULT_STAT ^b	10µs	С	С
V _{CONN} OCP Low	V _{CONN} current exceeds the IVCONN_OCP_L threshold ^g	<u>VCONN_OCPL</u> d <u>SHIELDING</u> d <u>VNDR_ALRT</u> d,a <u>VCONN_OCP_FAULT</u> d <u>FAULT_STAT</u> d,b	400µs	В	В
V _{CONN} OCP High	V _{CONN} current exceeds the I _{VCONN_OCP_H} threshold ^g	<u>VCONN_OCP_FAULT</u> d <u>FAULT_STAT</u> d,b	5µs	В	В
V _{CONN} UV	VCONN_EN = 0: V _{CONN} pin falls below the V _{CONN_FAST_UV} threshold	<u>VCONN_IN_UV</u> 9 <u>VNDR_ALRT</u> ^{e,g}	Immediate	В	В

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Table 7. Fault Table (Analog Devices Auto-Shield) (continued)

	VCONN_EN = 1: V _{CONN} pin falls below the V _{VCONN_FAST_UV} threshold	<u>VCONN_IN_UV9</u> <u>VCONN_OCPL9</u> <u>SHIELDING9</u> <u>VNDR_ALRT</u> a,g <u>VCONN_OCP_FAULT</u> 9 <u>FAULT_STAT</u> b, 9			
V _{CONN} Reverse OV	HVCC to V_{CONN} pin voltage exceeds the reverse overvoltage threshold (100mV, typ)	<u>VCONN_REV_OV</u> <u>SHIELDING</u> <u>VNDR_ALRT</u> ª	Immediate	D	В
V _{CONN} STG	HVCC is below the STG (0.5V (typ) for more than 8ms) prior V _{CONN} switch soft- start	<u>VCONN_PRESENT</u> stays at 0	30µs	Disable V _{CONN} and take Action D except Retry Time is 16ms	В
IN UV	V _{IN} (main IC supply) falls below the threshold set in the <u>IN_UV_THRESH[3:0]</u> register	<u>IN_UV</u> SHIELDING <u>VNDR_ALRT</u> ª	100µs	А	A
Shield Short-to- Battery	A shield short-to-battery event has been detected. (G-suffix devices only). See the <u>Shield Short-to-Battery Protection</u> section.	<u>SHLD_EVENT</u> <u>SHIELDING</u> <u>VNDR_ALRT</u> ª	Threshold: 5µs Slope: 2µs	A and turn off SHIELD FET	A
Buck-Boost Input Overcurrent	The differential voltage across the input current sense resistor exceeds the VOC1 threshold (16.6A (typ) for R_{CS1} = $3m\Omega$)	<u>IN_OC</u> SHIELDING <u>VNDR_ALRT</u> f	16ms	С	С
Buck-Boost Output Runaway	V _{BUS} is below 50% of the target regulation voltage or the differential voltage across the output current sense resistor is above the VOC2 threshold (output runaway)	<u>VBUS_RNA</u> <u>SHIELDING</u> <u>VNDR_ALRT</u> ª	Immediate	А	A

Note a: If <u>SHIELDING MASK</u> = '1'

Note b: If if the corresponding FAULT_STATUS_MASK[7:0] is set

Note c: If <u>OMF_TRANS_MASK</u> = '1'

Note d: On the third consecutive fault

Note e: If <u>VBUS_OCP_DET_EN</u> = '0'

Note f: If <u>VBUS_OVP_DET_EN</u> = '0'

Note g: If <u>VCONN_OCP_DET_EN</u> = '0'

Table 8. Fault Types

FAULT TYPE	ACTION ¹	RECOVERY
A	 Assert ALERT² Disable DC-DC, discharge to vSafe0V Open data switches Open CC passthrough switches Discharge HVCC1 and HVCC2 pins Open V_{CONN} switch for RETRY_TMR setting Reset BC1.2 state machine 	 DC-DC can be re-enabled by the I²C master through the COMMAND register Close data switches Close CC passthrough switches Close V_{CONN} switch based on <u>TCPC POWER_CONTROL[0]</u> and <u>TCPC_CONTROL[0]</u> settings

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Table 8. Fault Types (continued)

В	 First and second fault: Open V_{CONN} switch Start V_{CONN} STG detect sequence Start V_{CONN} retry sequence Third fault: Same as first two faults except: Open V_{CONN} switch for the time set in RETRY_TMR bit field Assert ALERT² (Note 3) 	 Close V_{CONN} switch depending on <u>TCPC POWER_CONTROL[0]</u> and <u>TCPC_CONTROL[0]</u> settings
С	Assert ALERT ²	None
D	 Open V_{CONN} switch for the time set in RETRY_TMR bit field Assert ALERT² (Note 3) 	 Close V_{CONN} switch depending on <u>TCPC POWER_CONTROL[0]</u> and <u>TCPC_CONTROL[0]</u> settings

Note 1: Faults do not reset the TCPC state machine nor disable Rp current sources.

Note 2: If <u>MSK_VNDR_ALRT</u> = 1

Note 3: The MAX25432 always maintains CC switches closed during those faults.

I²C, Control, and Diagnostics

I²C Diagnostics and Events Handling

Contact Analog Devices for more information on how to program I²C diagnostics and events handling.

Mask Registers and Nested Alerts

The registers in this section provide the masks that may be set for the ALERT registers. A masked register still indicates in the ALERT register, but does not set the ALERT pin low. POWER_STATUS_MASK, FAULT_STATUS_MASK, EXTENDED_STATUS_MASK and ALERT_EXTENDED_MASK registers are nested alerts.

- A POWER_STATUS change has to be <u>unmasked</u> in both the POWER_STATUS_MASK and the ALERT_MASK_L.MSK_PWR_STAT to assert the ALERT pin.
- A FAULT_STATUS change has to be unmasked in both the FAULT_STATUS_MASK and the ALERT_MASK_H.MSK_FAULT_STAT to assert the ALERT pin.
- An EXTENDED_STATUS change has to be unmasked in both the EXTENDED_STATUS_MASK and the ALERT_MASK_H.MSK_EXTND_STAT to assert the ALERT pin.
- An ALERT_EXTENDED change has to be unmasked in both the ALERT_EXTENDED_MASK and the ALERT_MASK_H.MSK_ALRT_EXTND to assert the ALERT pin.

In the application, the TCPM will first clear all bits in FAULT_STATUS register and then clear FAULT_STAT bit in ALERT_H to clear the ALERT, provided all fault conditions are cleared.

Figure 18 and Figure 19 describe the alerts, and the corresponding masks and links between them. A Level 1 alert requires to have one mask bit unmasked to assert the ALERT pin. A Level 2 alert requires to have two mask bits unmasked to assert the ALERT pin.

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Figure 18. Nested Alerts Diagram - ALERT_H

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Figure 19. Nested Alerts Diagram - ALERT_L

<u>I²C Interface</u>

The MAX25432 is an I²C slave device and requires an I²C master to communicate with its internal registers. It can accept SCL clock rates up to 1MHz, and its 7-bit device address can be set to 0x50, 0x51, 0x52, or 0x53 through the ADDR input pin.

The master, a PD controller, SoC or microcontroller, generates SCL and always initiates data transfer on the bus. The MAX25432's SCL line operates as an input only. A pullup resistor greater than 500 Ω is required on SCL if the master has an open-drain SCL output.

The MAX25432's SDA line operates as both an input and an open-drain output. A pullup resistor greater than 500Ω is required on the SDA line.

These resistors should be placed close to the MAX25432 SCL and SDA pins to minimize the effects of I^2C bus capacitance. Analog Devices recommends using a value of $4.7k\Omega$ for both resistors in most cases. Series resistors in line with SCL and SDA are optional. The SCL and SDA inputs suppress noise spikes to assure proper device operation even on a noisy bus.

The MAX25432 I²C slave logic is powered by the voltage applied to V_{DD_IO} (1.8V to 5.0V), allowing the MAX25432's logic levels to be matched with those of the I²C master. Note that I²C communications is possible even if the buck-boost is not switching (i.e., when V_{BUS} is off).

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Figure 20. Typical I²C Application Diagram

Interrupt Output (ALERT Pin)

 $\overline{\text{ALERT}}$ is an active-low, open-drain output that asserts to notify the I²C master of an interrupt. A pullup to V_{DD IO} is required for proper operation. Note that certain bits require their corresponding mask bit to be set for the ALERT pin to be asserted, as the mask bits act as AND gates.

I²C Slave Addressing (ADDR Pin)

Once the device is enabled, the I²C slave address is set and latched based on the ADDR pin. The address is defined as the 7 most significant bits (MSBs) followed by the R/W bit. Set the R/W bit to 1 to configure the devices to Read mode. Set the R/W bit to 0 to configure the device to Write mode. The address is the first byte of information sent to the devices after the START condition.

ADDR PIN	A6	A5	A4	A3	A2	A1	A0	7-BIT ADDRESS	WRITE	READ
GND	1	0	1	0	0	0	0	0x50	0xA0	0xA1
8870Ω to GND	1	0	1	0	0	0	1	0x51	0xA2	0xA3
15800Ω to GND	1	0	1	0	0	1	0	0x52	0xA4	0xA5
BIAS	1	0	1	0	0	1	1	0x53	0xA6	0xA7

Table 9. I²C Slave Addresses

<u>l²C Protocol</u>

Data is transferred MSB first with each data bit present on SDA sampled on every SCL clock pulse while the SDA line is stable. A byte of data on SDA contains 8 bits, MSB first, that can represent but is not limited to a register address or data written to the device. Additionally, SDA should never change while the SCL is high. There are two exceptions to this rule: the START condition and the STOP condition.

START Condition

Every I²C transaction between a master device and slave device begins with the master sending a START condition. The I²C master generates a START condition by first detecting when the I²C bus is idle, and then asserting the SDA

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signal low while allowing SCL to remain pulled high.

STOP Condition

An I²C STOP condition is created whenever an I²C master produces a rising edge on SDA while SCL remains high. This terminates any transaction with a slave device and frees up the I²C bus. SDA and SCL idle high when the I²C bus is not busy. The bus remains active if a REPEATED START (RS) condition is generated instead of a STOP condition.



Figure 21. START and STOP Conditions

REPEATED START Condition

An I²C REPEATED START condition is created when an I²C master produces a second START during a transaction with a slave device. REPEATED STARTs are needed to signal the slave device that the master desires a change in data direction during a transaction. The REPEATED START is sent after the acknowledge bit (ACK).



Figure 22. REPEATED START Condition

Acknowledge Bit (ACK)

ACK is a clocked 9th bit that the device uses to handshake receipt each byte of data. The device pulls down SDA during the master-generated 9th clock pulse. The SDA line must remain stable and low during the high period of the acknowledge clock pulse. Monitoring ACK allows for detection of unsuccessful data transfers. An unsuccessful data transfer occurs if a receiving device is busy or if a system fault has occurred. In the event of an unsuccessful data transfer, the I²C master can reattempt communication.

Clock Stretching

In general, the clock signal generation for the I²C bus is the responsibility of the master device. The I²C specification allows slow slave devices to alter the clock signal by holding down the clock line. The process in which a slave device holds down the clock line is typically called clock stretching. The MAX25432 does not use any form of clock stretching to

hold down the clock line.

General Call Address

The MAX25432 does not implement the I²C specification "general call address." If the MAX25432 sees the general call address (0b0000_0000), it will not issue an acknowledge.

<u>I²C Transactions</mark></u>

The MAX25432 supports several types of I²C transactions, described as follows.

Read Byte

The master Read Byte transaction begins with the master sending a START condition. This is followed by a 7-bit address and R/W bit = 0, indicating a master write operation. If this address matches the MAX25432 device address, the device will acknowledge (ACK) by holding the SDA line low for one SCL clock. The master then sends the byte address, which serves as a pointer to the MAX25432 device register where data will be read. The MAX25432 again ACKs the byte sent. Then, the master sends a REPEATED START condition, alerting the MAX25432 device that the next byte will again be an address. The master device clocks in the MAX25432 address, this time appended with a logic '1'. This signals the MAX25432 that the master wants to read the data from the register address previously sent. The MAX25432 again ACKs the byte sent. On the rising of the next SCL clock, the slave begins sending the desired data byte to the master. The master will then signal the MAX25432 that the previous byte was the final byte needed by not acknowledging (NACK), followed by a STOP condition, indicating the end of the Read Byte transaction.

When the I²C master desires to read data from two or more MAX25432 registers that are not contiguously located, sequential Read Byte transactions must be used. For instance, two bytes of data can be read from the MAX25432, one at register address 0x1E and the other at register address 0x20, however the I²C bus is released (STOP condition) between read operations. The MAX25432 will ACK its address and data bytes sent by the master. It expects the master to NACK the last data byte prior to sending a STOP condition.



Figure 23. Read Byte

Write Byte

The master Write Byte transaction begins with the master sending a START condition. This is followed by a 7-bit address and R/W bit = 0, indicating a master write operation. If this address matches the MAX25432 device address, it will ACK by holding the SDA line low for one SCL clock. The master then sends the register address, which serves as a pointer to the MAX25432 register where data will be written. The MAX25432 again ACKs the byte sent. Then the master sends the data byte and waits for the MAX25432 to ACK the data byte. Finally, the I²C master terminates the transaction by sending a STOP condition.

When it is desired to write data to two or more non-contiguous MAX25432 registers, sequential Master Write transactions should be used. The MAX25432 will acknowledge its address and data bytes sent by the master. A master STOP condition terminates each write.

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Figure 24. Write Byte

Read Word

The master Read Word transaction follows the same sequence as the master Read Byte except that two data bytes are received from the MAX25432, a low-address data byte (DATA n) followed by a high-address data byte (DATA n+1). This is accomplished by ACKing the first data byte received from the slave device, and then NACKing the second data byte, followed by sending a STOP condition. Note that the MAX25432 automatically increments the register pointer to the next address. Reading ALERT_L and ALERT_H registers in a single operation is an example of using the Read Word transaction.



Figure 25. Read Word

Write Word

The master Write Word transaction is similar to a master Write Byte except that data is written to two sequential MAX25432 registers in one operation. The transaction begins exactly as a master Write Byte transaction; namely a START condition, the Slave Address followed by a write bit, then the Register Address. However, two data bytes are then sent—a low-address data byte (DATA n) followed by a high-address data byte (DATA n+1). The MAX25432 ACKs each byte received, and automatically increments the register address pointer between the low and high data bytes. Finally, the master sends a STOP condition to complete the transaction. Note that the low and high data bytes follow the same bit order as the previous bytes (Slave and Register addresses) which is MSB first (D7 to D0). Once the data is received, the l²C master will need to flip the bit order and concatenate to obtain a 16-bit word with LSB first.

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Figure 26. Write Word

Read Block

The master Read Block transaction is a powerful function, enabling the I^2C master to read from 1 to 255 bytes of data from contiguous MAX25432 registers in one operation. Note that I^2C Read operations from the MAX25432B's TCPC Receive Buffer require this type of I^2C transaction for proper operation.



Figure 27. Read Block

The master Read Block transaction begins as any I²C Read operation, first the master sends a START condition, followed by the MAX25432's 7-bit device address plus the R/W bit = 0. The MAX25432 will ACK its address, then the master sends the register address for the beginning of the contiguous block where data is to be read from. The MAX25432 again ACKs the received data. Next, the master sends a REPEATED START condition, informing the MAX25432 that the next byte sent will be an address. The I²C master then sends the MAX25432's 7-bit device address plus the R/W bit = 1, configuring the MAX25432 I²C for slave read operation. The MAX25432 again acknowledges its address and prepares to deliver data from its registers.

The master can now read up to 255 bytes of data from the MAX25432 by continuing to clock the SCL signal. The MAX25432 will output data on SDA, one byte for each 8 SCL clocks, and expect that the master ACK the data sent on the 9th SCL clock. The MAX25432 will automatically increment the register address pointer between successive bytes. When the desired number of bytes from the MAX25432 has been sent, the master must send a NACK followed by a

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STOP condition to terminate the transaction.

Write Block

The MAX25432 also supports I²C block data writes for up to 255 contiguous registers. The MAX25432B's transmit buffer requires this type of I²C transaction for proper operation.



Figure 28. Write Block

The master Write Block transaction begins by sending a START condition, followed by the MAX25432's 7-bit device address plus the R/W bit = 0. The MAX25432 will ACK its address, then the master sends the register address for the beginning of the contiguous block where data will be written. The MAX25432 again ACKs the received data.

The master can now write up to 255 bytes of data to the MAX25432 by continuing to clock the SCL signal. The MAX25432 will store data from SDA, one byte for each eight SCL clocks, and will ACK the data sent on the 9th SCL clock. The MAX25432 automatically increments the register address pointer between successive bytes. When the desired number of bytes from the MAX25432 has been sent, the master sends a STOP condition to terminate the transaction.

Watchdog Timer

The MAX25432 implements a programmable watchdog timer to give the design engineer the ability to monitor the I^2C interface for lack of communication from the I^2C master. The watchdog provides a fail-safe mechanism in case the TCPM software stack or PD controller firmware hangs in a state where, for instance, a voltage is sourced on V_{BUS} when the sink is no longer attached.

The watchdog timer functionality is enabled by setting TCPC_CONTROL.EN_WD_TMR to logic '1'. The watchdog timer starts when the <u>ALERT</u> pin is asserted. The watchdog timer is cleared on any I²C access by the I²C master (either Read or Write). If the <u>ALERT</u> pin is still asserted after this I²C access, the watchdog timer reinitializes and start monitoring again until the <u>ALERT</u> pin is deasserted.

If the I²C master is unable to clear the watchdog timer within the programmed time set in WATCHDOG_SETUP.WD_TIMEOUT[1:0], it causes the watchdog timer to expire. When the watchdog timer expires, the MAX25432 immediately disconnects the CC terminations by setting ROLE_CONTROL[3:0] to 1111b, discharge V_{BUS} to vSafe0V, and then set FAULT_STATUS.I2C_ERR bit. The MAX25432 will remove the V_{BUS} discharge circuit when V_{BUS} is below vSafe0V and it will not reapply the discharge circuit if V_{BUS} rises above vSafe0V. Stop discharge in this case is an edge-triggered event.

Any further changes on V_{BUS} need to be initiated by the I²C master when its communication link with the MAX25432 is

restored.

Transmitting and Receiving a Hard Reset (MAX25432B only)

To transmit a Hard Reset, write 0x05 to the TRANSMIT[7:0] register.

Upon receiving a Hard Reset from the port partner, the MAX25432B will set the RX_HARD_RST flag in the ALERT_L[7:0] register.

Upon sending or receiving a Hard Reset, the MAX25432B resets the following registers to their default values:

- RECEIVE DETECT[7:0]
- ALERT_MASK_L_SEL[7:0]
- ALERT_MASK_H_SEL[7:0]
- POWER_STATUS_MASK[7:0]
- EXTENDED_STATUS_MASK[7:0]
- ALERT_EXTENDED_MASK[7:0]

Built-In Self-Test (BIST)

The MAX25432B supports BIST Carrier Mode 2 and BIST Test Data Mode per USB PD Revision 3.0 Version 1.2.

- Transmitting BIST Carrier mode 2
 - Upon receiving a BIST data object (BDO) with the BIST type set to Carrier mode, the TCPM writes 0x07 to the TRANSMIT[7:0] register to enable BIST Carrier mode 2.
 - Immediately after, the MAX25432B transmits the BIST pattern for 50ms (typ) on the HVCC line corresponding to the orientation defined by the PLUG_ORNT bit.
 - At the end of the 50ms timer, the MAX25432B asserts ALERT and flags the TX_SOP_MSG_SUCC bit.
 - After reading this flag, the TCPM should enter the PE_SRC_Transition_to_default state.
- Entering/exiting BIST Test Data mode
 - Upon receiving a BDO with the BIST type set to Test Data, the TCPM sets the BIST_TM bit in the TCPC_CONTROL[7:0] register to enable BIST Test Data mode.
 - See the BIST_TM bit description for information on this mode.
 - The TCPM must clear the BIST_TM bit upon receiving a Hard Reset in order to exit this mode.

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Register Map

Register_Map

The following register map summary table displays all the registers for the MAX25432 product family. Bit descriptions that show "MAX25432B only" are only applicable to MAX25432B devices. If using MAX25432A devices, "MAX25432B only" bits should be ignored and left to their reset values. Row "Reset" in Register Details contains MAX25432B reset values while row "Reset A" contains MAX25432A reset values.

Register values will reset to their default values upon a POR.

Registers starting from address 0x00 to address 0x79 are compliant to the Type-C Port Controller Interface Specification Revision 2.0, Version 1.1. Refer to the specification for additional information on how to use those registers.

Registers starting from address 0x80 to address 0x8B are vendor-defined by Analog Devices.

For more information on the MAX25432 register set and for instructions on how to program the interface, contact Analog Devices.

ADDRESS	NAME	MSB							LSB				
USB Type-0	C and USB-PD Registers												
0x00	VENDOR_ID_L[7:0]				VENDO	R_ID[7:0]							
0x01	VENDOR_ID_H[7:0]				VENDOR	LD[15:8]							
0x02	PRODUCT_ID_L[7:0]		PRODUCT_ID[7:0]										
0x03	PRODUCT_ID_H[7:0]				PRODUC	T_ID[15:8]							
0x04	DEVICE_ID_L[7:0]				DEVICE	_ID[7:0]							
0x05	DEVICE_ID_H[7:0]				DEVICE	_ID[15:8]							
0x06	USBTYPEC_REV_L[7:0]				TYPEC_	REV[7:0]							
0x08	USBPD_REV_VER_L[7 :0]				PD_VE	ER[7:0]							
0x09	USBPD_REV_VER_H[7 :0]				PD_RI	EV[7:0]							
0x0A	PD_INTERFACE_REV_ L[7:0]				IBS_VI	ER[7:0]							
0x0B	PD_INTERFACE_REV_ H[7:0]				IBS_R	EV[7:0]							
0x10	ALERT_L[7:0]	VBUS_A LARM_H I	TX_SOP _MSG_S UCC	TX_SOP _MSG_D ISCRD	TX_SOP _MSG_F AIL	RX_HAR D_RST	RX_SOP _MSG_S _TAT	PWR_ST AT	HVCC_S TAT				
0x11	ALERT_H[7:0]	VNDR_A LRT	ALRT_E XTND	EXTND_ STAT	BEG_SO P_MSG_ STAT	VBUS_S NK_DIS C_DET	RX_BUF F_OVRF L	FAULT_ STAT	VBUS_A LARM_L O				
0x12	ALERT_MASK_L[7:0]	MSK_VB US_V_A LRM_HI	MSK_TX _SOP_M SG_SUC C	MSK_TX _SOP_M SG_DIS CRD	MSK_TX _SOP_M SG_FAIL	MSK_RX _HARD_ RST	MSK_RX _SOP_M SG_STA T	MSK_P WR_STA T	MSK_HV CC_STA T				
0x13	ALERT_MASK_H[7:0]	MSK_VN DR_ALR T	MSK_AL RT_EXT ND	MSK_EX TND_ST AT	MSK_BE G_SOP_ MSG_ST AT	MSK_VB US_SNK _DISC_ DET	MSK_RX _BUFF_ OVRFL	MSK_FA ULT_ST AT	MSK_VB US_V_A LRM_LO				

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ADDRESS	NAME	MSB							LSB	
0x14	POWER_STATUS_MA SK[7:0]	MSK_DE BG_ACC _CONN_ STAT	MSK_TC PC_INIT _STAT	MSK_SR C_NON_ DEF_VO LT_STA T	MSK_SR C_VBUS _STAT	MSK_VB US_DET _STAT	MSK_VB US_PRS N_STAT	MSK_VC ONN_PR SN_STA T	MSK_SN K_VBUS _STAT	
0x15	FAULT_STATUS_MAS K[7:0]	MSK_All _REG_R ST	MSK_FO RCD_OF F_VBUS	MSK_AU TO_DIS CH_FAIL	MSK_FO RC_DIS CH_FAIL	MSK_VB US_OCP	MSK_VB US_OVP	MSK_VC ONN_O CP	MSK_I2 C_ERR	
0x16	EXTENDED_STATUS_ MASK[7:0]	-	-	-	-	-	-	-	MSK_VS AFE0V	
0x17	ALERT_EXTENDED_M ASK[7:0]	-	-	-	-	-	MSK_TM R_EXP	MSK_SR C_FST_ RSWP	MSK_SN K_FST_ RSWP	
0x19	TCPC_CONTROL[7:0]	EN_SMB _PEC	EN_LK4 CONN_A LRT	EN_WD_ TMR	DBG_AC C_CNTR L		STRCH[1:	BIST_T M	PLUG_O RNT	
0x1A	ROLE_CONTROL[7:0]	_	DRP	RP_V	AL[1:0]	HVCC	2[1:0]	HVCC	:1[1:0]	
0x1B	FAULT_CONTROL[7:0]	-	-	-	FRC_OF F_VBUS _DIS	VBUS_D ISCH_FL T_DET_ TMR_EN	VBUS_O CP_DET _EN	VBUS_O VP_DET _EN	VCONN_ OCP_DE T_EN	
0x1C	POWER_CONTROL[7: 0]	FAST_R SWP_E N	VBUS_V OLT_MO N_EN	VOLT_A LRMS_E N	AUTO_D ISCH_DI SC_EN	BLED_DI SCH_EN	FORC_D ISCH_E N	VCONN_ PWR_S UPP	EN_VCO NN	
0x1D	HVCC_STATUS[7:0]	-	-	LOOKIN G4CON N	CONN_ RSLT	HVCC2_S	TATE[1:0]	HVCC1_S	_STATE[1:0]	
0x1E	POWER_STATUS[7:0]	DBG_AC C_STAT	INIT_ST AT	SRC_NO N_DEF_ VOLT	SRC_VB US	VBUS_D ET_EN	VBUS_P RESENT	VCONN_ PRESEN T	SNK_VB US	
0x1F	FAULT_STATUS[7:0]	ALL_RE G_RST	FORCD_ OFF_VB US	AUTO_D ISCH_F AIL	FORCE_ DISCH_ FAIL	VBUS_O CP_FAU LT	VBUS_O VP_FAU LT	VCONN_ OCP_FA ULT	I2C_ER R	
0x20	EXTENDED_STATUS[7 :0]	-	-	-	-	-	-	-	VSAFE0 V	
0x21	ALERT_EXTENDED[7:	-	_	_	_	-	TMR_EX P	SRC_FS T_RSWP	SNK_FS T_RSWP	
0x23	COMMAND[7:0]				COMMA	ND[7:0]				
0x24	DEVICE_CAPABILITIE S_1_L[7:0]	PWR	_ROLE_CA	P[2:0]	SOP_DB G_CAP	SRC_VC ONN_CA P	SNK_VB US_CAP	SRC_HI _VBUS_ CAP	SRC_VB US_CAP	
0x25	DEVICE_CAPABILITIE S_1_H[7:0]	VBUS_N ONDEF_ TRGT_C AP	VBUS_O CP_RPT _CAP	VBUS_O VP_RPT _CAP	BLEED_ DISCH_ CAP	FORCE_ DISCH_ CAP	VBUS_M EAS_AL RM_CAP	SRC_RES P[1	_SUP_CA :0]	
0x26	DEVICE_CAPABILITIE S_2_L[7:0]	SNK_DI SC_DET _CAP	STP_DIS CH_THR _CAP		DLT_ALRM CAP[1:0]	VCON	N_PWR_CA	AP[2:0] VCONN OCP_CA P		
0x27	DEVICE_CAPABILITIE S_2_H[7:0]	-	-	GENERI C_TMR_ CAP	LONG_ MSG_C AP	SMB_PE C_CAP	SRC_FR S_CAP	SNK_FR S_CAP	WDOG_ TMR_CA P	

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ADDRESS	NAME	MSB							LSB	
0x28	STANDARD_INPUT_C APABILITIES[7:0]	-	-	-		5_INP_CA 1:0]	VBUS_E XT_OVP _CAP	VBUS_E XT_OCP _CAP	FRC_OF F_VBUS _CAP	
0x29	STANDARD_OUTPUT_ CAPABILITIES[7:0]	VBUS_S NK_DIS_ DET_CA P	DBG_AC C_CAP	VBUS_P RESENT _CAP	AUD_AC C_CAP	ACT_CB L_CAP	MUX_C ONFG_C AP	CONN_P RESENT _CAP	CONN_ ORIENT _CAP	
0x2A	CONFIG_EXTENDED1[7:0]	-	-	-	-	-	_	FRS_BI DIR	SRC_FR S_IN	
0x2E	MESSAGE_HEADER_I NFO[7:0]	-	Ι	-	CBL_PL G	DATA_R OLE	USB_F	PD[1:0]	PWR_R OLE	
0x2F	RECEIVE_DETECT[7:0]	-	EN_CBL _RST	EN_HRD _RST	EN_SOP _DBG2	EN_SOP _DBG1	EN_SOP 2	EN_SOP 1	EN_SOP	
0x30	RECEIVE_BUFFER[7:0]			I	RECEIVE_E	BUFFER[7:0	7:0]			
0x50	TRANSMIT[7:0]	-	Ι		OUNTER[0]	-	TX_SC	DP_MESSA	GE[2:0]	
0x51	TRANSMIT_BUFFER[7:			Т	RANSMIT_	BUFFER[7:	0]			
0x70	VBUS_VOLTAGE_L[7:0]				VBUS_VO	LTAGE[7:0]				
0x71	VBUS_VOLTAGE_H[7: 0]	-	-	SCALE_FACTOR[1: VBUS_VOLT 0] 8]						
0x74	VBUS_STOP_DISCHA RGE_THRESHOLD_L[7 :0]		VBUS_STOP_DISCH_THRESHOLD[7:0]							
0x75	VBUS_STOP_DISCHA RGE_THRESHOLD_H[7:0]	-	-	-	-	-	-	VBUS_ST H_THRES	OP_DISC HOLD[9:8]	
0x76	VBUS_VOLTAGE_ALA RM_HI_CFG_L[7:0]			VB	US_ALARN	/_HI_CFG[7	7:0]			
0x77	VBUS_VOLTAGE_ALA RM_HI_CFG_H[7:0]	-	-	-	-	-	-	VBUS_AL CFG	ARM_HI_ [9:8]	
0x78	VBUS_VOLTAGE_ALA RM_LO_CFG_L[7:0]			VB	US_ALARN	1_LO_CFG[7:0]			
0x79	VBUS_VOLTAGE_ALA RM_LO_CFG_H[7:0]	-	Ι	-	-	-	-		ARM_LO_ [9:8]	
0x7A	VBUS_NONDEFAULT_ TARGET_L[7:0]			VBUS_N	NONDEFAU	ILT_TARGE	T_L[7:0]			
0x7B	VBUS_NONDEFAULT_ TARGET_H[7:0]			VBUS_N	IONDEFAU	LT_TARGE	T_H[7:0]			
Power, Prot	tection and Legacy USB I	Registers								
0x80	VBUS_CURRENT[7:0]				VBUS_CU	RRENT[7:0]				
0x81	CABLE_COMP_CONT ROL[7:0]	– – GAIN[5:0]								
0x82	VBUS_ILIM_SETUP[7:0]				VBUS_ILIN	M_SET[7:0]				
0x83	BUCK_BOOST_SETUP [7:0]		SLP[2:0]		FSW	/[1:0]	SYNC_D IR	SS_SI	EL[1:0]	

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ADDRESS	NAME	MSB							LSB
0x84	WATCHDOG_SETUP[7 :0]	-	-	-	-	-	-	WD_TIME	EOUT[1:0]
0x85	AUTO_SHIELD_SETUP [7:0]	-	-	Ι	-	-	-	RETRY_	TMR[1:0]
0x86	GENERAL_SETUP[7:0]	-	VBUS_H IRES	-	EXT_BIA S_SEL	-	CL_EN	AUTO_CI MOD	DP_DCP_ E[1:0]
0x87	IN_THRESH[7:0]	-	-	-	-		IN_UV_THRESH[3:0]		
0x88	VCONN_THRESH[7:0]	N	CONN_OC	PL_SEL[3:0)]	-	VCONN_IN_UV_THRESH[2:0		
0x89	VBUS_THRESH[7:0]	_	VBUS_	OV_THRE	SH[2:0]	_	- VBUS_UV_THRESH[2:		
0x8A	VENDOR_STATUS_MA SK[7:0]	SHIELDI NG_MA SK	-	-	-	-	-	-	OMF_TR ANS_MA SK
0x8B	VENDOR_STATUS[7:0]	SHIELDI NG	-	Ι	-	-	-	-	OMF_TR ANS
0x8C	AUTO_SHIELD_STATU S_0[7:0]	TSHDN	VCONN_ REV_OV	VCONN_ OCPL	SHLD_E VENT	VCONN_ IN_UV	IN_OC	VDD_US B_UV	VBUS_U V
0x8D	AUTO_SHIELD_STATU S_1[7:0]	CL_CV	CV_ILIM	VBUS_R NA	VBUS_S HT_GND	IN_UV	DATA_O V	HVCC_O V	VDD_US B_OV

Register Details

VENDOR_ID_L (0x0)

Lower 8 Bits of VID. A vendor ID, or VID, is used to identify the TCPC vendor. The VID is a unique 16-bit unsigned integer assigned by USB-IF.

BIT	7	6	5	4	3	2	1	0	
Field		VENDOR_ID[7:0]							
Reset		0x6A							
Access Type		Read Only							
Reset A				0x	6A				
BITFIELD	BITS	BITS DESCRIPTION DECODE							
VENDOR_ID	7:0	Lower 8 Bits	s of Analog Dev	vices VID.	Always reads 0x6A in MAX25432				

VENDOR_ID_H (0x1)

Upper 8 Bits of VID.

BIT	7	6	5	4	3		2	1	0		
Field		VENDOR_ID[15:8]									
Reset		0x0B									
Access Type		Read Only									
Reset A				0x	0B						
BITFIELD	BITS	BITS DESCRIPTION DECODE									
VENDOR_ID	7:0	Upper 8 Bits	s of Analog Dev	vices VID.	Alw	Always reads 0x0B in MAX25432					

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PRODUCT_ID_L (0x2)

Lower 8 Bits of PID. The product ID, or PID, is used to identify the product.

BIT	7	6	5	4	3	2	1	0	
Field		PRODUCT_ID[7:0]							
Reset		0x00							
Access Type		Read Only							
Reset A				0x	00				
BITFIELD	BITS		DESCRIPT	ION		D	ECODE		
PRODUCT_I D	7:0	Lower 8 bits	of MAX25432	's PID		0x01: Buck-Boost Capable 0x02: Buck-Only Capable			

PRODUCT_ID_H (0x3)

Upper 8 Bits of PID.

BIT	7	6	5	4	3	2	1	0		
Field		PRODUCT_ID[15:8]								
Reset		0x00								
Access Type		Read Only								
Reset A		0x00								
BITFIELD	BITS	BITS DESCRIPTION DECODE								
PRODUCT_I D	7:0	7:0 Upper 8 Bits of MAX25432's PID Always reads 0x00 in MAX25432								

DEVICE_ID_L (0x4)

Lower 8 Bits of bcdDevice. The Device ID, bcdDevice, is used to identify the release version of the product.

BIT	7	6	5	4		3	2	1	0	
Field		DEVICE_ID[7:0]								
Reset		0x00								
Access Type		Read Only								
Reset A				0x	00					
BITFIELD	BITS	BITS DESCRIPTION DECODE								
DEVICE_ID	7:0	Lower 8 Bits of MAX25432's Device ID. See Ordering Information table								

DEVICE_ID_H (0x5)

Upper 8 Bits of Device ID.

BIT	7	6	5	4	3	2	1	0		
Field		DEVICE_ID[15:8]								
Reset		0x00								
Access Type		Read Only								
Reset A		0x00								

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BITFIELD	BITS	DESCRIPTION	DECODE
DEVICE_ID	7:0	Upper 8 Bits of MAX25432's Device ID.	See Ordering Information table

USBTYPEC_REV_L (0x6)

This register refers to USB Type-C Cable and Connector Specification Revision; USB Type-C represented by a unique 16-bit unsigned register. The format is packed binary coded decimal (BCD).

BIT	7	6	5	4	3	2	1	0	
Field		•	TYPEC_REV[7:0]						
Reset		0x13							
Access Type		Read Only							
Reset A				0x	13				
BITFIELD	BITS	BITS DESCRIPTION DECODE							
TYPEC_REV	7:0	USB Type-C Revision 1.3			Always	Always reads 0x13 in MAX25432			

USBPD_REV_VER_L (0x8)

USBPD_REV_	_VER[15:8]: Lo	ower 8 Bits									
BIT	7	6	5	4	3	2	1	0			
Field		PD_VER[7:0]									
Reset		0x12									
Access Type				Read	Only						
Reset A				0x?	12						
BITFIELD	BITS	BITS DESCRIPTION DECODE									
PD_VER	7:0 USB PD Version 1.2 Always reads 0x12 in MAX25432										

USBPD_REV_VER_H (0x9)

This register refers to USB PD Specification revision and version represented by a unique 16-bit unsigned integer. The format is packed BCD.

BIT	7	6	5	4	3	2	1	0	
Field				PD_RI	EV[7:0]				
Reset		0x30							
Access Type		Read Only							
Reset A				0x	30				
BITFIELD	BITS	BITS DESCRIPTION DECODE							
PD_REV	7:0	USB PD Revision 3.0 Always reads 0x30 in MAX25432							

PD_INTERFACE_REV_L (0xA)

PD_INTERFACE_REV[7:0]: Lower 8 Bits

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BIT	7	6	5	4	3	2	1	0				
Field		IBS_VER[7:0]										
Reset		0x11										
Access Type	Read Only											
Reset A				0х	11							
BITFIELD	BITS	BITS DESCRIPTION DECODE										
IBS_VER	7:0	7:0 USB PD Inter-Block Specification Version 1.1 Always reads 0x11 in MAX25432										

PD_INTERFACE_REV_H (0xB)

The USB Port Controller Specification Revision register refers to the specification revision and version represented by a unique 16-bit unsigned integer. The format is packed BCD.

BIT	7	6	5	4	3	2	1	0			
Field	IBS_REV[7:0]										
Reset	0x20										
Access Type		Read Only									
Reset A				0x	20						
BITFIELD	BITS		DESCRIPT	ION		D	ECODE				
IBS_REV	7:0	7:0 USB PD Inter-Block Specification Revision 2.0 Always reads 0x20 in MAX25432									

<u>ALERT_L (0x10)</u>

Lower 8 Bits of ALERT Register.

This register is set by TCPC and cleared by TCPM. This register is used to communicate a status change from the TCPC to the TCPM. After an event or condition occurs, the TCPC sets the corresponding bit in the ALERT register.

Any unmasked bit that is s	et in this register will drive	the ALERT pin low.
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BIT	7	6	5	4		3	2	1	0		
Field	VBUS_ALA RM_HI	TX_SOP_M SG_SUCC	TX_SOP_M SG_DISCR D	TX_SOP_M SG_FAIL	RX_HARD_ RST		RX_SOP_M SG_STAT	PWR_STAT	HVCC_STA T		
Reset	0b0	0b0	0b0	0b0		0b0	0b0	0b0	0b0		
Access Type	Write 1 to Clear, Read	Write 1 to Clear, Read	Write 1 to Clear, Read	Write 1 to Clear, Read		rite 1 to ar, Read	Write 1 to Clear, Read	Write 1 to Clear, Read	Write 1 to Clear, Read		
Reset A	0b0	0b0	0b0	0b0	0b0		0b0	0b0	0b0		
BITFIELD	BITS		DESCRIPT	ION			DECODE				
VBUS_ALAR M_HI	7	V _{BUS} Voltag	ge Alarm Hi			0: Cleared 1: A high-voltage alarm has occurred					
TX_SOP_MS G_SUCC	6		Transmit SOP* Message Successful. (MAX25432B only)				0: Cleared 1: Reset or SOP* message transmission successful. GoodCRC response received on SOP* message transmission. Transmit SOP* message buffer registers are empty.				

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BITFIELD	BITS	DESCRIPTION	DECODE
TX_SOP_MS G_DISCRD	5	Transmit SOP* Message Discarded (MAX25432B only)	0: Cleared 1: Reset or SOP* message transmission not sent due to an incoming receive message. Transmit SOP* message buffer registers are empty.
TX_SOP_MS G_FAIL	4	Transmit SOP* Message Failed. (MAX25432B only)	0: Cleared 1: SOP* message transmission not successful, no GoodCRC response received on SOP* message transmission. Transmit SOP* message buffer registers are empty.
RX_HARD_R ST	3	Received Hard Reset. (MAX25432B only)	0: Cleared 1: Received Hard Reset message
RX_SOP_M SG_STAT	2	Received SOP* Message Status. (MAX25432B only)	0: Cleared 1: RECEIVE_BUFFER register changed. READABLE_BYTE_COUNT being set to 0 does not set this bit.
PWR_STAT	1	Power Status.	0: Cleared 1: Power Status changed
HVCC_STAT	0	HVCC Status. (MAX25432B only)	0: Cleared 1: HVCC Status changed Set when ROLE_CONTROL.HVCC1[10] or ROLE_CONTROL.HVCC2[10] has changed. The MAX25432B does not assert this bit when HVCC_STATUS.LOOKING4CONN changes state if TCPC_CONTROL.EN_LK4CONN_ALRT is set to 0.

ALERT_H (0x11)

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Upper 8 Bits of ALERT Register.

This register is set by TCPC and cleared by TCPM. This register is used to communicate a status change from the TCPC to the TCPM. After an event or condition occurs, the TCPC sets the corresponding bit in the ALERT register.

BIT	7	6	5	4	3		2	1	0	
Field	VNDR_ALR T	ALRT_EXT ND	EXTND_ST AT	BEG_SOP_ MSG_STAT	VBUS_SNK _DISC_DET		RX_BUFF_ OVRFL	FAULT_ST AT	VBUS_ALA RM_LO	
Reset	0b0	0b0	0b0	0b0		0b0	0b0	0b0	0b0	
Access Type	Write 1 to Clear, Read	Read Only	Write 1 to Clear, Read	Read Only	Read Only		Write 1 to Clear, Read	Write 1 to Clear, Read	Write 1 to Clear, Read	
Reset A	0b0	0b0	0b0	0b0		0b0	0b0	0b0	0b0	
BITFIELD	BITS		DESCRIPT	DI	ECODE					
VNDR_ALRT	7	Vendor-Defi	ned Alert			Defined starting This bit	ed dor-defined ale in the VENDOI at address 0x8 can be cleared f the alert source	R_DEFINED re 0. , regardless of	egisters	
ALRT_EXTN D	6	Alert Extend (Reserved)	Alert Extended. (Reserved)				Always reads 0 (Extended Alerts not supported)			

Any unmasked bit that is set in this register will drive the ALERT pin low.

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BITFIELD	BITS	DESCRIPTION	DECODE
EXTND_STA T	5	Extended Status.	0: Cleared 1: Extended Status changed
BEG_SOP_ MSG_STAT	4	Beginning SOP* Message Status. (MAX25432B only)	Always reads 0 (Extended messaging not supported)
VBUS_SNK_ DISC_DET	3	V _{BUS} Sink Disconnect Detected. (MAX25432B only)	Always reads 0 (Source-only)
RX_BUFF_O VRFL	2	Rx Buffer Overflow. (MAX25432B only)	0: TCPC Rx buffer is functioning properly. 1: TCPC Rx buffer has overflowed. Future GoodCRC shall not be sent. This bit is cleared when the TCPM writes a 1 to it and a 1 to ALERT.RX_SOP_MSG_STAT.
FAULT_STA T	1	Fault Status.	0: No fault 1: A fault has occurred. Read the FAULT_STATUS register.
VBUS_ALAR M_LO	0	V _{BUS} Voltage Alarm Lo.	0: Cleared 1: A low-voltage alarm has occurred.

ALERT_MASK_L (0x12)

Lower 8 Bits of ALERT_MASK Register.

The registers in this section define the masks that may be set for the ALERT registers. A masked register will still indicate in the ALERT register, but will not set the ALERT pin low.

This register will be reset to its default value when a Hard Reset is sent; or a Hard Reset is received (if Hard Reset detection is enabled).

BIT	7	6	5	4		3	2	1	0	
Field	MSK_VBUS _V_ALRM_ HI	MSK_TX_S OP_MSG_S UCC	MSK_TX_S OP_MSG_ DISCRD	MSK_TX_S OP_MSG_F AIL		K_RX_H RD_RST	MSK_RX_S OP_MSG_S TAT	MSK_PWR _STAT	MSK_HVC C_STAT	
Reset	0b1	0b1	0b1	0b1		0b1	0b1	0b1	0b1	
Access Type	Write, Read, Ext	Write, Read, Ext	Write, Read, Ext	Write, Read, Ext		Write, ad, Ext	Write, Read, Ext	Write, Read, Ext	Write, Read, Ext	
Reset A	0b0	0b0	0b0	0b0		0b0	0b0	0b0	0b0	
BITFIELD	BITS		DESCRIPT	ION			DI	ECODE		
MSK_VBUS_ V_ALRM_HI	7	V _{BUS} Voltag (MAX25432	je Alarm Hi Inte B only)	errupt Mask.			upt masked upt unmasked			
MSK_TX_SO P_MSG_SU CC	6	Transmit SC Mask. (MAX25432)	0	uccessful Inter	rupt		rupt masked rupt unmasked			
MSK_TX_SO P_MSG_DIS CRD	5	Transmit SC Mask. (MAX25432	0	iscarded Interr	upt	0: Interrupt masked 1: Interrupt unmasked				
MSK_TX_SO P_MSG_FAI L	4	Transmit SC Mask. (MAX25432	P* Message F B only)	ailed Interrupt		0: Interrupt masked 1: Interrupt unmasked				
MSK_RX_HA RD_RST	3	Received Ha Interrupt Ma (MAX25432)		sage Status			upt masked upt unmasked			

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BITFIELD	BITS	DESCRIPTION	DECODE
MSK_RX_S OP_MSG_S TAT	2	Receive SOP* Message Status Interrupt Mask. (MAX25432B only)	0: Interrupt masked 1: Interrupt unmasked
MSK_PWR_ STAT	1	Power Status Interrupt Mask.	0: Interrupt masked 1: Interrupt unmasked
MSK_HVCC _STAT	0	CC Status Interrupt Mask. (MAX25432B only)	0: Interrupt masked 1: Interrupt unmasked

ALERT_MASK_H (0x13)

Upper 8 Bits of ALERT_MASK Register.

The registers in this section define the masks that may be set for the ALERT registers. A masked register will still indicate in the ALERT register, but will not set the ALERT pin low.

This register will be reset to its default value when a Hard Reset is sent; or a Hard Reset is received (if Hard Reset detection is enabled).

7	6	5	4		3	2	1	0	
MSK_VND R_ALRT	MSK_ALRT _EXTND	MSK_EXTN D_STAT	MSK_BEG_ SOP_MSG_ STAT	MSK_VBUS _SNK_DIS C_DET		MSK_RX_B UFF_OVRF L	MSK_FAUL T_STAT	MSK_VBUS _V_ALRM_ _LO	
0b1	0b1	0b1	0b1		0b1	0b1	0b1	0b1	
Write, Read, Ext	Write, Read, Ext	Write, Read, Ext	Write, Read, Ext		,	Write, Read, Ext	Write, Read, Ext	Write, Read, Ext	
0b1	0b0	0b0	0b0		0b0	0b0	0b1	0b0	
BITS		DESCRIPT	ION			DI	ECODE		
7	Vendor-Defi	ned Alert Interr	rupt Mask.						
6	Alert Extend (Reserved)	Alert Extended Interrupt Mask. (Reserved)					le (Alert Exten	ded not	
5	Extended St	atus Interrupt N	Mask.			0: Interrupt masked 1: Interrupt unmasked			
4	Beginning S Mask. (Reserved)	OP* Message	Status Interrup	t	Writes are not applicable (Extended messaging not supported)				
3	V _{BUS} Sink E Mask. (Reserved)					Writes are not applicable (source only)			
2		Rx Buffer Overflow Interrupt Mask. (MAX25432B only)				0: Interrupt masked 1: Interrupt unmasked			
1	Fault Status	Interrupt Mask	ζ.						
	MSK_VND R_ALRT Ob1 Write, Read, Ext Ob1 BITS 7 6 5 4 3	MSK_VND R_ALRTMSK_ALRT _EXTND0b10b10b10b1Write, Read, ExtWrite, Read, Ext0b10b0BITS0b17Vendor-Definer (Reserved)6Alert Extended (Reserved)5Extended St Mask. (Reserved)3VBUS Sink I Mask. (Reserved)2Rx Buffer Or (MAX25432)	MSK_VND R_ALRT MSK_ALRT LEXTND MSK_EXTN D_STAT 0b1 0b1 0b1 0b1 0b1 0b1 Write, Read, Ext Write, Read, Ext Write, Read, Ext 0b1 0b0 0b0 BITS DESCRIPT 7 Vendor-Defined Alert Interno Alert Extended Interrupt Mathematication (Reserved) 5 Extended Status Interrupt Mathematication (Reserved) 4 Beginning SOP* Message Mask. (Reserved) 3 VBUS Sink Disconnect Det Mask. (Reserved) 2 Rx Buffer Overflow Interrupt (MAX25432B only)	MSK_VND R_ALRT MSK_ALRT _EXTND MSK_EXTN D_STAT MSK_BEG_ SOP_MSG_ STAT 0b1 0b1 0b1 0b1 Write, Read, Ext Write, Read, Ext Write, Read, Ext Write, Read, Ext Write, Read, Ext 0b1 0b0 0b0 0b0 BITS DESCRIPTION 7 Vendor-Defined Alert Interrupt Mask. (Reserved) 5 Extended Interrupt Mask. (Reserved) 4 Beginning SOP* Message Status Interrup Mask. (Reserved) 3 VBUS Sink Disconnect Detected Interrupt Mask. (Reserved)	MSK_VND R_ALRT MSK_ALRT _EXTND MSK_EXTN D_STAT MSK_BEG_SOP_MSG_STAT MSI SI SI STAT 0b1 0b1 0b1 0b1 0b1 Write, Read, Ext Write, Read, Ext	MSK_VND R_ALRT MSK_ALRT _EXTND MSK_EXTN D_STAT MSK_BEG_ SOP_MSG_ STAT MSK_VBUS _SNK_DIS C_DET 0b1 0b1 0b1 0b1 0b1 0b1 Write, Read, Ext 0b1 0b0 0b0 0b0 0b0 0b0 BITS DESCRIPTION 0: Intern 1: Intern 7 Vendor-Defined Alert Interrupt Mask. (Reserved) 0: Intern 1: Intern 6 Alert Extended Interrupt Mask. (Reserved) 0: Intern 1: Intern 5 Extended Status Interrupt Mask. (Reserved) 0: Intern 1: Intern 4 Beginning SOP* Message Status Interrupt Mask. (Reserved) Writes a supporte 3 V _{BUS} Sink Disconnect Detected Interrupt Mask. (Reserved) 0: Intern 1: Intern 2 Rx Buffer Overflow Interrupt Mask. (MAX25432B only) 0: Intern 1: Intern	MSK_VND R_ALRT MSK_ALRT _EXTND MSK_EXTN D_STAT MSK_ESC SOP_MSG_ STAT MSK_VBUS SNK_DIS C_DET MSK_RX_B UFF_OVRF 0b1 0b1 0b1 0b1 0b1 0b1 0b1 0b1 Write, Read, Ext 0b1 0b0 0b0 0b0 0b0 0b0 0b0 BITS DESCRIPTION DI 7 Vendor-Defined Alert Interrupt Mask. (Reserved) 0: Interrupt masked 1: Interrupt unmasked 6 Alert Extended Interrupt Mask. (Reserved) 0: Interrupt masked 1: Interrupt unmasked 5 Extended Status Interrupt Mask. (Reserved) 0: Interrupt masked 1: Interrupt unmasked 4 Beginning SOP* Message Status Interrupt Mask. (Reserved) Writes are not applicab supported) 3 VBUS Sink Disconnect Detected Interrupt Mask. (Reserved) Writes are not applicab supported) 2 Rx Buffer Overflow Interrupt Mask. (MAX25432B only) 0: Interrupt masked 1: Interrupt unmasked	MSK_VND R_ALRT MSK_ALRT _EXTND MSK_EXTN D_STAT MSK_BEG SOP_MSG_ STAT MSK_VBUS SNK_DIS C_DET MSK_RX_B UFF_OVRF MSK_FAUL T_STAT 0b1 0b1 0b1 0b1 0b1 0b1 0b1 0b1 0b1 Write, Read, Ext MSK_ODE DECODE 0 <t< td=""></t<>	

POWER STATUS MASK (0x14)

0

Event Interrupt Mask. It is masked and unmasked by the TCPM. This register allows individual masking of power events.

0: Interrupt masked

1: Interrupt unmasked

The assertion of the ALERT pin is prevented when the corresponding bit is set to zero by the TCPM.

V_{BUS} Voltage Alarm Lo Interrupt Mask. (MAX25432B only)

This register will be reset to its default value when a Hard Reset is sent; or a Hard Reset is received (if Hard Reset

MSK VBUS

V_ALRM_LO

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detection is enabled).

BIT	7	6	5	4		3	2	1	0	
Field	MSK_DEB G_ACC_CO NN_STAT	MSK_TCPC _INIT_STA T	MSK_SRC_ NON_DEF_ VOLT_STA T	MSK_SRC_ VBUS_STA T		K_VBUS ET_STA T	MSK_VBUS _PRSN_ST AT	MSK_VCO NN_PRSN_ STAT	MSK_SNK_ VBUS_STA T	
Reset	0b1	0b1	0b1	0b1		0b1	0b1	0b1	0b1	
Access Type	Write, Read, Ext	Write, Read, Ext	Write, Read, Ext	Write, Read, Ext		Vrite, ad, Ext	Write, Read, Ext	Write, Read, Ext	Write, Read, Ext	
Reset A	0b1	0b1	0b1	0b1		0b1	0b1	0b1	0b1	
BITFIELD	BITS		DESCRIPT	ION			DI	ECODE		
MSK_DEBG _ACC_CON N_STAT	7	Debug Acce Mask.	ssory Connect	ed Status Inter	rupt		Interrupt masked Interrupt unmasked			
MSK_TCPC_ INIT_STAT	6	MAX25432 Mask.	nitialization Sta	atus Interrupt			upt masked upt unmasked			
MSK_SRC_ NON_DEF_V OLT_STAT	5	Sourcing Hig	gh-Voltage Stat	tus Interrupt Ma	ask.		rrupt masked rrupt unmasked			
MSK_SRC_V BUS_STAT	4	Sourcing VE	SUS Status Inte	errupt Mask		0: Interrupt masked 1: Interrupt unmasked				
MSK_VBUS_ DET_STAT	3	V _{BUS} Detec	tion Status Inte	errupt Mask.			upt masked upt unmasked			
MSK_VBUS_ PRSN_STAT	2	V _{BUS} Prese	V _{BUS} Present Status Interrupt Mask.				upt masked upt unmasked			
MSK_VCON N_PRSN_ST AT	1	V _{CONN} Pres	V _{CONN} Present Status Interrupt Mask.				0: Interrupt masked 1: Interrupt unmasked			
MSK_SNK_V BUS_STAT	0	Sinking V _{BU} (Reserved)	_S Status Interro	upt Mask.		Writes a supporte	re not applicab ed)	le (Force off V	_{BUS} not	

FAULT_STATUS_MASK (0x15)

Event Interrupt Mask. It is masked and unmasked by the TCPM. This register allows individual masking of fault events. The assertion of the ALERT pin is prevented when the corresponding bit is set to zero by the TCPM.

BIT	7	6	5	4		3	2	1	0	
Field	MSK_AII_R EG_RST	MSK_FOR CD_OFF_V BUS	MSK_AUTO _DISCH_FA IL	MSK_FOR C_DISCH_ FAIL	MSK_VBUS _OCP		MSK_VBUS _OVP	MSK_VCO NN_OCP	MSK_I2C_E RR	
Reset	0b1	0b1	0b1	0b1		0b1	0b1	0b1	0b1	
Access Type	Write, Read	Write, Read	Write, Read	Write, Read	Write	e, Read	Write, Read	Write, Read	Write, Read	
Reset A	0b1	0b1	0b1	0b1		0b1	0b1	0b1	0b1	
BITFIELD	BITS		DESCRIPT	ION		DECODE				
MSK_AII_RE G_RST	7	All Registers	s Reset to Defa	ult Interrupt Ma	ask.		iterrupt masked iterrupt unmasked			
MSK_FORC D_OFF_VBU S	6	Force Off V _E (Reserved)	_{BUS} Interrupt S	tatus Mask.		Writes a supporte	re not applicab ed)	le (Force off V _I	_{BUS} not	
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BITFIELD	BITS	DESCRIPTION	DECODE			
MSK_AUTO_ DISCH_FAIL	5	Auto Discharge Failed Interrupt Mask. (MAX25432B only)	0: Interrupt masked 1: Interrupt unmasked			
MSK_FORC _DISCH_FAI L	4	Force Discharge Failed Interrupt Mask.	0: Interrupt masked 1: Interrupt unmasked			
MSK_VBUS_ OCP	3	V _{BUS} Overcurrent Protection Fault Interrupt Status Mask.	0: Interrupt masked 1: Interrupt unmasked			
MSK_VBUS_ OVP	2	V _{BUS} Overvoltage Protection Fault Interrupt Status Mask.	0: Interrupt masked 1: Interrupt unmasked			
MSK_VCON N_OCP	1	V _{CONN} Overcurrent Fault Interrupt Status Mask.	0: Interrupt masked 1: Interrupt unmasked			
MSK_I2C_E RR	0	I ² C Interface Error Interrupt Status Mask.	0: Interrupt masked 1: Interrupt unmasked			

EXTENDED_STATUS_MASK (0x16)

Event Interrupt Mask. It is masked and unmasked by the TCPM.

The assertion of the ALERT pin is prevented when the corresponding bit is set to zero by the TCPM.

Bits[7:1] are reserved and ignored by TCPC.

This register will be reset to its default value when a Hard Reset is sent; or a Hard Reset is received (if Hard Reset detection is enabled).

BIT	7	6	5	4	3	2	1	0	
Field	_	-	_	_	-	-	-	MSK_VSAF E0V	
Reset	_	-	-	-	-	-	-	0b1	
Access Type	_	-	-	_	-	-	-	Write, Read, Ext	
Reset A	_	-	-	_	-	-	-	0b1	
BITFIELD	BITS		DESCRIPT	ION	DECODE				
MSK_VSAFE 0V	0	vSafe0V Sta	atus Interrupt M	lask.	0: Interrupt masked 1: Interrupt unmasked				

ALERT_EXTENDED_MASK (0x17)

Event Interrupt Mask. It is masked and unmasked by the TCPM.

The assertion of the ALERT pin is prevented when the corresponding bit is set to zero by the TCPM.

Bits[7:3] are reserved and ignored by TCPC.

This register will be reset to its default value when a Hard Reset is sent; or a Hard Reset is received (if Hard Reset detection is enabled).

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	-	-	MSK_TMR_ EXP	MSK_SRC_ FST_RSWP	MSK_SNK_ FST_RSWP
Reset	-	-	-	-	-	0b1	0b1	0b1
Access Type	-	-	_	-	-	Write, Read, Ext	Write, Read, Ext	Write, Read, Ext
Reset A	-	-	-	-	-	0b1	0b1	0b1

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BITFIELD	BITS	DESCRIPTION	DECODE
MSK_TMR_ EXP	2	Timer Expired Interrupt Mask. (Reserved)	Writes are not applicable (Generic Timer not supported)
MSK_SRC_F ST_RSWP	1	Source Fast Role Swap Interrupt Mask. (Reserved)	Writes are not applicable (Fast Role Swap not supported)
MSK_SNK_F ST_RSWP	0	Sink Fast Role Swap Interrupt Mask. (Reserved)	Writes are not applicable (source only)

TCPC_CONTROL (0x19)

After the TCPC has set the POR default values	, this register is set and cleared only by the TCPM.
Alter the FOLO has set the FOR delault values,	

BIT	7	6	5	4		3	2	1	0	
Field	EN_SMB_P EC	EN_LK4CO NN_ALRT	EN_WD_T MR	DBG_ACC_ CNTRL	12	C_CLK_STRCH[1:0]		BIST_TM	PLUG_ORN T	
Reset	0b0	0b0	0b0	0b0		0b	00	0b0	0b0	
Access Type	Read Only	Write, Read	Write, Read	Write, Read		Read	Only	Write, Read	Write, Read	
Reset A	0b0	0b0	0b0	0b0		01	00	0b0	0b0	
BITFIELD	BITS		DESCRIPT	ION			D	ECODE		
EN_SMB_PE C	7	Enable SME (Reserved)	Bus PEC.				re ignored and supported)	always reads	0 (SMBus	
EN_LK4CON N_ALRT	6	Enable Lool (MAX25432	ting4Connectic B only)	on Alert.		0: Disable ALERT_L.HVCC_STAT assertion when HVCC_STATUS.LOOKING4CONN changes (default). 1: Enable ALERT_L.HVCC_STAT assertion when HVCC_STATUS.LOOKING4CONN changes.				
EN_WD_TM R	5	Enable Wate	chdog Timer.			0: Watchdog Timer is disabled (default).1: Watchdog Timer is enabled.See the Watchdog Timer section for more information.				
DBG_ACC_ CNTRL	4	Debug Acce (MAX25432	ssory Control. B only)			0: Disab 1: Contr	led (power on olled by TCPM	default)		
I2C_CLK_ST RCH	3:2	I ² C Clock S (Reserved)	retching Contr	ol.		Writes are ignored and always reads 0 (I ² C Clock Stretching not supported)				
BIST_TM	1	(MAX25432 Setting this only when a USB BIST to the TCPC. 1	BIST Test Mode. (MAX25432B only) Setting this bit to 1 is intended to be used only when a USB compliance tester is using USB BIST test data to test the PHY layer of the TCPC. The TCPM should clear this bit when a disconnect is detected.				 0: Normal Operation. Incoming messages enabled by RECEIVE_DETECT passed to TCPM via Alert. 1: BIST Test Mode. Incoming messages enabled by RECEIVE_DETECT result in GoodCRC response but may not be passed to the TCPM via Alert. TCPC may temporarily store incoming messages in the Receive Message Buffer, but this may or may not result in a Receive SOP* Message Status or a Rx Buffer Overflow alert. The TCPM can mask or ignore received message alerts when this bit is set to 1 since the TCPC may or may not assert the alert. The TCPM may also treat received messages in this mode in the same way as received messages during normal operation. 			

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BITFIELD	BITS	DESCRIPTION	DECODE
PLUG_ORN T	0	Plug Orientation.	 0: When V_{CONN} is enabled, apply it to the CC2 pin. MAX25432B only: The MAX25432B monitors the CC1 pin for BMC communications if PD message delivery is enabled. 1: When V_{CONN} is enabled, apply it to the CC1 pin. MAX25432B only: The MAX25432B monitors the CC2 pin for BMC communications if PD message delivery is enabled. Note: The V_{BUS} Auto Discharge Disconnect function uses PLUG_ORNT to detect a disconnect on the correct HVCC pin. Therefore PLUG_ORNT needs to be set to the correct value by the TCPM before enabling the Auto Discharge Disconnect.

ROLE_CONTROL (0x1A)

After the TCPC has set the POR default values, this register is set and cleared only by the TCPM. The TCPM writes to this register to configure the CC pullup (Rp) current sources. The TCPM can write to this register as early as when MAX25432B enters the HVCC Discharge state (see the Power-Up Sequence diagram). An example for this situation would be to keep the current sources disabled until the TCPM is ready.

Since the CC current sources are on the low-voltage side (CC pins), the pullups will be seen on the HVCC pins when the CC pass-through switches are closed. Note that certain faults can cause the switches to open. See the Fault Types table.

BIT	7	6	5	4	3	2	1	0		
Field	_	DRP	RP_VAL[1:0]		HVC	C2[1:0]	HVCC1[1:0]			
Reset	_	0b0	Ot	b10	C	b01	0b	01		
Access Type	-	Read Only	Write	, Read	Write, F	Read, Dual	Write, Re	ead, Dual		
Reset A	-	0b0	Ot	b11	C	b11	0b	11		
BITFIELD	BITS		DESCRIPT	ΓΙΟΝ		D	ECODE			
DRP	6	DRP. (Reserved)				Writes are ignored and always reads 0 (DRP not supported)				
RP_VAL	5:4	Rp Value Se (MAX25432I			01: Rp 10: Rp	00: Rp default 01: Rp 1.5A 10: Rp 3.0A 11: Reserved				
HVCC2	3:2	HVCC2 Con (MAX25432I			01: Rp 10: Re	00: Reserved 01: Rp 10: Reserved 11: Open (disconnect or don't care)				
HVCC1	1:0	HVCC1 Con (MAX254321			01: Rp 10: Re	00: Reserved 01: Rp 10: Reserved 11: Open (disconnect or don't care)				

FAULT_CONTROL (0x1B)

After the TCPC has set the POR default values, this register is set and cleared only by the TCPM. The TCPM writes to

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BIT	7	6	5	4		3	2	1	0	
Field	-	-	-	FRC_OFF_ VBUS_DIS	CH	US_DIS _FLT_D _TMR_E _N	VBUS_OCP _DET_EN	VBUS_OVP _DET_EN	VCONN_O CP_DET_E N	
Reset	-	_	_	0b0		0b0	0b0	0b0	0b0	
Access Type	_	_	_	Read Only	Writ	te, Read	Write, Read	Write, Read	Write, Read	
Reset A	-	_	-	0b0		0b0	0b0	0b0	0b0	
BITFIELD	BITS		DESCRIPT	ION		DECODE				
FRC_OFF_V BUS_DIS	4	Force Off V _E (Reserved)	3US-			Writes are ignored and always reads 0b (force off V_{BUS} control not supported)				
VBUS_DISC H_FLT_DET _TMR_EN	3	V _{BUS} Discha Enable.	arge Fault Dete	ection Timer		0: Enable 1: Disable This enables the timers for both FAULT_STATUS.AUTO_DISCH_FAIL and FAULT_STATUS.FORCE_DISCH_FAIL.				
VBUS_OCP_ DET_EN	2	V _{BUS} Overc	urrent Protection	on Enable.		0: Enable 1: Disable				
VBUS_OVP_ DET_EN	1	V _{BUS} Overv	V _{BUS} Overvoltage Protection Enable.				0: Enable 1: Disable			
VCONN_OC P_DET_EN	0	V _{CONN} Ove	rcurrent Protec	tion Enable.		0: Enable 1: Disable				

FAULT_CONTROL to enable/disable detection of certain faults.

POWER_CONTROL (0x1C)

After the TCPC has set the POR default values, this register is set and cleared by the TCPM.

The timing parameters for the TCPM in conjunction with the TCPC must meet the USB PD requirements.

The TCPM reads the HVCC_STATUS, POWER_STATUS and optionally the VBUS_VOLTAGE registers to determine the connection state and the orientation of a USB Type-C port.

The TCPM shall take the following steps to request sourcing V_{CONN} over one of the HVCC pins:

1. The TCPM shall write to TCPC_CONTROL.PLUG_ORNT to inform TCPC which HVCC pin (not connected through the cable) is repurposed as V_{CONN} .

2. The TCPM shall set POWER_CONTROL.EN_VCONN = 1b.

The TCPC will then source V_{CONN} as TCPM requested irrespective of the status of V_{BUS} and the HVCC1, HVCC2 pins. The TCPC will not autonomously disable V_{CONN} sourcing when V_{BUS} is removed, or the HVCC1, HVCC2 status has changed. The TCPM shall set POWER_CONTROL.EN_VCONN = 0b to request disabling V_{CONN} sourcing.

This register's write access is blocked during a Fault Action A. I²C master's write transactions will be taken into account after the Fault A is removed.

BIT	7	6	5	4	3	2	1	0
Field	FAST_RSW P_EN	VBUS_VOL T_MON_EN	VOLT_ALR MS_EN	AUTO_DIS CH_DISC_ EN	BLED_DIS CH_EN	FORC_DIS CH_EN	VCONN_P WR_SUPP	EN_VCON N
Reset	0b0	0b1	0b1	0b0	0b0	0b0	0b0	0b0
Access Type	Read Only	Write, Read	Write, Read	Write, Read	Read Only	Write, Read	Write, Read	Write, Read, Dual
Reset A	0b0	0b1	0b1	0b0	0b0	0b0	0b0	0b0

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BITFIELD	BITS	DESCRIPTION	DECODE
FAST_RSW P_EN	7	Fast Role Swap Enable. (Reserved)	Writes are ignored and always reads 0 in MAX25432 (Fast Role Swap not supported)
VBUS_VOLT _MON_EN	6	VBUS_VOLTAGE and VBUS_CURRENT Monitor.	 0: Enables V_{BUS} Voltage and Current Monitoring (ADC). 1: Disables V_{BUS} Voltage and Current Monitoring (default).
VOLT_ALRM S_EN	5	Disable Voltage Alarms.	0: Enables Voltage Alarms Power status reporting.1: Disables Voltage Alarms Power status reporting (default).
AUTO_DISC H_DISC_EN	4	Auto-Discharge Disconnect. (MAX25432B only)	0: Disabled (default) 1: Enabled When enabled, the MAX25432B automatically disables sourcing V_{BUS} then discharges V_{BUS} when a disconnect is detected. A disconnect is defined as HVCC1_STATE or HVCC2_STATE register value being equal to 00b ("Open"), with PLUG_ORNT set to 0b or 1b, respectively. Therefore, PLUG_ORNT must be set to the correct value before enabling the V_{BUS} Auto Discharge Disconnect function.
BLED_DISC H_EN	3	Enable Bleed Discharge. (Reserved)	Writes are ignored and always reads 0 in MAX25432 (Bleed Discharge not supported).
FORC_DISC H_EN	2	V _{BUS} Force Discharge.	0: Disable 1: Enable
VCONN_PW R_SUPP	CONN_PW 1 Vocum Power Supported		0: Deliver up to 1W. 1: Deliver at least the power indicated in DEVICE_CAPABILITIES.VCONN_PWR_CAP. Writing to this register has no effect in the MAX25432. Actual wattage is dependent on the VCONN_THRESH.VCONN_OCPL_SEL threshold and V _{CONN} pin voltage.
EN_VCONN	_VCONN 0 Enable V _{CONN} .		$\begin{array}{l} \mbox{0: Disable V}_{CONN} \mbox{ source (default).} \\ \mbox{1: Enable V}_{CONN} \mbox{ source.} \\ \\ \mbox{Enabling V}_{CONN} \mbox{ will cause the corresponding} \\ \mbox{HVCC}_{STAT} \mbox{ to go to 00b (Open).} \\ \\ \mbox{The MAX25432 autonomously disables V}_{CONN} \mbox{ by} \\ \\ \mbox{clearing EN}_{VCONN} \mbox{ when SHIELDING is active.} \end{array}$

HVCC_STATUS (0x1D)

This register is set and cleared by the TCPC. The TCPC indicates the current HVCC state in this register. Connection status (LOOKING4CONN) and result (CONN_RSLT) are not supported as the MAX25432B is a source only. The TCPC will update the HVCC_STATUS register within tSetReg (50µs, max) of a change on the HVCC1 or HVCC2 pins, after tTCPCfilter debounce (375µs, typ). The TCPM shall read the HVCC1_STATE and HVCC2_STATE to determine the state of the HVCC1 and HVCC2 pins. The TCPM reads this register upon detecting the ALERT pin being asserted and seeing ALERT_L.HVCC_STAT = 1b. The HVCC status reporting is disabled when ROLE_CONTROL.HVCC1 = ROLE_CONTROL.HVCC2 = 11b (Open). When the HVCC status reporting is disabled, the HVCC_STATUS register will be set to all zeros. Disabling the HVCC status reporting will not cause a change to the ALERT registers.

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BIT	7	6	5	4	3		2	1	0	
Field	_	-	LOOKING4 CONN	CONN_RSL T	HVCC	HVCC2_STATE[1:0]		HVCC1_STATE[1:0]		
Reset	-	-	0b0	0b0		0b	00	Ob	000	
Access Type	_	-	Read Only	Read Only	F	Read	l Only	Read	l Only	
Reset A	_	-	0b0	0b0		0b	011	Ob	o11	
BITFIELD	BITS		DESCRIPT	ION			D	ECODE		
LOOKING4C ONN	5	Looking4Co (MAX25432			con 1: M A tra	 0: MAX25432B is not actively looking for a connection. 1: MAX25432B is looking for a connection. A transition from 1 to 0 indicates a potential connection has been found. 				
CONN_RSLT	4	ConnectRes (Reserved)	sult.		Alw	Always reads 0 in MAX25432 (source only)				
HVCC2_STA TE	3:2	1	HVCC2 State. (MAX25432B only)				00: SRC.Open (Open, Rp) 01: SRC.Ra (below maximum vRa) 10: SRC.Rd (within the vRd range) 11: Reserved			
HVCC1_STA TE	1:0	HVCC1 Stat (MAX25432	00: SRC.Open (Open, Rp) 01: SRC.Ra (below maximum vRa) 10: SRC.Rd (within the vRd range) 11: Reserved							

POWER_STATUS (0x1E)

This register is set and cleared by the TCPC. The TCPM reads this register upon detecting an ALERT and reading the ALERT_L.PWR_STAT bit set to 1. The TCPC indicates the current Power Status in this register.

BIT	7	6	5	4		3	2	1	0	
Field	DBG_ACC_ STAT	INIT_STAT	SRC_NON_ DEF_VOLT	SRC_VBUS	VBUS_DET _EN		VBUS_PRE SENT	VCONN_P RESENT	SNK_VBUS	
Reset	0b0	0b0	0b0	0b0		0b1	0b0	0b0	0b0	
Access Type	Read Only	Read Only	Read Only	Read Only	Read Only		Read Only	Read Only	Read Only	
Reset A	0b0	0b0	0b0	0b0		0b1	0b0	0b0	0b0	
BITFIELD	BITS		DESCRIPT	ION			DECODE			
DBG_ACC_S TAT	7	Debug Acce	essory Status.				No debug accessory connected (default) Debug accessory connected			
INIT_STAT	6	MAX25432	MAX25432 Initialization Status.				 0: The MAX25432 has completed initialization and all registers are valid. 1: The MAX25432 is still performing internal initialization and the only registers that are guaranteed to return the correct values are 0x000x0B. 			

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BITFIELD	BITS	DESCRIPTION	DECODE			
SRC_NON_ DEF_VOLT	5	Sourcing Non-Default V _{BUS} Voltage.	0: Sourcing vSafe5V voltage on V_{BUS} 1: Sourcing non-default voltage on V_{BUS} This bit is asserted as long as the MAX25432 is sourcing. Non-default voltage over V_{BUS} (i.e., not vSafe5V) as a response to TCPM sending the SourceVbusNondefaultVoltage command. This bit is not valid if POWER_STATUS.SRC_VBUS = 0.			
SRC_VBUS	4	Sourcing V _{BUS} .	0: The MAX25432 is not sourcing V_{BUS} . 1: The MAX25432 is sourcing V_{BUS} .			
VBUS_DET_ EN	3	V _{BUS} Detection Enabled.	0: V _{BUS} detection disabled 1: V _{BUS} detection enabled (default)			
VBUS_PRES ENT	2	V _{BUS} Present Status.	0: V _{BUS} is not present (below 4V). 1: V _{BUS} is present (4V or above).			
VCONN_PR ESENT	1	V _{CONN} Present Status.	0: V_{CONN} is not present. 1: This bit is asserted whenever V_{CONN} is present on HVCC1 or HVCC2.			
SNK_VBUS	_VBUS 0 Sinking V _{BUS} Status. (Reserved)		Always reads 0 in MAX25432 (source only)			

FAULT_STATUS (0x1F)

This register is set by TCPC and cleared by TCPM. The TCPM reads this register upon detecting an ALERT and reading the ALERT_H.FAULT_STAT bit set to 1. The TCPC indicates the current fault status in this register.

BIT	7	6	5	4		3	2	1	0	
Field	ALL_REG_ RST	FORCD_OF F_VBUS	AUTO_DIS CH_FAIL	FORCE_DI SCH_FAIL		JS_OCP FAULT	VBUS_OVP _FAULT	VCONN_O CP_FAULT	I2C_ERR	
Reset	0b1	0b0	0b0	0b0		0b0	0b0	0b0	0b0	
Access Type	Write 1 to Clear, Read	Write 1 to Clear, Read	Write 1 to Clear, Read	Write 1 to Clear, Read		rite 1 to ar, Read	Write 1 to Clear, Read	Write 1 to Clear, Read	Write 1 to Clear, Read	
Reset A	0b1	0b0	0b0	0b0		0b0	0b0	0b0	0b0	
BITFIELD	BITS		DESCRIPT	ION			DI	ECODE		
ALL_REG_R ST	7	All Registers	All Registers Reset to Default.				 0: Registers have not been reset to their default values. 1: All registers have been initialized to their default values. This bit is asserted when the MAX25432 resets all registers to their default value. This happens at initial power-up or if an unexpected power reset occurs. 			
FORCD_OF F_VBUS	6	Force Off V _E (Reserved)	3US-			Writes are ignored and always reads 0 in the MAX25432 (force off V _{BUS} not supported)				
AUTO_DISC H_FAIL	5	V _{BUS} Auto-I (MAX25432	Discharge Faile B only)	ed.		0: No fault 1: V _{BUS} Auto-Discharge commanded by the TCPM failed				
FORCE_DIS CH_FAIL	4	V _{BUS} Force	V _{BUS} Force Discharge Failed.				0: No fault 1: V _{BUS} Force Discharge commanded by the TCPM failed			
VBUS_OCP_ FAULT	3	V _{BUS} Overc	urrent Protection	on Fault.		0: No fault 1: Fault detected				

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BITFIELD	BITS	DESCRIPTION	DECODE
VBUS_OVP_ FAULT	2	V _{BUS} Overvoltage Protection Fault.	0: No fault 1: Fault detected
VCONN_OC P_FAULT	1	V _{CONN} Overcurrent Protection Fault.	0: No fault 1: Fault detected
I2C_ERR	0	I ² C Interface Error.	 0: No error An I²C error has occurred The following conditions will cause the MAX25432 to assert this bit: The watchdog timer has expired Writing SourceVbusDefault command while not sourcing V_{BUS} and a pre-bias exists on V_{BUS} that cannot be discharged Writing DisableVbusNonDefault command while not sourcing V_{BUS} Writing DisableVbusDetect command while sourcing V_{BUS} (V_{BUS} needs to be disabled first to turn off V_{BUS} present detection) Writing to CONFIG_EXTENDED1.FRS_BIDIR Writing to the TRANSMIT register requesting a transmission that is not Hard Reset, Cable Reset, or BIST Carrier Mode 2 and there are less than 2 bytes in the TX_BUF_BYTE_x register (MAX25432B only) The MAX25432 will not assert I2C_ERR in the following conditions: Reading or writing to an address that is not the first byte of a multibyte register (e.g., VBUS_NONDEFAULT_TARGET_H[7:0]) Reading or writing to multiple registers in one transaction Writing SourceVbusDefault command while sourcing V_{BUS} default voltage. Writing WakeI2C or I²C Idle commands Reading the last COMMAND (always returns 0) Writing to a nondefined register

EXTENDED_STATUS (0x20)

This register is set and cleared by the TCPC. The TCPM reads this register upon detecting an ALERT and reading the ALERT_H.EXTND_STAT bit set to 1.

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	-	-	-	_	VSAFE0V
Reset	-	-	-	-	-	-	-	0b0
Access Type	-	-	-	-	-	-	-	Read Only
Reset A	-	-	-	-	-	-	_	0b0

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BITFIELD	BITS	DESCRIPTION
VSAFE0V	0	0: V _{BUS} is above vSafe0V. 1: V _{BUS} is at or below vSafe0V. The MAX25432 will report V _{BUS} is at or below vSafe0V when the OUT pin is below 0.8V (typ). This bit is not valid when POWER_STATUS.VBUS_DET_EN = 0.

ALERT_EXTENDED (0x21)

This register has no effect on MAX25432.

BIT	7	6	5	4	3		2	1	0	
Field	_	-	-	_	_		TMR_EXP	SRC_FST_ RSWP	SNK_FST_ RSWP	
Reset	_	_					0b0	0b0	0b0	
Access Type	-	_	-	-	_		Read Only	Read Only	Read Only	
Reset A	-	-	-	-	-		0b0	0b0	0b0	
BITFIELD	BITS		DESCRIPT	ION		DECODE				
TMR_EXP	2	Generic Tim (Reserved)	er Expired.			Writes are ignored and always reads 0 (generic timer not supported)				
SRC_FST_R SWP	1	Source Fast (Reserved)	Source Fast Role Swap. (Reserved)				Writes are ignored and always reads 0 (Fast Role Swap not supported)			
SNK_FST_R SWP	0	Sink Fast Role Swap. (Reserved)				Writes are ignored and always reads 0 (source only)				

COMMAND (0x23)

Commands are issued and written by the TCPM. The COMMAND register is cleared by the TCPC after being acted upon.

BIT	7	6	5	4	3	2	1	0				
Field		COMMAND[7:0]										
Reset	0x00											
Access Type		Write, Read, Ext										
Reset A		0x00										

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BITFIELD	BITS	DESCRIPTION
COMMAND	7:0	List of supported commands: 0x22 DisableVbusDetect : Disables V _{BUS} present and vSafe0V detection. 0x33 EnableVbusDetect : Enables V _{BUS} present and vSafe0V detection. 0x66 DisableSourceVbus : Disables sourcing of V _{BUS} . This command does not disable V _{BUS} present detection. 0x77 SourceVbusDefaultVoltage : Enables sourcing vSafe5V over V _{BUS} and enables V _{BUS} present detection by setting POWER_STATUS.VBUS_DET_EN = 1. The MAX25432 will transition to vSafe5V if sourcing non-default voltage. 0x88 SourceVbusNonDefaultVoltage : Sets V _{BUS} to a non-default voltage target. This is an invalid command when not already sourcing V _{BUS} . 0x99 Lock4Connection (MAX25432B only): The TCPC restarts connection detection. This command is ignored when HVCC1 and HVCC2 in ROLE CONTROL register are not the same value. 0xAA RxOneMore (MAX25432B only): Configures the TCPC to automatically clear the RECEIVE_DETECT register after sending the next GoodCRC. This is used to disable message passing at a known point regardless of message separation or the depth of the RECEIVE_BUFFER in the TCPC. 0xDD ResetTransmitBuffer (MAX25432B only): The TCPC resets the pointer of the TRANSMIT_BUFFER register to offset 1 and the contents of TRANSMIT_BUFFER becomes invalid when this command is issued by the TCPM. 0xEE ResetReceiveBuffer (MAX25432B only): The TCPC resets the pointer of RECEIVE_BUFFER to 1 when this command is issued by the TCPM. TCPC does not clear the content of the buffer upon receiving this command. The TCPM issues this command in order to re-read the RECEIVE_BUFFER.RX_BUF_BYTE_x. List of unsupported commands: 0x11 WakeI2C - No action 0x44 DisableSinkVbus - No action 0x45 SinkVbus - No action 0x45 SinkVbus - No action 0x45 ID Reset Resetion 0x46 ID Reset Reset Resetion 0x46 ID Reset Resetion 0x46 ID Reset Reset Resetio

DEVICE_CAPABILITIES_1_L (0x24)

This register is in the nonvolatile memory of the TCPC. This register describes features supported by the TCPC.

BIT	7	6	5	4		3	2	1	0	
Field	PWR_ROLE_CAP[2:0]			SOP_DBG_ CAP	SRC_VCO NN_CAP		SNK_VBUS _CAP	SRC_HI_V BUS_CAP	SRC_VBUS _CAP	
Reset		0b001		0b1		0b1	0b0	0b1	0b1	
Access Type	Read Only			Read Only	Re	ad Only	Read Only	Read Only	Read Only	
Reset A		0b0	0b1		0b0	0b1	0b1			
BITFIELD	BITS		DESCRIPT	ION			DECODE			
PWR_ROLE _CAP	7:5	Power Roles	Power Roles Supported.				001: Source only. Rp 3.0A, 1.5A, and default indicated in DEVICE_CAPABILITIES_1_H.SRC_RES_SUP_C AP (MAX25432B) 111: Source only with no Type-C port controller (MAX25432A)			
SOP_DBG_ CAP	4		SOP'_DBG/SOP"_DBG Support. (MAX25432B only)				1: All SOP* messages including SOP'_DBG/ SOP"_DBG are supported			

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BITFIELD	BITS	DESCRIPTION	DECODE
SRC_VCON N_CAP	3	Source V _{CONN} Capability.	1: The MAX25432 is capable of sourcing $V_{\mbox{CONN}}$ through its switch.
SNK_VBUS_ CAP	2	Sink V _{BUS} Capability.	0: The MAX25432 is not capable of controlling the sink path to the system load (source only).
SRC_HI_VB US_CAP	1	Source Non-Default V _{BUS} Capability.	1: The MAX25432 is capable of sourcing non-default voltages on V_{BUS} .
SRC_VBUS_ CAP	0	Source V _{BUS} Capability.	1: The MAX25432 is capable of controlling the source path to V_{BUS} .

DEVICE_CAPABILITIES_1_H (0x25)

This register is in the nonvolatile memory of the TCPC. This register describes features supported by the TCPC.

BIT	7	6	5	4		3	2	1	0	
Field	VBUS_NON DEF_TRGT _CAP	VBUS_OCP _RPT_CAP	VBUS_OVP _RPT_CAP	BLEED_DIS CH_CAP		RCE_DI VBUS_MEA S_ALRM_C SRC_RES_SUP_ AP		UP_CAP[1:0]		
Reset	0b1	0b1	0b1	0b0		0b1	0b1	0b	10	
Access Type	Read Only	Read Only	Read Only	Read Only	Re	ad Only	Read Only	Read	l Only	
Reset A	0b1	0b1	0b1	0b0		0b1	0b1	0b	11	
BITFIELD	BITS		DESCRIPT	ION			D	ECODE		
VBUS_NON DEF_TRGT_ CAP	7	V _{BUS} Non-E	V _{BUS} Non-Default Target Capability.				0: VBUS_NONDEFAULT_TARGET register supported			
VBUS_OCP_ RPT_CAP	6	V _{BUS} OCP	Reporting Capa	ability.		1: Supported				
VBUS_OVP_ RPT_CAP	5	V _{BUS} OVP I	Reporting Capa	ability.		1: Supported				
BLEED_DIS CH_CAP	4	Bleed Disch	arge Capability	<i>י</i> .		0: Not supported				
FORCE_DIS CH_CAP	3	Force Disch	arge Capability	<i>י</i> .		1: Supported				
VBUS_MEA S_ALRM_CA P	2	V _{BUS} Meas	V _{BUS} Measurement and Alarm Capabilities.				1: Supported			
SRC_RES_S UP_CAP	1:0	Source Resi	istor Supported	l.		10: Rp 3.0A, 1.5A, and default on the MAX25432B 11: Not supported on the MAX25432A				

DEVICE_CAPABILITIES_2_L (0x26)

This register is in the nonvolatile memory of the TCPC. This register describes features supported by the TCPC.

BIT	7	6	5	4	3	2	1	0
Field	SNK_DISC _DET_CAP	STP_DISC H_THR_CA P		ALRM_LSB P[1:0]	VCO	VCONN_O CP_CAP		
Reset	0b0	0b1	0b	00	0b001			0b1
Access Type	Read Only	Read Only	Read	Only	Read Only			Read Only
Reset A	0b0	0b1	0b	0b00		0b001		0b1

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BITFIELD	BITS	DESCRIPTION	DECODE		
SNK_DISC_ DET_CAP	7	Sink Disconnect Detection Capability.	0: VBUS_SINK_DISCONNECT_THRESHOLD not supported (source only)		
STP_DISCH _THR_CAP	6	V _{BUS} Stop Discharge Threshold Capability.	1: VBUS_STOP_DISCHARGE_THRESHOLD supported		
VBUS_VOLT _ALRM_LSB _CAP	5:4	V _{BUS} Voltage Alarm LSB Capability.	00: MAX25432 has 25mV LSB for its voltage alarm and uses all 10 bits in VBUS_VOLTAGE_ALARM_HI_CFG and VBUS_VOLTAGE_ALARM_LO_CFG.		
VCONN_PW R_CAP	3:1	V _{CONN} Power Supported.	001: Up to 1.5W (programmable)		
VCONN_OC P_CAP	0	V _{CONN} Overcurrent Fault Capability.	1: Supported		

DEVICE_CAPABILITIES_2_H (0x27)

This register is in the nonvolatile memor	of the TCPC. This register describes	features supported by the TCPC.
The register is in the neriveration memory		

BIT	7	6	5	4		3	2	1	0	
Field	_	-	GENERIC_ TMR_CAP	LONG_MS G_CAP		B_PEC_ CAP	SRC_FRS_ CAP	SNK_FRS_ CAP	WDOG_TM R_CAP	
Reset	-	-	0b0	0b0		0b0	0b0	0b0	0b1	
Access Type	-	-	Read Only	Read Only	Re	ad Only	Read Only	Read Only	Read Only	
Reset A	-	-	0b0	0b0		0b0	0b0	0b0	0b1	
BITFIELD	BITS		DESCRIPT	ION			D	ECODE		
GENERIC_T MR_CAP	5	Generic Tim	er Capability.			0: Not si	supported			
LONG_MSG _CAP	4	Long Messa	ge Capability.			The MA	messages (264 bytes) not supported. X25432B supports up to 30 bytes content SOP* message.			
SMB_PEC_C AP	3	SMBus PEC	Capability.			0: Not si	supported			
SRC_FRS_C AP	2	Source FR S	Source FR Swap Capability.				lot supported			
SNK_FRS_C AP	1	Sink FR Sw	Sink FR Swap Capability.				D: Not supported			
WDOG_TMR _CAP	0	Watchdog T	Watchdog Timer Capability.				1: Supported			

STANDARD_INPUT_CAPABILITIES (0x28)

This register is in the nonvolatile memory of the TCPC. MAX25432 does not support any standard inputs.

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	SRC_FRS_INP_CAP[1:0]		VBUS_EXT _OVP_CAP	VBUS_EXT _OCP_CAP	FRC_OFF_ VBUS_CAP
Reset	_	-	-	Ob	0b00		0b0	0b0
Access Type	-	_	-	Read Only		Read Only	Read Only	Read Only
Reset A	_	-	-	0b00		0b0	0b0	0b0

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BITFIELD	BITS	DESCRIPTION	DECODE		
SRC_FRS_I NP_CAP	4:3	Source Fast Role Swap Standard Input Capability.	00: Not supported		
VBUS_EXT_ OVP_CAP	2	V _{BUS} External Overvoltage Fault Standard Input Capability.	0: Not supported		
VBUS_EXT_ OCP_CAP	1	V _{BUS} External Overcurrent Fault Standard Input Capability.	0: Not supported		
FRC_OFF_V BUS_CAP	0	Force Off V _{BUS} Standard Input Capability.	0: Not supported		

STANDARD_OUTPUT_CAPABILITIES (0x29)

This register is in the nonvolatile memory of the TCPC. MAX25432 does not support any standard outputs.

BIT	7	6	5	4		3	2	1	0	
Field	VBUS_SNK _DIS_DET_ CAP	DBG_ACC_ CAP	VBUS_PRE SENT_CAP	AUD_ACC_ CAP		T_CBL_ CAP	MUX_CON FG_CAP	CONN_PR ESENT_CA P	CONN_ORI ENT_CAP	
Reset	0b0	0b0	0b0	0b0		0b0	0b0	0b0	0b0	
Access Type	Read Only	Read Only	Read Only	Read Only	Re	ad Only	Read Only	Read Only	Read Only	
Reset A	0b0	0b0	0b0	0b0		0b0	0b0	0b0	0b0	
BITFIELD	BITS		DESCRIPT	ION			D	ECODE		
VBUS_SNK_ DIS_DET_C AP	7		V _{BUS} Sink Disconnect Detect Standard Output Capability.				supported			
DBG_ACC_ CAP	6	Debug Acce Capability.	Debug Accessory Standard Output Capability.				upported			
VBUS_PRES ENT_CAP	5	V _{BUS} Prese Capability.	nt Monitor Star	ndard Output		0: Not si	t supported			
AUD_ACC_C AP	4	Audio Adapt Capability.	er Accessory S	Standard Outpu	t	0: Not si	supported			
ACT_CBL_C AP	3	Active Cable Capability.	e Indicator Stan	ndard Output		0: Not si	t supported			
MUX_CONF G_CAP	2	MUX Config Capability.	MUX Configuration Control Standard Output Capability.				tsupported			
CONN_PRE SENT_CAP	1	Connection Capability.	Connection Present Standard Output Capability.				0: Not supported			
CONN_ORIE NT_CAP	0	Connector C Capability.	Drientation Star	ndard Output		0: Not supported				

CONFIG_EXTENDED1 (0x2A)

MAX25432 does not support	t any extended functions.
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BIT	7	6	5	4	3	2	1	0
Field	-	-	-	-	-	-	FRS_BIDIR	SRC_FRS_I N
Reset	_	_	_	-	_	_	0b0	0b0
Access Type	-	-	-	-	-	-	Write, Read, Ext	Read Only
Reset A	-	-	-	-	-	-	0b0	0b0

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BITFIELD	BITS	DESCRIPTION	DECODE
FRS_BIDIR	1	Fast Role Swap Bidirectional Pin. (Reserved)	Writes to this bit are ignored and will assert FAULT_STATUS.I2C_ERR. Always reads 0.
SRC_FRS_I N	0	Standard Input Source FR Swap. (Reserved)	Writes are ignored and always reads 0 (Standard Input Source FR Swap not supported)

MESSAGE_HEADER_INFO (0x2E)

The TCPC sets this register at power on. The TCPM may overwrite this register after TCPC initialization is complete.

On attach and after implementing the tCCDebounce (100-200ms), the TCPM shall update the MESSAGE_HEADER_INFO Register first before writing to the RECEIVE_DETECT register.

The TCPC reads from this register to generate the Message header for the GoodCRC.

BIT	7	6	5	4		3	2	1	0	
Field	_	-	– – CBL_PLG			TA_ROL E			PWR_ROL E	
Reset	-	-	-	0b0		0b1	0b	010	0b1	
Access Type	_	-	-	Write, Read	Writ	te, Read	Write,	Read	Write, Read	
Reset A	_	-	-	0b0		0b1	0b	o10	0b1	
BITFIELD	BITS		DESCRIPT	ION			DECODE			
CBL_PLG	4	Cable Plug. (MAX25432	Cable Plug. (MAX25432B only)				Message originated from source, sink, or dual- le power (DRP) Message originated from a cable plug			
DATA_ROLE	3	Data Role. (MAX25432	B only)			0: UFP 1: DFP				
USB_PD	2:1		USB PD Specification Revision. (MAX25432B only)				vision 1.0 vision 2.0 vision 3.0 served			
PWR_ROLE	0		Power Role. (MAX25432B only)				0: Sink 1: Source			

RECEIVE_DETECT (0x2F)

Set by TCPM, cleared by TCPM (and/or TCPC in some instances).

This register enables detection of certain message types and/or signaling types over the HVCC lines. The TCPC responds to the enabled message type with a GoodCRC if it is a SOP* message, except in the case of a GoodCRC message.

When all bits are set to zero, the TCPC disables automatic transmission of GoodCRC message and discards RxOneMore Command if it has not been acted upon.

The TCPM should not set any bits in this register until it is able to respond. The TCPC will set the RECEIVE_DETECT and the READABLE_BYTE_COUNT registers to all zeros in the following cases: when a Hard Reset is sent; a Hard Reset or Cable Reset is received (if Hard Reset or Cable Reset detection is enabled, respectively); after transmitting GoodCRC due to RxOneMore; on a disconnect detection.

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BIT	7	6	5	4		3	2	1	0	
Field	-	EN_CBL_R ST	EN_HRD_R ST	EN_SOP_D BG2	EN_SOP_D BG1		EN_SOP2	EN_SOP1	EN_SOP	
Reset	-	0b0	0b0	0b0		0b0	0b0	0b0	0b0	
Access Type	-	Write, Read, Dual	Write, Read, Dual	Write, Read, Dual		Write, ad, Dual	Write, Read, Dual	Write, Read, Dual	Write, Read, Dual	
Reset A	-	0b0	0b0	0b0		0b0	0b0	0b0	0b0	
BITFIELD	BITS		DESCRIPT	ION			D	ECODE		
EN_CBL_RS T	6		Enable Cable Reset Detection. (MAX25432B only)				Cable Reset detection disabled (default) Cable Reset detection enabled			
EN_HRD_RS T	5		Enable Hard Reset Detection. (MAX25432B only)				Reset detection Reset detection	n disabled (defa n enabled	ault)	
EN_SOP_DB G2	4	Enable SOF (MAX25432	_DBG" Messa B only)	ge.		(default)	 DBG" message detection disabled DBG" message detection enabled 			
EN_SOP_DB G1	3	Enable SOF (MAX25432	2_DBG' Messag B only)	je.		(default)	SOP_DBG' message detection disabled lefault) SOP_DBG' message detection enabled			
EN_SOP2	2		Enable SOP'' Message. (MAX25432B only)			0: SOP" message detection disabled (default) 1: SOP" message detection enabled				
EN_SOP1	1		Enable SOP' Message. (MAX25432B only)			0: SOP' message detection disabled (default) 1: SOP' message detection enabled				
EN_SOP	0		Enable SOP Message. (MAX25432B only)			0: SOP message detection disabled (default) 1: SOP message detection enabled				

RECEIVE_BUFFER (0x30)

The RECEIVE_BUFFER comprises of three sets of registers:

-READABLE_BYTE_COUNT

-RX_BUF_FRAME_TYPE

-RX_BUF_BYTE_x

These registers can only be accessed by reading RECEIVE_BUFFER starting at address 0x30. These registers indicate the status of the received SOP* message buffer. These registers shall be read by the TCPM when the TCPC indicates a SOP* message was received in the Alert Status registers.

The TCPM reads the READABLE_BYTE_COUNT to determine the number of bytes in the RX_BUFFER_BYTE_x. The TCPM reads the RX_BUF_FRAME_TYPE to determine the type of message. The TCPM then reads the content of the USB PD message in RX_BUF_BYTE_x.

The READABLE_BYTE_COUNT register will be set to 0 when a Hard Reset is sent; a Hard Reset is received (if Hard Reset detection is enabled); a disconnect; or when RX_SOP_MSG_STAT is cleared.

BIT	7	7 6 5 4 3 2 1 0								
Field		RECEIVE_BUFFER[7:0]								
Reset				0x	00					
Access Type				Read	l, Ext					
Reset A				0x	00					

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BITFIELD	BITS	DESCRIPTION	DECODE
RECEIVE_B UFFER	7:0	Receive Buffer. (MAX25432B only)	READABLE_BYTE_COUNT[7:0]: Indicates the number of bytes in the RX_BUF_BYTE_x registers plus one (for the RX_BUF_FRAME_TYPE). RX_BUF_FRAME_TYPE[2:0]: Received SOP* Message 0x00: Received SOP 0x01: Received SOP' 0x02: Received SOP' 0x03: Received SOP_DBG' 0x04: Received SOP_DBG' 0x05: Received Cable Reset All others are reserved. RX_BUF_BYTE_x[7:0]: Content of the USB PD message.

TRANSMIT (0x50)

The TCPM writes to this register to transmit a SOP* message where the SOP* message payload (i.e., the header bytes and the data bytes) was written into the TCPC's internal transmit buffer using the TRANSMIT_BUFFER register. The TCPC transmits the aggregate of data written to the TRANSMIT_BUFFER since the pointer was last reset, either due to the TCPM writing to the TRANSMIT register or the TCPM writing to COMMAND.ResetTransmitBuffer (0xDD). The entire register will be written at once and then sent. The TCPC will clear the TRANSMIT register

I2C_WRITE_BYTE_COUNT and its internal transmit buffer after executing the transmission regardless of the outcome (either successful, failed or discarded).

BIT	7	6	5 4 RETRY_COUNTER[1:0]			3	2	1	0	
Field	-	_	RETRY_COUNTER[1:0]			-	TX_S	OP_MESSAG	E[2:0]	
Reset	-	_	0b00			-	0b000			
Access Type	-	_	Write, Read			_	Write, Read			
Reset A	-	-	0b00			-		0b000		
BITFIELD	BITS		DESCRIPT	DESCRIPTION			D	ECODE		
RETRY_CO UNTER	5:4	Retry Count (MAX25432				0x1: Aut once 0x2: Aut twice	o message retry is required utomatically retry message transmission utomatically retry message transmission utomatically retry message transmission			
TX_SOP_ME SSAGE	2:0	Transmit SC (MAX25432	0P* Message. B only)			0x0: Transmit SOP 0x1: Transmit SOP' 0x2: Transmit SOP'' 0x3: Transmit SOP_DBG' 0x4: Transmit SOP_DBG'' 0x5: Transmit Hard Reset 0x6: Transmit Cable Reset 0x7: Transmit BIST Carrier Mode 2				

TRANSMIT_BUFFER (0x51)

The TRANSMIT_BUFFER holds the I2C_WRITE_BYTE_COUNT and the portion of the SOP* USB PD message payload (including the header and/or the data bytes) most recently written by the TCPM in TX_BUF_BYTE_x.

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TX_BUF_BYTE_x is "hidden" and can only be accessed by writing to register address 51h.

BIT	7	6	5	4	3	2	1	0					
Field				TRANSMIT_	BUFFER[7:0]								
Reset		0x00											
Access Type		Write Only											
Reset A				0x	00								
BITFIELD	BITS		DESCRIPT	ION		D	ECODE						
TRANSMIT_ BUFFER	7:0	Transmit Bu (MAX25432			The num the TX_	BUF_BYTE_x	OUNT[7:0] ne TCPM intend in the given I ² C : Transmit buffe	C transaction					

VBUS_VOLTAGE_L (0x70)

BIT	7	7 6 5 4 3 2 1 0										
Field	VBUS_VOLTAGE[7:0]											
Reset		0x00										
Access Type		Read Only										
Reset A				0x	00							
BITFIELD	BITS		DESCRIPT	ION		[DECODE					
VBUS_VOLT AGE	7:0 V _{BUS} Voltage Measurement from 10-Bit ADC (Lower 8 Bits). Bits [7:0] of the 10-bit V _{BUS} ADC measurement result with 25mV LSB. Valid when POWER_CONTROL.VBUS_VOLT_MON_EN = 0b.											

VBUS_VOLTAGE_H (0x71)

BIT	7	6	5	4	3	3 2		0	
Field	-	_	_	_	SCALE_FACTOR[1:0]		VBUS_VOI	_TAGE[9:8]	
Reset	_	_	-	-	Ob	000	0b	00	
Access Type	_	_	-	_	Read	Read Only		Only	
Reset A	_	_	_	-	Ot	0b00		0b00	
BITFIELD	BITS		DESCRIPT	ION		D	ECODE		
SCALE_FAC TOR	3:2	Scale Factor (Reserved)	r.		00: V _{BU}	00: V _{BUS} measurement not scaled			
VBUS_VOLT AGE	1:0	V _{BUS} Voltag (Upper 2 Bit		nt from 10-Bit A	ADC result w Valid wł	B] of the 10-bit \ ith 25mV LSB. nen R_CONTROL.V			

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VBUS_STOP_DISCHARGE_THRESHOLD_L (0x74)

BIT	7	6 5 4 3 2 1											
Field		VBUS_STOP_DISCH_THRESHOLD[7:0]											
Reset		0x20											
Access Type		Write, Read											
Reset A				0x	20								
BITFIELD	BITS		DESCRIPT	ION		D	ECODE						
VBUS_STOP _DISCH_TH RESHOLD	7:0	V _{BUS} Stop I (Lower 8 bit	Discharge Thre	shold.	threshol 0x000 to 0x01C t Bit 1 an and equ Example 0x000 =	o 0x018: 0.5V o 0x3FF: Value d Bit 0 are alw als to 100mV. es: : 0.5V : 0.8V (default)	e (decimal) x 2 ays ignored. B	-					

VBUS_STOP_DISCHARGE_THRESHOLD_H (0x75)

BIT	7	6	5	4		3	2	1	0	
Field	_	-	-	-		_	-	VBUS_STOF RESHC	P_DISCH_TH DLD[9:8]	
Reset	—	-	-	-		-	-	0b	00	
Access Type	_	-	-	-		_	-	Write, Read		
Reset A	-	-	-	-		-	-	0b	00	
BITFIELD	BITS		DESCRIPT	ION			DECODE			
VBUS_STOP _DISCH_TH RESHOLD	1:0		BUS Stop Discharge Threshold. Bits [9:8] of the 10-bit V _{BUS} stop discharge threshold					narge		

VBUS_VOLTAGE_ALARM_HI_CFG_L (0x76)

This register defines the level triggered alarm high threshold.

The TCPM can write to POWER_CONTROL.VOLT_ALRMS_EN = 0b to enable the voltage alarms or write 1b to disable them. The TCPM writes to VBUS_VOLTAGE_ALARM_HI_CFG to set the high-voltage alarm level.

When V_{OUT} is above this threshold, the MAX25432 will set the alarm high flag ALERT_L.VBUS_ALARM_HI to 1. The MAX25432 will reassert the alarm high flag if the high-voltage condition on V_{OUT} prevails after the TCPM has cleared the flag, unless the TCPM disables the voltage alarms.

BIT	7	7 6 5 4 3 2 1 0								
Field				VBUS_ALARM	1_HI_CFG[7:0]					
Reset				0x	00					
Access Type				Write,	Read					
Reset A				0x	00					

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BITFIELD	BITS	DESCRIPTION	DECODE
VBUS_ALAR M_HI_CFG	7:0	V _{BUS} Alarm High-Voltage Trip Point. (Lower 8 bits)	Bits [7:0] of the 10-bit V_{BUS} alarm high-voltage threshold with 25mV LSB

VBUS_VOLTAGE_ALARM_HI_CFG_H (0x77)

See the VBUS_VOLTAGE_ALARM_HI_CFG_L register description.

BIT	7	6	5	4	3	2	1	0	
Field	_	-	_	-	_	-	VBUS_ALAR :{	M_HI_CFG[9 3]	
Reset	-	-	-	_	_	-	0b	00	
Access Type	-	-	-	-	-	-	Write, Read		
Reset A	-	-	-	-	-	-	0b	00	
BITFIELD	BITS		DESCRIPT	ION		DECODE			
VBUS_ALAR M_HI_CFG	1:0	V _{BUS} Alarm (Upper 2 bit	High Voltage ⁻ s)	Trip Point.	Bits [9:8] of the 10-bit V _{BUS} alarm high-voltage threshold with 25mV LSB				

VBUS_VOLTAGE_ALARM_LO_CFG_L (0x78)

This register defines the level triggered alarm low threshold.

The TCPM can write to POWER_CONTROL.VOLT_ALRMS_EN = 0b to enable the voltage alarms or write 1b to disable them. The TCPM writes to VBUS_VOLTAGE_ALARM_LO_CFG to set the low-voltage alarm level.

When V_{OUT} is below this threshold, the MAX25432 will set the alarm low flag ALERT_H.VBUS_ALARM_LO to 1. The MAX25432 will reassert the alarm low flag if the low-voltage condition on V_{OUT} prevails after the TCPM has cleared the flag, unless the TCPM disables the voltage alarms.

BIT	7	7 6 5 4 3 2 1 0											
Field		VBUS_ALARM_LO_CFG[7:0]											
Reset		0x00											
Access Type		Write, Read											
Reset A				0x	.00								
BITFIELD	BITS		DESCRIPT	ION		0	ECODE						
VBUS_ALAR M_LO_CFG	7:0 V _{BUS} Low-Voltage Trip Point. (Lower 8 bits) Bits [7:0] of the 10-bit V _{BUS} alarm low-voltage threshold with 25mV LSB. When V _{OUT} is below this threshold, The MAX25432 will set ALERT_H.VBUS_ALARM_LO to 1.												

VBUS_VOLTAGE_ALARM_LO_CFG_H (0x79)

See the VBUS_VOLTAGE_ALARM_LO_CFG_L register description.

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BIT	7	6	5	4	3	2	1	0
Field	-	-	-	-	-	_	VBUS_ALAR 9:	M_LO_CFG[8]
Reset	_	-	-	-	-	_	0b00	
Access Type	-	-	-	-	-	_	Write, Read	
Reset A	_	_	-	-	_	_	0b	00
BITFIELD	BITS		DESCRIPT	ION	DECODE			
VBUS_ALAR M_LO_CFG	1:0	V _{BUS} Alarm (Upper 2 bits	Low-Voltage T s)	Frip Point	Bits [9:8] of the 10-bit V_{BUS} alarm low-voltage threshold with 25mV LSB			

VBUS_NONDEFAULT_TARGET_L (0x7A)

Writing to this 16-bit register sets the VBUS Non-Default Target Voltage. VBUS will slew to the new voltage once the SourceVbusNonDefault command is received.

BIT	7	6	5	4	3	2	1	0					
Field		VBUS_NONDEFAULT_TARGET_L[7:0]											
Reset		0x00											
Access Type		Write, Read											
Reset A				0x	00								
BITFIE	LD	BITS		DESCRIPTION									
				V _{BUS} Non-Default Voltage Target.									

		V _{BUS} Non-Default Voltage Target. (Lower 8 bits)
		For VBUS_HIRES = 0 (not recommended), resolution is 10-bit, and LSB = 20.51mV (typ) Valid range is from 0x00A5 (3.3V) to 0x03FF (21.0V).
VBUS_NONDEFAULT_ TARGET_L	7:0	For VBUS_HIRES = 1 (required to pass SPT compliance), resolution is 11-bit, and LSB = 10.255mV (typ) Valid range is from 0x014A (3.3V) to 0x07FF (21.0V).
		For proper operation, do not write values outside of the valid range.
		For VBUS_HIRES = 1, the equation to convert from mV to decimal code is the following:
		uint16_t vbus_code = v/10 - [floor(304*v/100000) - 10]
		Where v is the RDO in mV and vbus_code the resulting output in decimal to write to this register. No floating point required.

VBUS_NONDEFAULT_TARGET_H (0x7B)

See the VBUS_NONDEFAULT_TARGET_L register description.

BIT	7	7 6 5 4 3 2 1 0											
Field		VBUS_NONDEFAULT_TARGET_H[7:0]											
Reset		0x00											
Access Type		Write, Read											
Reset A		0x00											

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BITFIELD	BITS	DESCRIPTION
VBUS_NONDEFAULT_ TARGET_H	7:0	V _{BUS} Non-Default Voltage Target. (Upper 8 bits)

VBUS_CURRENT (0x80)

BIT	7	6	5	4	3	3	2	1	0					
Field		VBUS_CURRENT[7:0]												
Reset		0x00												
Access Type		Read Only												
Reset A		0x00												
BITFIELD	BITS		DESCRIPT	ION			ſ	DECODE						
VBUS_CUR RENT	7:0	V _{BUS} Curre (All MAX254		nt from 7-Bit A[C. N C. N S C P	50mA, typ /BUS_CU /ax regist 50mA = Conversio ourcing V POWER_(o) IRRENT[7] er value = (6.35A n result vali /BUS and	ENT[7:0] x IOU is always 0b. 0x7F = 127. Fu d when the MA VBUS_VOLT_I	ll Scale = 127 X25432 is					

CABLE_COMP_CONTROL (0x81)

BIT	7	6	5	5 4 3 2 1								
Field	_	_		GAIN[5:0]								
Reset	_	_		0x00								
Access Type	-	-		Write, Read								
Reset A	_	_		0x00								
BITFIELD	BITS		DESCRIP	DESCRIPTION DECODE								
GAIN	5:0	Cable Comp	pensation Gair	n.	R _{COMP} compen 5mΩ, so USB Ca calculat applicat Maximu therefor	this register's d $_{LSB} = 8.2m\Omega$ t isation gain (R _C cale for other re- able Compensat e the correct ga ion. Im register settin e, maximum ca = 516.6mΩ.	o get the cable $COMP$) in m Ω for sistance value tion section on in setting base ng = 0x3F = 00	e or R _{CS3} = es. See the how to ed on your d63;				

VBUS_ILIM_SETUP (0x82)

BIT	7	7 6 5 4 3 2 1											
Field		VBUS_ILIM_SET[7:0]											
Reset		0x80											
Access Type		Write, Read											
Reset A				0x	80								

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BITFIELD	BITS	DESCRIPTION	DECODE
VBUS_ILIM_ SET	7:0	V _{BUS} Current Limit Target.	LSB = $25mA$. Default is 3.20A (0x80). Valid range for this register is 1.00A (0x28) to 6.35A (0xFE). For proper operation, do not write values outside the valid range.

BUCK_BOOST_SETUP (0x83)

BIT	7	6	5	4		3	2	1	0		
Field		SLP[2:0]		FSW	FSW[1:0]		SYNC_DIR	SS_SE	EL[1:0]		
Reset		0b011		Ob	10		0b1	0b	00		
Access Type		Write, Read		Write,	Read	d	Write, Read	Write,	Read		
Reset A		0b011		Ob	10		0b1	0b	00		
BITFIELD	BITS		DESCRIPT	ION			DE	ECODE			
SLP	7:5	Slope Comp					000: 100 mV 001: 200 mV 010: 300 mV 011: 400 mV (Default) 100: 500 mV 101: 600 mV 110: 700 mV 111: 800 mV				
FSW	4:3	DC-DC Conv	verter Switchir	ng Frequency.		00: 220kHz 01: 300kHz 10: 400kHz (default) 11: 2.2MHz					
SYNC_DIR	2	SYNC Pin Di	SYNC Pin Direction Selection.				0: Output 1: Input (default)				
SS_SEL	1:0	Spread-Spec	ctrum Selectio	n.		01: ±3% 10: ±6%	abled (default) o spread spectru o spread spectru o spread spectru	um			

WATCHDOG_SETUP (0x84)

BIT	7	6	5	4	3	2	1	0		
Field	_	-	-	_	_	_	WD_TIME	EOUT[1:0]		
Reset	-	-	-	-	-	-	0b	00		
Access Type	_	_	_	-	-	_	Write, Read			
Reset A	-	-	-	-	-	– 0b00		00		
BITFIELD	BITS		DESCRIPT	ION		DECODE				
WD_TIMEO UT	1:0	Watchdog T	imer Timeout \	/alue.	00: 1 second (default) 01: 2 seconds 10: 4 seconds 11: 5 seconds					

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AUTO_SHIELD_SETUP (0x85)

BIT	7	6	5	4	3	2	1	0	
Field	_	-	-	-	_	-	RETRY_	TMR[1:0]	
Reset	_	_	_	_	_	-	0b	11	
Access Type	-	-	-	-	-	– Write, Read		Read	
Reset A	_	_	_	_	_	– – 0b11			
BITFIELD	BITS		DESCRIPT	ION		D	ECODE		
RETRY_TM R	1:0	Retry Timer	Value.		00 = 2.0s 01 = 1.0s 10 = 0.5s 11 = 16ms (default) Determines the length of the RETRY timer after a fault condition				

GENERAL SETUP (0x86)

BIT	7	6	5	4		3	2	1	0	
Field	_	VBUS_HIR ES	_	EXT_BIAS_ SEL		_	CL_EN		DCP_MODE[:0]	
Reset	_	0b1	_	0b0		_	0b1	Ob	000	
Access Type	_	Write, Read	-	Write, Read		_	Write, Read	Write,	, Read	
Reset A	_	0b1	_	0b0		_	0b1	Ob	000	
BITFIELD	BITS		DESCRIPT	ION		DECODE				
VBUS_HIRE S	6	V _{BUS} Non-D	efault Target F	Resolution.		0: 20m∨ 1: 10m∨	(default)			
EXT_BIAS_S EL	4	External BIA	S Selection.			0: Internal (default) 1: External (disables internal BIAS LDO) Note: A valid power source needs to be driving BIAS before writing a '1' to this bit. Failure to do so will result in an I ² C register reset.				
CL_EN	2	V _{BUS} Currer	nt-Limit (CL) R	(CL) Regulation Enable. 0: V _{BUS} current-limit regulation disabled, the MAX25432 will enwithen V _{BUS} current is above the VBUS target. (CL) Regulation Enable. When enabled, the MAX25432 will enwithen V _{BUS} current is above the VBUS target. (CL) Regulation Enable. When disabled, the MAX25432 will not mode when V _{BUS} current is above the VBUS target. (CL) Regulation Enable. When disabled, the MAX25432 will not mode when V _{BUS} current is above the VBUS target. (CL) Regulation Enable. When disabled, the MAX25432 will not mode when V _{BUS} current is above the VBUS target. (CL) Regulation Enable. When disabled, the MAX25432 will not mode when V _{BUS} current is above the VBUS target. (CL) Regulation Enable. When disabled, the MAX25432 will not mode when V _{BUS} current is above the VBUS_ILIM_SET target.				ed (default) hter CL mode S_ILIM_SET ot enter CL e certain faults.		
AUTO_CDP_ DCP_MODE	1:0	BC1.2 Charg	ge Detection M	lode Selection.		01: Auto 10: Auto	I-Speed Pass-T D-CDP D-DCP / Apple 2 D-DCP / Apple 2	2.4A	llt)	

IN_THRESH (0x87)

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BIT	7	6	5	4	3	3 2 1					
Field	_	_	-	-		IN_UV_THRESH[3:0]					
Reset	_	_	-	-		0x0					
Access Type	_	_	_	_	Write, Read						
Reset A	-	-	-	-	0x0						
BITFIELD	BITS		DESCRIPT	ION		D	ECODE				
IN_UV_THR ESH	3:0	Input Supply	γ (V _{IN}) Undervo	oltage Threshol	0x1 : 4. 0x2 : 5. 0x3 : 5. 0x4 : 6. 0x5: 6. 0x6: 6. 0x7: 7. 0x8: 7. 0x9: 8. 0xA: 8 0xA: 8 0xB : R 0xC : F 0xD: F 0xE: R	3V 7V 1V 5V 9V 3V 7V					

VCONN_THRESH (0x88)

BIT	7	6	5	4	3	2	1	0	
Field		VCONN_OC	PL_SEL[3:0]		_	VCONN	_IN_UV_THRE	SH[2:0]	
Reset		0>	6		_		0x3		
Access Type		Write,	Read		_	Write, Read			
Reset A		0>	:6		-		0x3		
BITFIELD	BITS		DESCRIPT	ION		D	ECODE		
VCONN_OC PL_SEL	7:4	4 V _{CONN} Overcurrent Threshold Low.				0x0: 50mA 0x1: 100mA 0x2: 150mA 0x3: 200mA 0x4: 250mA 0x5: 300mA 0x6: 350mA (default) 0x7: 400mA 0x8: 450mA 0x9: 500mA			
VCONN_IN_ UV_THRESH	2:0	V _{CONN} Und	ervoltage Thre	shold.	0xA - 0xF: Reserved 0x0: 2.75V 0x1: 2.85V 0x2: 2.95V 0x3: 3.05V (default) 0x4: 4.35V 0x5: 4.45V 0x6: 4.55V 0x7: 4.65V				

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VBUS_THRESH (0x89)

BIT	7	6	5	4	3	2	1	0		
Field	_	VBUS	S_OV_THRES	H[2:0]	-	VBU	S_UV_THRESI	H[2:0]		
Reset	_		0x3		-	0x3				
Access Type	_		Write, Read		-	Write, Read				
Reset A	_		0x3		-		0x3			
BITFIELD	BITS		DESCRIPT	ION		D	ECODE			
VBUS_OV_T HRESH	6:4	V _{BUS} Overv	oltage Threshc	old.	0x1: +1 0x2: +1 0x3: +1 0x4: +1 0x5: +1 0x6: +1	0x0: +8.75% 0x1: +10.00% 0x2: +11.25% 0x3: +12.50% (default) 0x4: +13.75% 0x5: +15.00% 0x6: +16.25% 0x7: +17.50%				
VBUS_UV_T HRESH	2:0	V _{BUS} Under	voltage Thresh	nold.	0x0: -8.75% 0x1: -10.00% 0x2: -11.25% 0x3: -12.50% (default) 0x4: -13.75% 0x5: -15.00% 0x6: -16.25% 0x7: -17.50%					

VENDOR_STATUS_MASK (0x8A)

BIT	7	6	5	4		3	2	1	0	
Field	SHIELDING _MASK	_	-	-		_	-	-	OMF_TRAN S_MASK	
Reset	0b1	_					_	-	0b1	
Access Type	Write, Read	_					-	-	Write, Read	
Reset A	0b1	-	-	-		-	-	-	0b1	
BITFIELD	BITS		DESCRIPT	ION		DECODE				
SHIELDING_ MASK	7	Shielding Ma	Shielding Mask.				0: Not included in VNDR_ALRT 1: Included in VNDR_ALRT (default)			
OMF_TRAN S_MASK	0	Operating M	ode Flag (OMI	F) Transition Ma	ask.	 O: Not included in VNDR_ALRT 1: Included in VNDR_ALRT (default) 				

VENDOR_STATUS (0x8B)

BIT	7	6	5	4	3	2	1	0
Field	SHIELDING	_	-	-	-	-	-	OMF_TRAN S
Reset	0b0	_	_	-	_	-	-	0b0
Access Type	Read Only	_	-	-	-	-	-	Write 1 to Clear, Read
Reset A	0b0	-	-	_	-	-	-	0b0

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BITFIELD	BITS	DESCRIPTION	DECODE
SHIELDING	7	Shielding Status.	0b: Normal operation 1b: Fault condition detected
OMF_TRAN S	0	Operating Mode Flag (OMF) Transition.	 0: No change in CV/CL operating mode 1: A change in CV/CL operating mode has occurred Indicates a change in the Constant Voltage/Current Limit Operating mode. Any transition between modes will trigger a VNDR_ALRT if this bit is unmasked, but does not trigger a fault. Only valid for CL_EN = 1. Ignore for CL_EN = 0.

AUTO_SHIELD_STATUS_0 (0x8C)

BIT	7	6	5	4		3	2	1	0		
Field	TSHDN	VCONN_R EV_OV				NN_IN _UV	IN_OC	VDD_USB_ UV	VBUS_UV		
Reset	0b0	0b0	0b0	0b0		0b0	0b0	0b0	0b0		
Access Type	Write 1 to Clear, Read	Write 1 to Clear, Read				rite 1 to ar, Read	Write 1 to Clear, Read	Write 1 to Clear, Read	Write 1 to Clear, Read		
Reset A	0b0	0b0	0b0 0b0 0b0				0b0 0b0 0b0 0b0				
BITFIELD	BITS		DESCRIPT	ION			D	ECODE			
TSHDN	7	Thermal Shu	Thermal Shutdown Fault.				0: No fault 1: Fault detected				
VCONN_RE V_OV	6	V _{CONN} Rev	V _{CONN} Reverse OV Fault.				ult detected				
VCONN_OC PL	5	V _{CONN} OCF	P Low Fault.			0: No fault 1: Fault detected					
SHLD_EVEN T	4	Shield Short	-to-Battery Eve	ent Fault.		0: No fa 1: Fault	ult detected				
VCONN_IN_ UV	3	V _{CONN} Und	ervoltage Fault	i.		0: No fa 1: Fault	ult detected				
IN_OC	2	Buck-Boost	Buck-Boost Input Overcurrent Fault.				ult detected				
VDD_USB_U V	1	V _{DD_USB} U	ndervoltage Fa	ult.		0: No fa 1: Fault	ult detected				
VBUS_UV	0	V _{BUS} Under	voltage Fault.			0: No fa 1: Fault	ult detected				

AUTO_SHIELD_STATUS_1 (0x8D)

BIT	7	6	5	4	3	2	1	0
Field	CL_CV	CV_ILIM	VBUS_RNA	VBUS_SHT _GND	IN_UV	DATA_OV	HVCC_OV	VDD_USB_ OV
Reset	0b0	0b0	0b0	0b0	0b0	0b0	0b0	0b0
Access Type	Read Only	Write 1 to Clear, Read						
Reset A	0b0	0b0	0b0	0b0	0b0	0b0	0b0	0b0

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BITFIELD	BITS	DESCRIPTION	DECODE
			0: Constant Voltage (CV) mode 1: Current-Limit (CL) mode
CL_CV	7	Operating Mode Status Bit.	Only valid when CL_EN = 1. Ignore when CL_EN = 0. This bit is read-only and non-latched. Read OMF_TRANS for the latched status. Does not trigger a fault or VNDR_ALRT.
CV_ILIM	6	V _{BUS} CV I _{LIM} Fault.	0: No fault 1: Fault detected 0 to 1 only. Only valid when CL_EN = 0. Ignore when CL_EN = 1.
VBUS_RNA	5	V _{BUS} Runaway Fault.	0: No fault 1: Fault detected
VBUS_SHT_ GND	4	V _{BUS} STG Fault.	0: No fault 1: Fault detected
IN_UV	3	Input UV Fault.	0: No fault 1: Fault detected
DATA_OV	2	HVD Overvoltage Fault.	0: No fault 1: Fault detected
HVCC_OV	1	HVCC Overvoltage Fault.	0: No fault 1: Fault detected
VDD_USB_O V	0	V _{DD_USB} Overvoltage Fault.	0: No fault 1: Fault detected

Applications Information

TCPC Functionality (MAX25432B only)

The MAX25432B devices incorporate a USB-IF compliant CC PHY capable of encoding/decoding BMC messages. CRC is automatically appended to all outgoing messages and checked on all incoming messages.

The MAX25432B's TCPC hardware permits the simple integration with an external MCU, running a TCPM stack, to create a complete USB Type-C PD source.

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Figure 29. TCPM to TCPC Interface through I²C

Receiving USB PD Messages

The MAX25432B TCPC logic facilitates the reception and decoding of USB PD messages, by incorporating a Type-C PHY, and I²C-accessible registers. The TCPM responds to interrupts due to changes in status and then read from or write to the appropriate register. The generation and decoding of PD CRC bits is automatically handled by the TCPC logic. Upon receiving a valid USB PD message, the MAX25432 TCPC logic asserts the ALERT pin low to indicate a change in status. Changes in status are latched in the ALERT_L and ALERT_H registers located at addresses 0x10 and 0x11 respectively. The TCPM must read the ALERT_L and ALERT_H registers to determine the type of status change.

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0x10:	ALERT L
0x11:	ALERT H
0x1D:	HVCC STATUS
0x1E:	POWER STATUS
0x1F:	FAULT STATUS
0x20:	EXTENDED STATUS
0x21:	ALERT EXTENDED
0x70:	VBUS VOLTAGE L
0x71:	VBUS VOLTAGE H

Figure 30. Status Registers

For example, the TCPM detects that the MAX25432 ALERT pin has been asserted low. The TCPM would then perform an I²C Read Word transaction on the ALERT_L and ALERT_H registers.

<u>I²C Read Word from Register 0x10:</u>

0x04, 0x00

Table 10. Reading the RX SOP MESSAGE

REGISTER	ADDRESS	D7	D6	D5	D4	D3	D2	D1	D0
ALERT_L	0x10	VBUS V ALARM HIGH	TX SOP MESSAGE SUCCESS	TX SOP MESSAGE DISCARD	TX SOP MESSAGE FAIL	RX HARD RESET	RX SOP MESSAGE	POWER STATUS	HVCC STATUS
		0	0	0	0	0	1	0	0
ALERT_H	0x11	VENDOR ALERT	ALERT EXTENDED	EXTEND STATUS	BEGIN SOP MESSAGE STATUS	VBUS SINK DISCHAR DETECT	RX BUFFER OVRFL	FAULT STATUS	VBUS VOLT ALARM LOW
		0	0	0	0	0	0	0	0

Bit D2 in ALERT_L is set, indicating that a message has been received in the RX BUFFER.

Next, the message must be extracted from the MAX25432 RX_BUFFER and decoded.

The message content is stored in the RX_BUFFER, 32 contiguous bytes starting at address 0x30. The RX_BUFFER can be read with an I²C Read Block transaction, or it can be read with several I²C Read Byte transactions. The buffer address pointer will increment automatically after each byte is read.

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Figure 31. Receive Buffer

Continuing with the example, the message data is extracted from the RX_BUFFER.

I²C Read Block from Registers 0x30 – 0x4F:

0x03, 0x00, 0x47, 0x0C, 0x16, 0x87, 0x57, 0xF7, 0xEF, 0xD6,

0x2C, 0x40, 0x26, 0x28, 0x03, 0x9B, 0x00, 0x00, 0x00, 0x00,

0x44, 0xD3, 0x15, 0xEA, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00,

0x00, 0x00

The first byte indicates that there are three bytes significant to this message. The second byte is the SOP message type, the third and fourth bytes form the message header 0x0C47.

Note: The TCPC does not erase previous information from the buffer and therefore the TCPM must parse the relevant bytes to decode the message.

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Figure 32. Message Header - "Get_Source_cap"

Decoding the header word indicates the PD sink is requesting that the source capabilities be sent.

Now that the message has been decoded, the ALERT pin interrupt can be cleared, so that the MAX25432B TCPM's state machine can continue to service PD messages.

Table 11. Writing 1 to Clear the RX SOP MESSAGE

REGISTER	ADDRESS	D7	D6	D5	D4	D3	D2	D1	D0

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Table 11. Writing 1 to Clear the RX SOP MESSAGE (continued)

					•				
ALERT_L	0x10	VBUS V ALARM HIGH	TX SOP MESSAGE SUCCESS	TX SOP MESSAGE DISCARD	TX SOP MESSAGE FAIL	RX HARD RESET	RX SOP MESSAGE	POWER STATUS	HVCC STATUS
		0	0	0	0	0	1	0	0
ALERT_H	0x11	VENDOR ALERT	ALERT EXTENDED	EXTEND STATUS	BEGIN SOP MESSAGE STATUS	VBUS SINK DISCHAR DETECT	RX BUFFER OVRFL	FAULT STATUS	VBUS VOLT ALARM LOW
		0	0	0	0	0	0	0	0

<u>I²C Write Word to Register 0x10:</u>

0x04, 0x00

The TCPM clears the ALERT_L register by writing a logic '1' to bit D2. ALERT returns high.

Sending USB PD Messages

The MAX25432B TCPC logic simplifies the TCPM code required to transmit USB PD messages. Sending PD messages is a two-stage process: employing the TX_BUFFER (31 contiguous byte-wide registers) and the TRANSMIT register.

First, the TX_BUFFER is loaded with an encoded PD message (Control or Data), and then a command byte is written the TRANSMIT register (0x50) to trigger the MAX25432 TCPC transmit process.



Figure 33. Transmit Buffer

The PD message contents must be written to TX_BUFFER in a single I²C transaction, therefore an I²C Write Block transaction (see the l^2C Interface section) should be used, or the TCPC logic will generate an I²C error after the TRANSMIT byte is written to and the message will not be sent.

To illustrate the proper TCPM coding approach, we will continue with the MAX25432B's response to the PD sink's Get Source Capabilities example.

The TCPM needs to encode and load the requested Source Capabilities message, Header plus Data Objects, into the TX BUFFER.

Number of bytes:	0x12 (18 bytes)
Message Header:	0x4361 (Source Capabilities with 4 data objects) = 2 bytes
Data Object 1:	0x000190F0 (5.00V at 2.4A) = 4 bytes

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Data Object 2:	0x0002D12C (9.00V at 3A) = 4 bytes
Data Object 3:	0x0004B12C (15.00V at 3A) = 4 bytes
Data Object 4:	0x0006412C (20.00V at 3A) = 4 bytes
Figure 34 and Figure 35 s	how the corresponding Message Header and Data Object 1 decoding.

EXTENDED 1 = EXT 0 = CTL/DATA NUMBER OF DATA OBJECTS = = = 000 0 001 1 2 3 4 010 011 = 100 = 101 = 5 110 = = 6 7 111 MESSAGE ID 000 = 0 <mark>001</mark> 010 = 1 2 = 3 011 = 100 = 4 101 = 5 110 = 6 111 = 7 PORT POWER ROLE 1 = SOURCE 0 = SINK D15 D14 D13 D12 D10 0 0 0 1 0 0 1 1 0x43 SPECIFICATION REVISION 00 = **REVISION 1.0** 01 = REVISION 10 **REVISION 3.0** = 11 = RESERVED PORT DATA ROLE 1 = DFP UFP 0 = MESSAGE TYPE 00000 Reserved = Source_Capabilities 00001 00010 = Request Request BIST Sink_Capabilities Battery_Status 00011 00100 = = 00101 = 00110 = Alert Get_Country_Info 00111 = Enter_USB 01000 = 01111 Vendor_Defined = D4 D7 0 1 1 0 0 0 0 1 0x61

Figure 34. Message Header - "Source_Capabilities"

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Figure 35. Data Object 1 – 5V/2.4A Fixed PDO

The assembled message packet is then loaded into the TX_BUFFER.

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Figure 36. Transmit Buffer - "Source_Capabilities"

I²C Write Block to TX BUFFER 0x51:

0x12, 0x61, 0x43, 0xF0, 0x90, 0x01, 0x00, 0x2C, 0xD1, 0x02,

0x00, 0x2C, 0xB1, 0x04, 0x00, 0x2C, 0x41, 0x06, 0x00

Finally, the message is released to the MAX25432B's TCPC logic by writing 0x30 to the TRANSMIT register. Then the entire packet will be appended with the proper CRC, BMC encoded, and transmitted through the corresponding HVCC pin.

I²C Write Byte to TRANSMIT 0x50:

0x30

The MAX25432B's TCPC logic will now assert $\overline{\text{ALERT}}$ low and update the ALERT_L register with the message status. I²C Read Word from Register 0x10:

0x40, 0x00

Table 12. Writing 1 to Clear the TX SOP MESSAGE SUCCESS

REGISTERADDRESSD7D6D5D4D3D2	D1	D0
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Table 12. Writing 1 to Clear the TX SOP MESSAGE SUCCESS (continued)

	-								
ALERT_L	0x10	VBUS V ALARM HIGH	TX SOP MESSAGE SUCCESS	TX SOP MESSAGE DISCARD	TX SOP MESSAGE FAIL	RX HARD RESET	RX SOP MESSAGE	POWER STATUS	HVCC STATUS
		0	1	0	0	0	0	0	0
ALERT_H	0x11	VENDOR ALERT	ALERT EXTENDED	EXTEND STATUS	BEGIN SOP MESSAGE STATUS	VBUS SINK DISCHAR DETECT	RX BUFFER OVRFL	FAULT STATUS	VBUS VOLT ALARM LOW
		0	0	0	0	0	0	0	0

The TCPM reads the ALERT_L and ALERT_H registers and sees that bit D6 is set in ALERT_L, indicating that the previously sent message was successful.

Lastly, the TX_SOP_MESSAGE_SUCCESS bit in the ALERT_L register needs to be cleared by the TCPM. This is done by writing logic '1' to bit D6.

I²<u>C Write Word to Register 0x10:</u>

0x40, 0x00

Additional Resources

Contact Analog Devices for more information on how to program the TCPM.

Buck-Boost Component Selection

Inductor Selection

Choice of inductor is a compromise between the size, efficiency, control bandwidth, and stability of the converter. For a buck-boost application, selecting the right value of inductor becomes even more critical due to the presence of a right-half-plane (RHP) zero in boost and buck-boost mode. A larger inductance value reduces RMS current loss in MOSFETs and core/winding losses in the inductor. On the other hand, it slows the control loop and reduces the frequency of the RHP zero that can cause stability concerns.

Start the inductor selection based on the inductor current ripple as a percentage of the maximum inductor current in buck mode using the following equations. Choose the highest inductance between L_{BUCK} and L_{BOOST} . Minimum duty cycle in buck or boost will yield the highest inductor current ripple.

$$L_{\text{BUCK}} > \frac{\left(V_{\text{IN}_\text{MAX}} - V_{\text{OUT}_\text{MIN}}\right) \cdot D_{\text{BUCK}_\text{MIN}}}{f_{\text{SW}} \cdot \Delta I_{L}} (\text{eq. 1})$$

$$L_{\text{BOOST}} > \frac{V_{\text{IN}_\text{MIN}} \cdot D_{\text{BOOST}_\text{MAX}}}{f_{\text{SW}} \cdot \Delta I_{L}} (\text{eq. 2})$$

$$\Delta I_{L} = I_{\text{OUT}_\text{MAX}} \cdot \text{LIR} (\text{eq. 3})$$

$$D_{\text{BUCK}_\text{MIN}} = \frac{V_{\text{OUT}_\text{MIN}}}{V_{\text{IN}_\text{MAX}} \cdot \eta_{\text{BUCK}}} (\text{eq. 4})$$

$$D_{\text{BOOST}_\text{MAX}} = 1 - \frac{V_{\text{IN}_\text{MIN}} \cdot \eta_{\text{BOOST}}}{V_{\text{OUT}_\text{MAX}}} (\text{eq. 5})$$

 L_{BUCK} , L_{BOOST} : minimum inductance needed in buck mode and boost mode, respectively, in H. f_{SW}: switching frequency in Hz.

VIN MIN, VIN MAX: minimum and maximum voltage seen at the power stage input, respectively.

IOUT_MAX: maximum DC output current supported in the application.

LIR: desired peak-to-peak inductor current ripple ratio. Ratio of $\Delta I_L/I_{OUT}$ MAX.

D_{BUCK MIN}, D_{BOOST MAX}: minimum and maximum duty cycle in Buck and Boost mode, respectively.

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η_{BUCK}, η_{BOOST}: efficiency at maximum load in buck mode and boost mode, respectively.

V_{OUT MIN}: lowest output voltage seen in the application. For fixed PDO applications, use 5.15V (vSafe5V).

V_{OUT MAX}: highest output voltage seen in the application. 5.15V, 9V, 15V, or 20V for fixed PDOs applications.

Select the final value of inductance considering the ripple in both regions of operation, inductor derating and RHP zero. Once the final value of inductance is selected, calculate the peak inductor current and choose an inductor with saturation current approximately 20% higher than the peak inductor current. Low DCR helps achieve higher efficiency by reducing inductor conduction loss during high output power with low input voltage.

Example:

 $\begin{array}{l} \mathsf{P}_{\mathsf{OUT_MAX}} = 100\mathsf{W}; \ \mathsf{V}_{\mathsf{IN_MIN}} = 6\mathsf{V}; \ \mathsf{V}_{\mathsf{IN_MAX}} = 18\mathsf{V}; \ \mathsf{V}_{\mathsf{OUT_MIN}} = 5.15\mathsf{V}; \ \mathsf{V}_{\mathsf{OUT_MAX}} = 20\mathsf{V}; \ \mathsf{f}_{\mathsf{SW}} = 400\mathsf{kHz}; \ \mathsf{I}_{\mathsf{OUT_MAX}} = 5\mathsf{A}; \ \mathsf{\eta}_{\mathsf{BUCK}} = \mathsf{\eta}_{\mathsf{BOOST}} = 95\%; \ \mathsf{LIR} \ \mathsf{is chosen to be 55\% to keep the inductor small.} \end{array}$

For this example, $L_{BUCK} > 3.5\mu$ H and $L_{BOOST} > 3.9\mu$ H. Therefore, an inductor with a value of 4.7 μ H will be selected.

Inductor saturation current must be considered when choosing the inductor.

The high input current seen during low V_{IN}/high P_{OUT} conditions has an impact on the current saturation rating of the inductor and therefore its size. The MAX25432 advantage is its flexibility with regards to output power due to its scalable peak input current limit. When selecting the input current sense resistor value (R_{CS1}), consider the output power, inductor saturation current, minimum input voltage seen at the power stage and the minimum V_{BUS} voltage specification to meet at the user port. When the peak input current reaches the I_{OC1} threshold defined by R_{CS1}, the controller will automatically enter cycle-by-cycle input current limit which may cause V_{BUS} to droop below the minimum specification at the port. Cable compensation will not increase V_{BUS} in this condition as the input current (and therefore the input power) is limited.

Once the input sense resistor value is selected, the inductor saturation current rating (I_{SAT}) value can be chosen. The I_{SAT} value must be higher than the input peak I_{LIM} threshold by some safe margin to avoid saturating the core.

 $I_{SAT} > I_{OC1_MAX}$ $I_{a} = > \frac{V_{OC1_MAX}}{V_{OC1_MAX}}$

$$I_{\text{SAT}} > \frac{100 \text{ I}_{\text{I}} \text{ I}_{\text{SAT}}}{R_{\text{CS1}}}$$

Example:

 R_{CS1} = 3m Ω and V_{OC1_MAX} = 60mV yields I_{OC1_MAX} = 20A, therefore:

I_{SAT} > 20A

Input Capacitor Design

The input capacitor reduces peak currents drawn from the power source and minimizes noise and voltage ripple on the input caused by the circuit switching. In buck mode, input current is discontinuous with maximum ripple. The RMS current can be calculated using the following equation:

$$I_{\rm RMS} = \frac{I_{\rm OUT}_{\rm MAX} \cdot \sqrt{V_{\rm OUT} \cdot (V_{\rm IN} - V_{\rm OUT})}}{V_{\rm IN}} \text{ (eq. 6)}$$

The maximum input RMS current occurs at $V_{IN} = 2 \times V_{OUT}$. Substituting V_{IN} previously, the equation then becomes:

$$I_{\text{RMS}_{\text{MAX}}} = \frac{I_{\text{OUT}_{\text{MAX}}}}{2} (\text{eq. 7})$$

The input voltage ripple in buck mode is given by:

$$\Delta V_{IN} = \frac{\left(1 - D_{BUCK}\right) \cdot I_{OUT} \cdot D_{BUCK}}{f_{SW} \cdot C_{IN}} \text{ (eq. 8)}$$

It is recommended to keep the input voltage ripple below 1% of the input voltage to limit noise that could be conducted through the battery harness.

Maximum input voltage ripple occurs in buck mode at a duty cycle of 50% and at maximum output current. Select a higher value for the final total capacitance to account for DC bias and tolerance derating.

Use the following equation to determine the input capacitance needed to meet the input voltage ripple requirement:

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 $C_{\text{IN}} > \frac{0.25 \cdot I_{\text{OUT}_{\text{MAX}}}}{f_{\text{SW}} \cdot \Delta V_{\text{IN}_{\text{MAX}}} \cdot \left(1 - \left(C_{\text{IN}_{\text{TOL}}} + C_{\text{IN}_{\text{DCBIAS}}}\right)\right)} \text{ (eq. 9)}$

Example:

 $f_{SW} = 400 \text{kHz}$; $I_{OUT_MAX} = 5\text{A}$; $D_{BUCK} = 0.5$; $C_{IN_TOL} = 10\%$; $C_{IN_DCBIAS} = 10\%$; $\Delta V_{IN_MAX} = 12\text{V} \times 0.01 = 0.12\text{V}$ For this example, $C_{IN} > 27\mu\text{F}$.

Select the input capacitor that can handle the given RMS current at the operating frequency. Ceramic capacitors come with extremely low ESR and help reduce the peak-to-peak ripple voltage at the input. Good quality electrolytic capacitors are also available with low ESR, which give higher capacitance at low cost.

Electrolytic (bulk) input capacitors help reduce input voltage droop during large load transients. ESR in bulk capacitors help dampen line transients. A good combination of electrolytic and ceramic capacitors can help achieve the target specifications and minimize cost.

Place a high-frequency decoupling ceramic capacitor to filter high di/dt and reduce EMI caused by Q_{t1} turn on. Choose a small package, such as 0402, with low ESL.

Choose a voltage rating of 50V for applications where a 40V load dump can be seen at the input.

Output Capacitor Design

Output capacitance is selected to satisfy the output load-transient requirements. During a load step, the output current changes almost instantaneously whereas the inductor is slow to react. During this transition time, the load-charge requirements are supplied by the output capacitor, which causes an undershoot/overshoot in the output voltage. Select a capacitor based on the maximum allowable overshoot/undershoot on the output voltage. Typically, the worst-case response from a load transient is in Boost mode. Use the following equations to contain the undershoot within the given specifications in Boost mode:

$$C_{\text{OUT}} \ge \frac{L \cdot \Delta I_{\text{L}} \text{STEP}^{2}}{2 \cdot V_{\text{IN}} \text{ MIN} \cdot D_{\text{BOOST}} \text{ MAX} \cdot V_{\text{UNDER}}} + \frac{\left(\Delta I_{\text{L}} \text{STEP} \cdot t_{\text{DELAY}}\right)}{V_{\text{UNDER}}} (\text{eq. 10})$$

where t_{DELAY} = time delay for the next control pulse after a load step. For fixed-PWM mode, t_{DELAY} is the turn-off time in buck/boost mode.

Select the output capacitance to handle load transients in deep boost mode. t_{DELAY} is the delay for the PWM modulator to react after a load step. In PWM mode, the worst-case delay would be (1 - D) x t_{SW} when the load step occurs right after a turn-on cycle. With the previous example values:

$C_{OUT} \ge 120 \mu F$

Once the output capacitance is selected, the output voltage undershoot/overshoot can be calculated for buck region of operation using the following equations:

$$V_{\text{UNDER}_BUCK} = \frac{L \cdot \Delta I_{\text{L}_\text{STEP}}^2}{2 \cdot (V_{\text{IN}} - V_{\text{OUT}}) \cdot D_{\text{BUCK}_MAX} \cdot C_{\text{OUT}}} \text{ (eq. 11)}$$
$$V_{\text{OVER}_BUCK} = \frac{L \cdot \Delta I_{\text{L}_\text{STEP}}^2}{2 \cdot V_{\text{OUT}} \cdot C_{\text{OUT}}} \text{ (eq. 12)}$$

Select C_{OUT} to ensure low output voltage undershoot and ripple during a USB PD load transient at low V_{IN}. V_{BUS} load transients requirements may vary depending on the application. Contact Analog Devices for assistance with optimizing C_{OUT} for your application.

Output Voltage Setting

 V_{BUS} target is selected using the VBUS_NONDEFAULT_TARGET_L[7:0] and VBUS_NONDEFAULT_TARGET_H[7:0] register. When VBUS_HIRES = 0b then the LSB is 20.51mV (typ). When VBUS_HIRES = 1, then the LSB is 10.255mV (typ).

Once both registers are written, use the COMMAND[7:0] register to enable the buck-boost and request a new target V_{OUT} voltage. See the <u>Enabling/Disabling V_{BUS}</u> section and <u>Register Map</u> for details.

Example:

To program V_{OUT} at 15V with VBUS_HIRES = 0b then write VBUS_NONDEFAULT_TARGET_L[7..0]=EEh and VBUS_NONDEFAULT_TARGET_H[7..0]=02h.

Current-Sense Resistors Selection

The MAX25432 devices use three external current-sense resistors to provide current information for several functions. The input current-sense resistor R_{CS1} is used for inductor current control and setting the input cycle-by-cycle peak current limit. The output current-sense resistor R_{CS2} is used for output runaway and negative peak current limit. The R_{CS3} current-sense resistor is used for output DC current-sense and cable compensation.

Select an input current-sense resistor based on the maximum input current for the application (typically at maximum output power and minimum input voltage). The voltage across R_{CS1} for input current-limit is 50mV (typ). Calculate the peak input current using this equation:

$$I_{\text{IN}_{\text{PEAK}}} = \frac{V_{\text{OUT}_{\text{MAX}}} I_{\text{OUT}_{\text{MAX}}}}{V_{\text{IN}_{\text{MIN}}}} + \frac{V_{\text{IN}_{\text{MIN}}} (1 - \frac{V_{\text{IN}_{\text{MIN}}}}{V_{\text{OUT}_{\text{MAX}}}})}{2 \cdot L \cdot f_{\text{SW}}} (\text{eq. 13})$$

Calculate the input current-sense resistor (R_{CS1}) by setting the peak current limit slightly higher than the peak input current (I_{IN} PEAK) calculated in equation 13.

It is highly recommended that designs use an R_{CS3} resistor with an exact value of $5m\Omega$.

Slope Compensation

Slope compensation is required for current-mode control due to its inherent instability. A properly designed current-mode control with slope compensation removes the instability and provides noise immunity from current-sense signals. The MAX25432 offers a simple way to set the slope compensation peak ramp voltage (V_{SLOPE_PK}) by programming the SLP[2:0] register through I²C from 100mV to 800mV in 100mV increments. Once V_{SLOPE_PK} is calculated, select the next higher value available in the SLP[2:0] register.

The steps to calculate V_{SLOPE} PK are the following.

Design the slope compensation to lower the quality factor of the double pole at half the switching frequency of currentmode control. Choose the quality factor to be at or below 0.6 for the entire range of input and output voltages. The quality factor is given by the following equation:

$$Q_P = \frac{1}{\pi \cdot (m_C \cdot D' - 0.5)}$$
 (eq. 14)

where m_C, the compensation ramp factor, is given by:

$$m_C = 1 + \frac{S_e}{S_n}$$
 (eq. 15)

The compensation ramp slope, S_e, is:

$$S_e = \frac{V_{SLOPE}_{PK}}{T_{SW}} = V_{SLOPE}_{PK} * f_{SW} \text{ (eq. 16)}$$

And the inductor rising slope, Sn, is:

$$S_n = \frac{(V_{\text{IN}} - V_{\text{OUT}}) \cdot G_{\text{CS}}}{L} \text{ (eq. 17)}$$

 S_e = Slope of the external ramp, in V/s.

 S_n = Rising slope (upslope) of inductor current, in V/s.

V_{SLOPE PK} = The slope compensation peak ramp voltage for a theoretical 100% duty cycle, in V.

f_{SW} = switching frequency, in Hz

D' = 1 - duty cycle

Example:

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Due to the several possible output voltages, an optimum SLP[2:0] setting needs to be calculated for each fixed output voltage supported. Verify Qp does not exceed the design target across the input voltage range. From the previous example, and with a maximum Qp target of 0.6, we can calculate the optimum SLP[2:0] for V_{OUT} = 5.15V.

Using equation 14, Qp = 0.4 yields $m_c = 1.82$. With equation 17, we find $S_n = 1.89.105$ V/s. Then, equation 15 gives us Se = 1.54.105V/s. Finally, rearranging equation 16, we find V_{SLOPE PK} = 385mV.

Set SLP[2:0] to achieve the desired peak-to-peak voltage for the external compensation as calculated above.

Select Set SLP[2:0] = 0b011 for V_{SLOPE} PK = 400mV.

Repeat the steps above for each output voltage supported.

Voltage Loop Compensation Design (V_{COMP})

The MAX25432 uses an internal transconductance error amplifier in the voltage loop with its output terminal available to the user for external frequency compensation, as shown in <u>Figure 37</u>.



Figure 37. External Voltage Compensation Network (V_{COMP})

The controller uses a peak current-mode-controlled architecture to regulate the output voltage by forcing the required current through the external inductor. The external current-sense resistor senses the inductor current information. The current-mode control splits the double pole in the feedback loop caused by the inductor and output capacitor into two single poles. One of the poles is moved to a high frequency outside of the typical bandwidth of the converter, making it a single-pole system. This makes compensation easy with only Type II compensation network. In boost mode, an extra right-half plane (RHP) zero is introduced by the power stage to add extra phase delay in the control loop. To avoid any significant effect of the RHP zero on the converter stability, the compensation is designed such that the bandwidth is approximately 1/4 of the worst-case RHP zero frequency.

The design of external compensation requires some iterations to reach an optimized design. Care must be taken while designing the compensation for working in 'deep' boost mode and heavy load (V_{IN} MIN as RHP zero frequency reduces.

A convenient way to design compensation for both buck and boost modes is to design the compensation at minimum input voltage and heavy load (deep boost mode). At this operating point, RHP zero is at its lowest frequency. Design the compensation to achieve a bandwidth close to 1/4 of the RHP zero frequency in deep boost mode. Verify the gain and phase margin with the designed compensation in buck mode. The closed-loop gain of the converter is a combination of the power-stage gain of the converter and error-amplifier gain.

The following equation demonstrates the current-mode-controlled boost power-stage transfer function:

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$$\frac{1}{V_{O}} = \frac{R_{L} \cdot (1 - D)}{2 \cdot G_{CS}} \cdot \frac{\left(1 + \frac{S}{\omega_{ESR}}\right) \left(1 - \frac{S}{\omega_{RHP}}\right)}{\left(1 + \frac{S}{\omega_{P_{BOOST}}}\right) \cdot F_{H}(s)}$$
(eq. 18)

where:

G_{CS}: current-sense gain = 23.R_{CS1}

 $\omega_{P_BOOST} = \frac{2}{R_L \cdot C_{OUT}} (eq. 19) \ \omega_{ESR} = \frac{1}{R_C \cdot C_{OUT}} (eq. 20) \ \omega_{RHP} = \frac{R_L \cdot (1-D)^2}{L} (eq. 21) \ F_H(S) = 1 + \frac{S}{\omega_N \cdot Q_P} + \left(\frac{S}{\omega_N}\right)^2 (eq. 22) \ Q_P = \frac{1}{\pi \cdot (m_C \cdot D^+ - 0.5)} (eq. 23) \ \omega_N = \frac{\pi}{T_{SW}} (eq. 24)$ Error-amplifier transfer function:

$$H_{\text{EA}}(S) = g_M \cdot R_{\text{DC}} \cdot \frac{\left(1 + \frac{S}{\omega_{Z_\text{COMP}}}\right)}{\left(1 + \frac{S}{\omega_{P1_\text{COMP}}}\right) \cdot \left(1 + \frac{S}{\omega_{P2_\text{COMP}}}\right)} \quad (\text{eq. 25}) \qquad \omega_{Z_\text{COMP}} = \frac{1}{R_{\text{ZERO}} \cdot C_{\text{ZERO}}} \quad (\text{eq. 26})$$

$$\omega_{P1_\text{COMP}} = \frac{1}{R_{\text{DC}} \cdot C_{\text{ZERO}}} \quad (\text{eq. 27}) \quad \omega_{P2_\text{COMP}} = \frac{1}{R_{\text{ZERO}} \cdot \left(\frac{C_{\text{POLE}} \cdot C_{\text{ZERO}}}{C_{\text{POLE}} + C_{\text{ZERO}}}\right)} \cong \frac{1}{R_{\text{ZERO}} \cdot C_{\text{POLE}}} \text{ if } C_{\text{POLE}} \ll C_{\text{ZERO}} \text{ (eq. 28)}$$

Closed loop gain = Power stage gain x EA gain

Example:

Start the compensator design by calculating the critical frequencies for the boost power stage at the minimum input voltage and maximum load.

$$f_{\text{PBOOST}} = \frac{2}{2\pi \cdot R_L \cdot C_{\text{OUT}}} (\text{eq. 29}) f_{\text{ESR}} = \frac{1}{2\pi \cdot R_C \cdot C_{\text{OUT}}} (\text{eq. 30})$$

For a converter operating in boost mode, the inductor selection determines the RHP frequency and hence the stability of converter in deep boost mode. Calculate the RHP zero frequency in deep boost mode using the calculated inductor value.

$$f_{\text{RHP}} = \frac{R_L \cdot (1 - D_{\text{BOOST}}MAX)}{2\pi \cdot L} \text{ (eq. 31)}$$

where:

R_L: output load in Ω. $R_L = \frac{V_{OUT}}{I_{OUT}}$

C_{OUT}: output capacitance in F, chosen to be 214µF

 R_C : output capacitor ESR in Ω , chosen to be 3.5m Ω

DBOOST MAX: maximum duty cycle in boost mode calculated earlier

L: inductance value calculated earlier, in H

Using above values, we find f_{PBOOST} = 372Hz, f_{ESR} = 213kHz, and f_{RHP} = 9.2kHz.

With RHP zero at 9.2kHz, the loop cutoff frequency for a stable operation must be less than 1/4 of the RHP zero frequency in deep boost mode.

Therefore, a target bandwidth for the closed-loop converter close to 1.8kHz is selected. The zero of the error amplifier must be placed well below the bandwidth to give enough phase boost at the crossover frequency. Typically, the zero is placed close to the low-frequency pole. In such a case, resistor (R_{ZERO}) of the compensation can be calculated using the following equation:

$$R_{\text{ZERO}} = 2\pi \cdot f_{\text{BW}_{\text{BOOST}}} \cdot \frac{G_{\text{CS}} \cdot C_{\text{OUT}}}{g_{m} \cdot (1 - D_{\text{BOOST}_{\text{MAX}}})} \cdot \frac{(R_{\text{BOT}} + R_{\text{TOP}})}{R_{\text{TOP}}} \text{ (eq. 32)}$$

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where:

f_{BW BOOST}: desired converter bandwidth in boost mode

gm: error-amplifier transconductance, in A/V

 $R_{TOP},\,R_{BOT}$: top and bottom internal feedback network resistances, in Ω

 $R_{\rm TOP} = 96 k\Omega$

 $R_{\text{BOT}} = \frac{R_{\text{TOP}}}{\frac{V_{\text{OUT}} \text{MAX}}{1.25V} - 1} \text{ (eq. 33) Choosing } f_{\text{BW}} \text{BOOST} = 1.8 \text{kHz yields } R_{\text{ZERO}} = 11 \text{k}\Omega$

And with $f_{ZCOMP} = 1.2 \text{kHz}$,

$$C_{\text{ZERO}} = \frac{1}{R_{\text{ZERO}} \cdot 2\pi \cdot f_{\text{ZCOMP}}} \text{ (eq. 34)}$$

Therefore, $C_{ZERO} = 12nF$.

C_{POLE} determines the location of high-frequency pole. Select the high-frequency pole location higher than the bandwidth in buck mode so that it does not affect the phase margin and helps attenuate any high-frequency noise.

For $f_{P2COMP} = 140 kHz$,

$$C_{\text{POLE}} = \frac{1}{R_{\text{ZERO}} \cdot 2\pi \cdot f_{\text{P2COMP}}} \text{ (eq. 35)}$$

which yields C_{POLE} = 100pF.

For this example, the following component values would be selected: $R_{ZERO} = 11k\Omega$, $C_{ZERO} = 12nF$, and $C_{POLE} = 100pF$.

Current Loop Compensation Design (I_{COMP})

The MAX25432 includes a transconductance error amplifier in the current loop that requires external frequency compensation.

The current loop frequency crossover is targeted just above the cable compensation loop frequency of 1kHz. This results in the fixed compensation components shown in the <u>Typical Application Circuits</u>.

External MOSFET Selection

Four external MOSFETs are required for the H-bridge buck-boost architecture supported by the MAX25432, as shown in the *Typical Application Circuits*. During the buck-mode of operation, Q_{t2} remains on and Q_{b2} remains off. Q_{t1} and Q_{b1} switch to regulate the output voltage. During the boost mode, Q_{t1} remains on, Q_{b1} remains off, and Q_{t2} and Q_{b2} switch to regulate the output voltage. In the buck-boost region, all four switches are used to control the output voltage. The MOSFETs must be selected based on certain critical parameters such as on-resistance, breakdown voltage, output capacitance, and input capacitance. A low R_{DSON} reduces the conduction losses in the MOSFET and a small gate/output capacitance reduces switching losses. Typically, a lower R_{DSON} MOSFET would have higher gate charge for the same breakdown voltage. Hence, a compromise must be made depending on conditions to which the MOSFET is subjected.

The MAX25432 comes with a 5V gate drive with a high-current capability to support switching of four MOSFETs at a high frequency. In the buck-boost region, the device switches between pure buck and boost modes to reduce the gate-drive current and increase the efficiency.

Boost Cap and Diode Selection

A bootstrap circuit is used to drive the floating gates of high-side switches Q_{t1} and Q_{t2} . A boost capacitor provides the gate charge to the high-side FET during the high-side turn-on and is recharged when the bottom switch turns on. Hence, the capacitance value of the boost capacitor must be selected such that the voltage drop during the discharge is within acceptable limits. Choosing a very large capacitor value slows down the charging of the capacitor, and it might not completely charge in the minimum off-time of the top switch.

Select the boost diode based on the average gate-drive current and blocking voltage for the diode. The maximum blocking voltage for the diode must be high enough to block the maximum drain-to-source voltage for the FET. A fast

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reverse-recovery diode would prevent any current being sourced into the bias supply from drain-to-source voltage. For the MAX25432 devices, the gate drive is powered by the BIAS regulator, which is 5V (typ).

Since the boost capacitor provides gate charge to the top switch, the value of the boost capacitance needed for less than a ΔV_{BOOST} ripple on boost capacitor can be written as:

$$C_{\text{BOOST}} \ge \frac{Q_G}{\Delta V_{\text{BOOST}}}$$
 (eq. 36)

Average gate-drive current through the diode can be calculated as:

 $I_G = Q_G \cdot f_{SW} \text{ (eq. 37)}$

where Q_G = total gate charge of the top MOSFET.

Shield Short-to-Battery

The shield short-to-battery protection circuit requires that the total ground-path resistance from USB ground to system ground is in the range of $10m\Omega$ to $13m\Omega$. This is required to achieve the correct threshold detection values and avoid false detection or surge currents larger than desired. Contact Analog Devices for support in selecting a FET outside this R_{DSON} range for your application.

An N-channel FET with V_{DS} = 40V (min) must be chosen. The 1nF shield capacitor must be rated for 50V (min).

A single NVTFS5C466NLTAG can be used as a FET meeting those requirements.

USB Cable Compensation

Figure 38 shows a DC model of the voltage-correction function of the MAX25432.



Figure 38. DC Voltage Adjustment Model

Without voltage adjustment ($V_{ADJ} = 0$, GAIN[5:0] = 0), the voltage seen by the device at the end of the captive cable (V_{DUT}) will decrease linearly as load current increases. To compensate for this, the output voltage target of the buckboost controller should increase linearly with load current (see Figure 39).

The increase in $V_{\mbox{OUT}}$ over load current is called $V_{\mbox{ADJ}},$ such that:

$$V_{ADJ} = R_{COMP} \cdot I_{OUT}$$
 (eq. 38)

And R_{COMP} is the slope of V_{OUT} over the load current:

$$R_{COMP} = GAIN[5:0] \cdot R_{COMP_LSB} \cdot \frac{R_{CS3}}{5m\Omega} \text{ (eq. 39)}$$

where:

 R_{COMP} LSB is the gain setting LSB and is equal to 8.2m Ω (typ).

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The R_{COMP} adjustment discrete values available on the MAX25432 can be selected with the GAIN[5:0] register and are based on a $5m\Omega$ sense resistor. Use equation 41 to select the appropriate setting based on the calculated R_{COMP} value.

The R_{COMP} value must be calculated to take into account all series element and voltage drops in the charging path, including ground return. User cable can be of different length and type, and therefore should not be included in the calculations.

For $V_{DUT} = V_{OUT_NO_LOAD}$; $0 \le I_{OUT} \le 5A$, R_{COMP} must equal the sum of the system resistances. Calculate the minimum R_{COMP} for the system so that V_{DUT} stays constant:

 $R_{COMP_SYS} = R_{LR} + R_{CS3} + R_{PCB} + R_{CABLE_VBUS} + R_{CABLE_GND} (eq. 40)$

where:

 $R_{CABLE\ VBUS}$ and $R_{CABLE\ GND}$ are the V_{BUS} and GND resistance of the USB captive cable, respectively (including the effect from the cable shield, if it conducts current).

 R_{LR} is the converter's load regulation expressed in m Ω (2m Ω , typ).

R_{PCB} is the resistance of any additional V_{BUS} parasitics (PCB trace, ferrite, and the connector).

For G-suffix devices, R_{SHIELD} is the series resistance of the shield short-to-battery protection external FET and any PCB GND trace parasitics.

Find the setting for GAIN[5:0] using the minimum R_{COMP}:

 $GAIN[5:0] = ceiling\left(\frac{R_{COMP}_{SYS}}{R_{COMP}_{LSB}}\right) (eq. 41)$

The nominal DUT voltage can then be estimated at any load current by:

 $V_{DUT} = V_{OUT_NO_LOAD} + I_{OUT} (R_{COMP_LSB} \cdot GAIN[5:0] - R_{COMP_SYS}) (eq. 42)$

These equations presume a $5m\Omega$ sense resistor, which is recommended. Use equation 39 to scale for other resistance values. Note that the V_{BUS} current limit and OCP threshold will be scaled with a factor of $5m\Omega/R_{CS3}$.

The nominal cable resistance (with tolerance) for both V_{BUS} and GND should be determined from the cable manufacturer. In addition, be sure to include the resistance from the connector at the end of the captive cable. Determine the desired operating temperature range for the application, and consider the change in resistance over temperature. Contact Analog Devices for assistance with optimizing the cable compensation for your application.

Example:

With $R_{LR} = 2m\Omega$, $R_{CS3} = 5m\Omega$, $R_{PCB} = 40m\Omega$, $R_{CABLE} = 150m\Omega$, $R_{SHIELD} = 13m\Omega$, the total system resistance is then R_{COMP} SYS = 210m Ω .

In this application, the voltage drop at the far end of the captive cable is 630mV when the load current is 3A. Therefore, cable compensation is required to comply with USB and Apple specifications.

The desired GAIN[5:0] register setting is then ceiling(210/8.2) = 25.6 = 0x1A, which sets the adjustment level to $208m\Omega$.

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Figure 39. Increase in VOUT vs. IOUT

Capacitors on CC Lines

To comply with the USB PD specification, a cReceiver capacitance must be present on each CC line to ground when the BMC driver is not transmitting. Analog Devices recommends using 270pF ceramic capacitors to meet this requirement.

On MAX25432A, the capacitors can be placed on either the CC or HVCC side. On the MAX25432B, the capacitors should be placed on the HVCC side. See the <u>Typical Application Circuits</u> for details.

Table 13. cReceiver Specification from USB PD

NAME	MIN	MAX	UNIT
cReceiver	200	600	pF

Table 14. cReceiver Capacitance Breakdown

CAPACITANCE	MIN	MAX	UNIT
MAX25432 device capacitance on HVCC pins at +25°C	120	150	pF
External capacitor X7R 10% tolerance	243	297	pF
Total	363	447	pF

V_{CONN} Voltage Drop Budgeting

Care must be taken when designing a V_{CONN} source. Resistance in the V_{CONN} switch, PCB traces and connector will impact the voltage seen by the E-marked cable under load. This is even more important when using a 3.3V supply to provide V_{CONN} power. Use the following formula to estimate the V_{CONN} voltage drop from the power supply to the user's port (assuming no captive cable).

 $V_{\text{CONN}_{\text{DROP}}} = I_{\text{VCONN}} \cdot \left(R_{\text{PCB1}} + R_{\text{ON}} + R_{\text{PCB2}} + R_{\text{CON}} \right) = I_{\text{VCONN}} \cdot R_{\text{VCONN}_{\text{TOTAL}}} (\text{eq. 43})$

where:

R_{PCB1}: The PCB trace resistance from the V_{CONN} source (DC-DC or LDO)

 R_{ON} : The MAX25432 V_{CONN} switch resistance

R_{PCB2}: The PCB trace resistance from the HVCC pin of the MAX25432 to the Type-C receptacle

R_{CON}: The contact resistance of the Type-C receptacle CC pin

The Type-C specification requires the source to provide at least 3.0V under 1W of power at the receptacle for ports, including the SSTX/SSRX signals (USB 3.0 or higher), but also for V_{CONN} -powered USB devices (VPD) such as applications with remote LED lighting in a captive cable. For other applications where charging above 3A is needed, the V_{CONN} power required is 100mW at 3.0V.

Table 15. V_{CONN} Requirements

	PORT FEATURES			
D+/D-	D+/D- SSTX/SSRX, VPD		V _{CONN} POWER REQUIRED	
No	No	No	Not required	
Yes	No	No	Not required	
Yes	Yes	No	1W	
No	No	Yes	100mW	
Yes	No	Yes	100mW	
Yes	Yes	Yes	1W	

For a given V_{CONN} power and voltage to meet at the port, the required current is calculated :

 $I_{VCONN_PMIN} = \frac{P_{MIN}}{V_{DUT_MIN}} = \frac{1W}{3.0V} = 0.33A$ (eq. 44) The minimum V_{CONN} supply voltage needed to guarantee V_{DUT_MIN} at P_{MIN} at the receptacle is:

VCC_{MIN} = V_{DUT MIN} + R_{VCONN TOTAL} · I_{VCONN PMIN} (eq. 45)

Example:

 $R_{PCB1} = 10m\Omega$; $R_{ON MAX} = 600m\Omega$; $R_{PCB2} = 20m$; $R_{CON} = 40m$

VCC_{MIN} = 3.22V For a 3.3V supply with a 2% output voltage tolerance, the lowest voltage supplied is:

 $VCC_{LOW} = VCC_{TYP} \cdot (1 - VCC_{TOL}) = 3.3 \cdot (1 - 0.02) = 3.234V > VCC_{MIN}$ (eq. 46)

PCB Layout Guidelines

Refer to the EV kit for a complete layout reference. Contact Analog Devices to request for a review of your design.

Buck-Boost PCB Layout Guidelines

Careful PCB layout is critical to achieve low switching power losses and low-noise, stable operation. Use a multilayer board whenever possible for best noise immunity and thermals.

Use the following guidelines and see Figure 40 for an optimized buck-boost layout:

- 1. Arrange the high-power components in a compact layout away from the sensitive signals, such as the current-sense and gate-drive signals, to avoid stray noise pickup.
- Place the input capacitor and the input current-sense resistor close to the input MOSFETs (Q_{t1} and Q_{b1}) to make a small input current AC loop. High-frequency AC currents flow in this loop in buck mode and a small loop helps with the EMI and noise performance. Add high-frequency decoupling capacitors to improve the high-frequency performance.
- Place the output capacitor and the output current-sense resistor close to the output MOSFETs (Q_{t2} and Q_{b2}) to make a small output-current AC loop. High-frequency AC currents flow in this loop in boost mode and a small loop helps with the EMI and noise performance. Add high-frequency decoupling capacitors to improve the high-frequency performance.
- 4. The switching nodes (LX1 and LX2) carry high-frequency, high-current switching signals. Make LX1 and LX2 areas small to reduce parasitic inductance in the switching nodes. Since high currents flow through these nodes, a compromise must be made between thermal dissipation and noise mitigation.
- 5. Use a Kelvin sense connection for the current-sense resistors and route the sense traces close to each other to ensure a balanced measurement of the differential signal. Route these traces away from other noisy traces.
- 6. Use short and thick traces for gate connection to avoid any gate ringing.
- 7. Using internal PCB layers as a ground plane helps to improve EMI performance. A solid ground plane immediately below the top layer act as a shield against radiated noise. Have multiple vias spread around the board, especially near the ground connections, to have better overall ground connection.
- 8. Connect the PGND and AGND pins directly to the exposed pad under the IC. This ensures the shortest connection path between AGND and PGND.
- 9. Solder the exposed pad to a large copper-plane area under the device. To effectively use this copper area as a heat exchanger between the PCB and ambient, expose the copper area on the top and bottom side. Add several small vias or one large via on the copper pad for efficient heat transfer.
- 10. Place the BIAS ceramic capacitor as close as possible to the BIAS pin. The BIAS pin carries significant transients and supplies everything in the IC. Low inductance from the pin to the capacitor and low inductance to the GND return plane is key. Pay extra care in reducing parasitic inductance to reduce EMI. As the AGND pin is located after the IN and V_{COMP} and I_{COMP} pins, a trade-off must be made. Always give more importance to the BIAS capacitor placement over the IN-pin decoupling capacitor and compensation networks, as it helps filter out high di/dt switching currents.
- 11. Place the compensation network components close to the V_{COMP} and I_{COMP} pins. Minimize trace inductance and provide a short ground return path using several vias to the ground plane underneath. Place the compensation network components away from the power stage in order to prevent high-frequency switching noise to couple into the feedback loop.
- 12. Place the bootstrap capacitors close to the respective BST and LX pins to minimize inductance.
- 13. Leave the option to place series gate and BST resistors on the PCB to mitigate possible EMI issues at a later design stage.
- 14. Place the 100nF and 1uF ceramic capacitor close to the IN pin with a short path to the ground layer underneath. Place the 100nF capacitor closer to the pin.
- 15. Place vias as close to the AGND pins as possible to provide a low impedance path to the ground plane underneath

Figure 40 shows a recommended PCB layout for the buck-boost.

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Figure 40. Recommended Buck-Boost PCB Layout

USB PCB Layout Guidelines

Use the following guidelines for an optimized layout on USB-related IC pins:

- Place the V_{DD_USB} ceramic capacitor close to the respective pin and with a low impedance to ground. Use vias to the ground plane underneath. The V_{DD_USB} capacitor helps provide low impedance AC return path to ground during OV transients or ESD events on the USB data protection switches.
- Place the V_{CONN} ceramic capacitor close to the respective pin and with a low impedance to ground. Use vias to the ground plane underneath. The V_{CONN} capacitor helps provide a low impedance AC return path to ground on the respective HVCC pin during a V_{CONN} short-to-V_{BUS} event. The V_{CONN} capacitor also helps minimize droop on the upstream supply during high inrush current events such as capacitive load switching or a hot STG event.
- 3. Keep the HVCC traces large and short to minimize V_{CONN} voltage drop from the MAX25432 to the Type-C receptacle.
- 4. See the <u>USB Eye Diagram</u> section for recommendations when the MAX25432 is used in the USB Hi-Speed signal path.
- 5. On MAX25432B devices, place the V_{DD_BMC} ceramic capacitor close to the respective pin with a low impedance to ground. Use vias to the ground plane underneath.

Shield Short-to-Battery PCB Layout Guidelines

The shield FET should be placed as close as possible to the Type-C connector and must be connected to the connector with a plane. Where the FET's source connects to the PCB system ground, there should be several vias placed for a low-impedance path to ground. The 1nF capacitor from SHLD_SNS to system ground should also be placed close to the Type-C connector. Keep the SHLD_SNS Kelvin sense line away from switching traces or planes.

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Figure 41 shows a recommended layout for the shield short-to-battery feature.



Figure 41. Recommended Shield Short-to-Battery Component Layout

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USB Eye Diagram

USB Hi-Speed mode requires careful PCB layout with 90Ω controlled differential impedance, having matched traces of equal length, minimum vias, and no stubs or test points. The MAX25432 includes high-bandwidth USB data switches (>1GHz). This means that data-line tuning is generally not required.



Figure 42. Near-Eye Diagram (with No MAX25432)



Figure 43. Untuned Near-Eye Diagram (with MAX25432)

System-Level ESD Protection

The MAX25432 requires no external system-level ESD protection. All ADI devices incorporate ESD protection structures to protect against electrostatic discharges encountered during handling and assembly. After an ESD event, the MAX25432 continues to work without latch-up, while competing solutions can latch-up and require the power to be cycled. When used with the configurations shown in the <u>Typical Application Circuits</u>, the MAX25432 is characterized for protection to the following limits:

- 1. ±15kV IEC 61000-4-2 (150pF, 330Ω) Air-Gap Discharge
- 2. ±8kV IEC 61000-4-2 (150pF, 330Ω) Contact Discharge
- 3. ±15kV ISO 10605 (330pF, 2kΩ) Air-Gap Discharge
- 4. ±8kV ISO 10605 (330pF, 2kΩ) Contact Discharge

Note: All application-level ESD testing is performed on the standard EV kit.

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ESD Test Conditions

ESD performance depends on a variety of conditions. Contact Analog Devices for test setup, test methodology, and test results.

Human Body ESD

<u>Figure 44</u> shows the Human Body Model, and <u>Figure 45</u> shows the current waveform it generates when discharged into a low impedance. This model consists of a 100pF capacitor charged to the ESD voltage of interest, which is then discharged into the device through a $1.5k\Omega$ resistor.



Figure 44. Human Body ESD Test Model



Figure 45. Human Body Current Waveform

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IEC 61000-4-2 ESD

The IEC 61000-4-2 standard covers ESD testing and performance of finished equipment. The MAX25432 helps users design equipment that meets Level 4 of IEC 61000-4-2. The main difference between tests done using the Human Body Model and IEC 61000-4-2 is a higher peak current in IEC 61000-4-2. Because the series resistance is lower in the IEC 61000-4-2 ESD test model Figure 46, the ESD withstand-voltage measured to this standard is generally lower than that measured using the Human Body Model. Figure 47 shows the current waveform for the 8kV, IEC 61000-4-2 Level 4 ESD Contact Discharge test. The Air-Gap Discharge test involves approaching the device with a charged probe. The Contact Discharge method connects the probe to the device before the probe is energized.



Figure 46. IEC 61000-4-2 ESD Test Model



Figure 47. IEC 61000-4-2 Current Waveform

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Typical Application Circuits

MAX25432A Application Diagram

This figure shows the MAX25432AATLF/V+ with an external USB PD controller in a 100W single-port USB PD PPS application operating at 400kHz.



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Typical Application Circuits (continued)

MAX25432B Application Diagram

This figure shows the MAX25432BATLG/V+ with an external TCPM in a 100W single-port USB PD PPS application operating at 400kHz.



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Ordering Information

PART NUMBER	TEMP RANGE	USB PD ARCHITECTURE	CABLE SHIELD SHORT-TO- BATTERY PROTECTION	NORMALLY OPEN GROUND ²	USB PD PHY GROUND OFFSET COMPENSATION ³	DEVICE ID (HEX)	PIN- PACKAGE
MAX25432AATLF/ V+*	-40°C to +125°C	USB PD Controller Protection	No	Yes	No	0x0E00	
MAX25432AATLG/ V+*		USB PD Controller Protection	Yes	Yes	No	0x0A00	40-Pin TQFN-EP
MAX25432BATLG/ V+		Integrated ¹	Yes	Yes	130mV (max)	0x0200	
MAX25432BATLM/ V+		Integrated ¹	No	Yes	Yes	0x0200	

For variants with different options contact factory.

N+ Denotes automotive-qualified parts.

For tape-and-reel versions, add the suffix 'T' to the end of the part number (i.e., MAX25432AATLG/V+T).

+ Denotes a lead(Pb)-free/RoHS compliant package.

* Future product—contact factory for availability.

1 Variant with integrated USB PD BMC analog front-end (TCPC) for use with an external I^2C master which contains the USB PD FW stack (TCPM).

2 Downstream connector ground is automatically opened or closed based on Table 6.

3 Features a BMC Tx/Rx GND compensation circuit that lifts the BMC driver ground reference to reduce offset due to charging current.

MAX25432BATLG/V+							
BASE PART NUMBER							
GRADE A: USB PD CONTROLLER PROTECTION GRADE B: INTEGRATED USB PD PACKAGE (40-PIN TQFN-EP) —	CABLE SHIELD SHORT-TO-BATTERY PROTECTION G-SUFFIX: YES ALL OTHER: NO						

Part Number Breakdown

Automotive, 100W, USB PD, PPS, Buck-Boost Port Controller and Protector

Revision History

REVISION	REVISION	DESCRIPTION	PAGES
NUMBER	DATE		CHANGED
0	9/21	Initial release	—



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